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MB91F552, FR Family FR81S, 32-bit Microcontroller

The MB91550 series is a Cypress 32-bit microcontroller designed for automotive devices. This series contains the FR81S CPU which is compatible with the FR family.

Note: FR is a line of products of Cypress

Features

FR81S CPU Core

- 32-bit RISC, load/store architecture, 5-stage pipeline
- Maximum operating frequency: 80 MHz (Source oscillation = 4.0 MHz and 20 multiplied (PLL clock multiplication system))
- General-purpose register : 32 bits × 16 sets
- 16-bit fixed length instructions (basic instruction), 1 instruction per cycle
- Instructions appropriate to embedded applications
 - Memory-to-memory transfer instruction
 - Bit processing instruction
 - Barrel shift order etc.
- High-level language support instructions
- Function entry/exit instructions
- Register content multi-load and store instructions
- Bit search instructions
 - Logical 1 detection, 0 detection, and change-point detection
- Branch instructions with delay slot
 - Decrease overhead during branch process
- Register interlock function
 - Easy assembler writing
- Built-in multiplier and instruction level support
 - Signed 32-bit multiplication: 5 cycles
 - Signed 16-bit multiplication: 3 cycles
- Interrupt (PC/PS saving) 6 cycles (16 priority levels)
- The Harvard architecture allows simultaneous execution of program and data access.
- Instruction compatibility with the FR Family
- Built-in memory protection function (MPU)
 - Eight protection areas can be specified commonly for instructions and the data.
 - Control access privilege in both privilege mode and user mode.
- Built-in FPU (floating point arithmetic)
 - IEEE754 compliant
 - Floating-point register 32-bit × 16 sets

Peripheral functions

- CPU function for clock generation (with SSCG function)
 - Main oscillation (4MHz to 16MHz)
 - PLL multiplication rate (1 to 20 times)
 - PWM function for clock generation
 - Main oscillation (4 MHz to 16 MHz)
 - PLL multiplication rate (1 to 50 times)
 - Built-in program flash memory capacity
MB91F552:128+64KB
 - Built-in data flash (WorkFlash) 64KB
 - Built-in RAM capacity
 - Main RAM
MB91F552:24KB
 - General-purpose ports: MB91F552: 30sets
- DMA Controller*
- Up to 8 channels can be started simultaneously.
 - 2 transfer factors (Internal peripheral request and software)
- A/D converter 1 (successive approximation type)
 - 12-bit resolution : 8 channels × 1 unit
 - Conversion time : 1μs
- A/D converter 2 (successive approximation type simultaneous sampling of 4-channel input)
 - 12-bit resolution: Max. 4 channels × 1 unit
 - Conversion time :
 - For 1-channel conversion: Min. 0.7 μs
 - For 4-channel conversion: Min. 1.75 μs
- External interrupt input: 4 channels
 - Level ("H"/"L"), or edge detection (rising or falling) supported
- Multi-function serial communication (built-in transmission/reception FIFO memory) :3 channels
 - 5V tolerant input: 3 channels (ch.0, ch.1, ch.2)
CMOS hysteresis input

< UART (Asynchronous serial interface) >

- Full-duplex double buffering system, 64-step transmission FIFO memory, 64-step reception FIFO memory
- Parity or no parity is selectable.
- Built-in dedicated baud rate generator
- The external clock can be used as the transfer clock.
- Parity, frame, and overrun error detection functions are provided
- DMA transfer support

< CSIO (Synchronous serial interface) >

- Full-duplex double buffering system, 64-step transmission FIFO memory, 64-step reception FIFO memory
- SPI supported; master and slave systems supported; 5-bit to 16-bit, 20-bit, 24-bit, 32-bit data length can be set.
- Built-in dedicated baud rate generator (Master operation)
- The external clock can be entered (Slave operation).
- Overrun error detection function is provided
- DMA transfer support
- Serial chip select SPI function

< LIN (Asynchronous Serial Interface for LIN) >

- Full-duplex double buffering system, 64-step transmission FIFO memory, 64-step reception FIFO memory
- LIN protocol revision 2.1 supported
- Master and slave systems supported
- Framing error and overrun error detection
- LIN synch break generation and detection; LIN synch delimiter generation
- Built-in dedicated baud rate generator
- The external clock can be adjusted by the reload counter
- DMA transfer support
- Hard assist function

■ CAN Controller (CAN) : 1 channel

- Transfer speed : Up to 1Mbps
- 64-transmission/reception message buffering: 1 channel

■ Reload timer: 16-bit × 5 channels
■ Free-run timer: 16-bit × 1 channel
■ Input capture: 16-bit × 1 channel (linked with the free-run timer)
■ PWC: 2 channels

- Max. 80 MHz operation

■ PWM: 6 channels (2 channels × 3 pairs)

- Max. 200 MHz operation

■ Clock supervisor

- Monitoring abnormality (by damaged quartz, etc.) of external main oscillation (4 MHz)
- When abnormality is detected, it switches to the CR clock.

■ Base timer : Max.4 channels

- 16-bit timer
- The timer mode is selected from PWM/PPG/PWC/reload.
- A 32-bit timer can be used in 2 channels of cascade mode for the reload timer/PWC function.

■ CRC generation
■ Watchdog timer

- Hardware watchdog
- Software watchdog (An effective range of a clear counter can be set.)

■ Slope compensation (constant current unit): 1 channel
■ Comparator: 3 channels
■ NMI (non-maskable interrupt)
■ Interrupt controller
■ Interrupt request batch read

- Multiple interrupts from peripherals can be read by a series of registers.

■ Low-power consumption mode

- Sleep / Stop / Watch mode

■ Power-on reset
■ Low-voltage detection reset (external power supply and internal power supply are independently observed.)
■ Device Package : LQFP-64
■ CMOS 90nm Technology
■ Power supply

- 5V Power supply
- The internal 1.2V is generated from 5V with the voltage step-down circuit.

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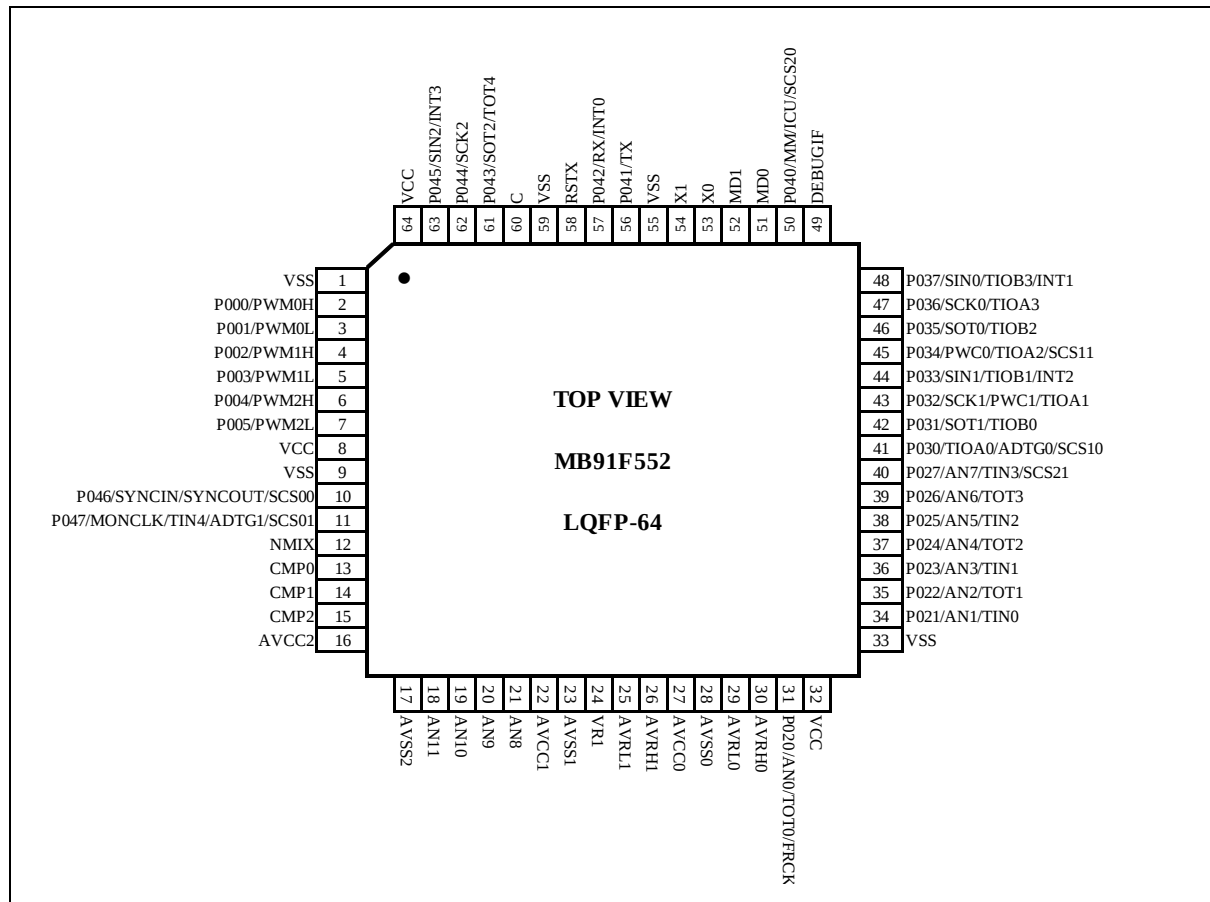
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1. Product Lineup

Parameter	Part number
	MB91F552
System Clock	On chip PLL Clock multiple method
Minimum instruction execution time	12.5ns(80MHz)
Flash Capacity (Program)	128 + 64KB
Flash Capacity (Data)	64KB
RAM Capacity	24KB
DMA Transfer	8 channels
16-bit Base Timer	4 channels
Free-run Timer	16bit×1 channel
Input capture	16bit×1 channel
16-bit Reload Timer	5 channels
Clock Supervisor	Yes
External Interrupt	4 channels
A/D converter	12 bit×8 channels (1 unit) Simultaneous sampling of 12 bit×4 channels input (1 unit)
Multi-Function Serial Interface	3 channels
CAN	64 msg×1 channel
Hardware Watchdog Timer	Yes
CRC Formation	Yes
Low-voltage detection reset	Yes
Flash Security	Yes
ECC Flash/WorkFlash	Yes
ECC RAM	Yes
Memory Protection Function (MPU)	Yes
Floating point arithmetic (FPU)	Yes
General-purpose port (#GPIOs)	30 ports
SSCG	Yes
CR oscillator	Yes
OCD (On Chip Debug)	Yes
TPU (Timing Protection Unit)	Yes
Key code register	Yes
Comparator	3 channels
Slope compensation (constant current unit)	1 channel
PWC	2 channels
PWM	2 channels×3pairs
NMI request function	Yes
Operation guaranteed temperature (T _A)	-40°C to +125°C
Power supply	4.5V to 5.5V
Package	LQFP-64

2. Pin Assignment



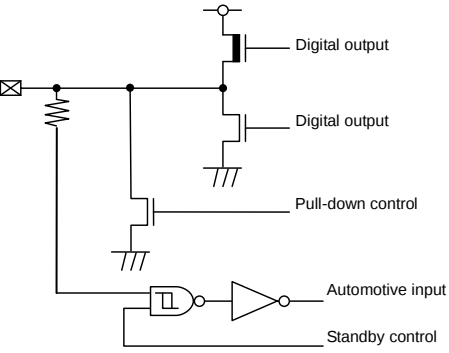
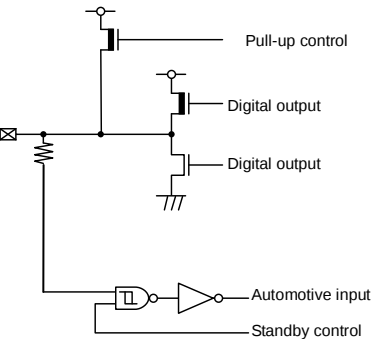
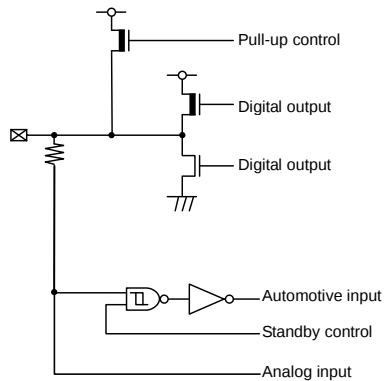
3. Pin Description

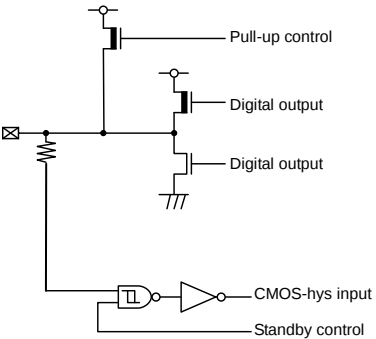
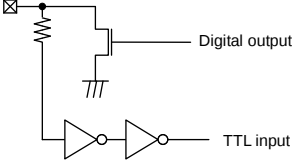
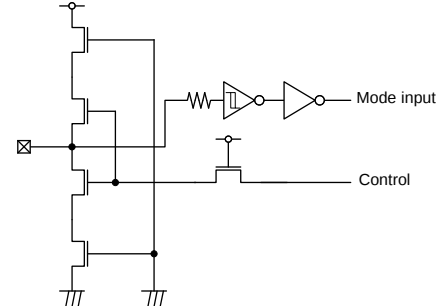
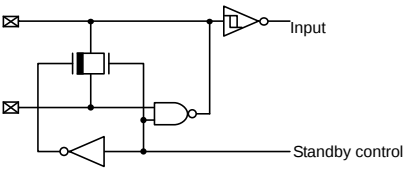
Pin no.	Pin Name	Polarity	I/O circuit types	Function
2	P000 PWM0H	- -	A	General-purpose I/O port PWM ch.0-H
3	P001 PWM0L	- -	A	General-purpose I/O port PWM ch.0-L
4	P002 PWM1H	- -	A	General-purpose I/O port PWM ch.1-H
5	P003 PWM1L	- -	A	General-purpose I/O port PWM ch.1-L
6	P004 PWM2H	- -	A	General-purpose I/O port PWM ch.2-H
7	P005 PWM2L	- -	A	General-purpose I/O port PWM ch.2-L
10	P046 SYNCIN SYNOUT SCS00	- - - -	B	General-purpose I/O port Master/Slave input pin for PWM parallel operation drive Master/Slave output pin for PWM parallel operation drive Multi-function serial ch.0 serial chip select 00 I/O pin
11	P047 MONCLK TIN4 ADTG1 SCS01	- - - -	B	General-purpose I/O port Clock monitor output pin Reload timer ch.4 event input pin A/D converter ch.8-ch.11 external trigger input pin Multi-function serial ch.0 serial chip select 01 output pin
12	NMIX	N	L	Interrupt input pin without mask
13	CMP0	-	C	Comparator ch.0 input pin
14	CMP1	-	C	Comparator ch.1 input pin
15	CMP2	-	C	Comparator ch.2 input pin
18	AN11	-	C	A/D converter ch.11 analog input pin (Simultaneous sampling possible with ch.8, ch.9, ch.10, and ch.11)
19	AN10	-	C	A/D converter ch.10 analog input pin (Simultaneous sampling possible with ch.8, ch.9, ch.10, and ch.11)
20	AN9	-	C	A/D converter ch.9 analog input pin (Simultaneous sampling possible with ch.8, ch.9, ch.10, and ch.11)
21	AN8	-	C	A/D converter ch.8 analog input pin (Simultaneous sampling possible with ch.8, ch.9, ch.10, and ch.11)
31	P020 AN0 TOT0 FRCK	- - - -	D	General-purpose I/O port A/D converter ch.0 analog input pin Reload timer ch.0 output pin Free-run timer clock input pin
34	P021 AN1 TIN0	- - -	D	General-purpose I/O port A/D converter ch.1 analog input pin Reload timer ch.0 event input pin
35	P022 AN2 TOT1	- - -	D	General-purpose I/O port A/D converter ch.2 analog input pin Reload timer ch.1 output pin

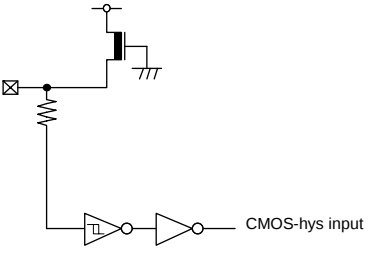
Pin no.	Pin Name	Polarity	I/O circuit types	Function
36	P023	-	D	General-purpose I/O port
	AN3	-		A/D converter ch.3 analog input pin
	TIN1	-		Reload timer ch.1 event input pin
37	P024	-	D	General-purpose I/O port
	AN4	-		A/D converter ch.4 analog input pin
	TOT2	-		Reload timer ch.2 output pin
38	P025	-	D	General-purpose I/O port
	AN5	-		A/D converter ch.5 analog input pin
	TIN2	-		Reload timer ch.2 event input pin
39	P026	-	D	General-purpose I/O port
	AN6	-		A/D converter ch.6 analog input pin
	TOT3	-		Reload timer ch.3 output pin
40	P027	-	D	General-purpose I/O port
	AN7	-		A/D converter ch.7 analog input pin
	TIN3	-		Reload timer ch.3 event input pin
	SCS21	-		Multi-function serial ch.2 serial chip select 21 output pin
41	P030	-	B	General-purpose I/O port
	TIOA0	-		Base timer ch.0 TIOA output pin
	ADTG0	-		A/D converter ch.0-ch.7 external trigger input pin
	SCS10	-		Multi-function serial ch.1 serial chip select 10 I/O pin
42	P031	-	B	General-purpose I/O port
	SOT1	-		Multi-function serial ch.1 serial data output pin
	TIOB0	-		Base timer ch.0 TIOB input pin
43	P032	-	E	General-purpose I/O port
	SCK1	-		Multi-function serial ch.1 clock I/O pin
	PWC1	-		PWC ch.1 input pin
	TIOA1	-		Base timer ch.1 TIOA I/O pin
44	P033	-	E	General-purpose I/O port
	SIN1	-		Multi-function serial ch.1 serial data input pin
	TIOB1	-		Base timer ch.1 TIOB input pin
	INT2	-		INT2 external interrupt input pin
45	P034	-	B	General-purpose I/O port
	PWC0	-		PWC ch.0 input pin
	TIOA2	-		Base timer ch.2 TIOA output pin
	SCS11	-		Multi-function serial ch.1 serial chip select 11 output pin
46	P035	-	B	General-purpose I/O port
	SOT0	-		Multi-function serial ch.0 serial data output pin
	TIOB2	-		Base timer ch.2 TIOB input pin
47	P036	-	E	General-purpose I/O port
	SCK0	-		Multi-function serial ch.0 clock I/O pin
	TIOA3	-		Base timer ch.3 TIOA I/O pin
48	P037	-	E	General-purpose I/O port
	SIN0	-		Multi-function serial ch.0 serial data input pin
	TIOB3	-		Base timer ch.3 TIOB input pin
	INT1	-		INT1 external interrupt input pin
49	DEBUGIF	-	F	MDI I/O pin for debug (OCD)
50	P040	-	B	General-purpose I/O port
	MM	-		Clock supervisor main clock stop detection output pin
	ICU	-		Input capture input pin
	SCS20	-		Multi-function serial ch.2 serial chip select 20 I/O pin
51	MD0	-	G	Mode pin 0
52	MD1	-	G	Mode pin 1
53	X0	-	H	Main clock oscillation input pin
54	X1	-	H	Main clock oscillation output pin

Pin no.	Pin Name	Polarity	I/O circuit types	Function
56	P041 TX	-	B	General-purpose I/O port CAN transmission data output pin
57	P042 RX INT0	- - -	E	General-purpose I/O port CAN reception data input pin INT0 external interrupt input pin
58	RSTX	N	L	External reset input pin
61	P043 SOT2 TOT4	- - -	B	General-purpose I/O port Multi-function serial ch.2 serial data output pin Reload timer ch.4 output pin
62	P044 SCK2	-	E	General-purpose I/O port Multi-function serial ch.2 clock I/O pin
63	P045 SIN2 INT3	- - -	E	General-purpose I/O port Multi-function serial ch.2 serial data input pin INT3 external interrupt input pin
16	AVCC2	-	-	Analog power supply pin for comparator and slope compensation circuit
22	AVCC1	-	-	Analog power supply pin for A/D converter, with 4ch. simultaneous sampling/hold function
27	AVCC0	-	-	A/D converter analog power supply pin
26	AVRH1	-	-	Upper limit reference voltage pin for A/D converter, with 4ch. simultaneous sampling/hold function
30	AVRH0	-	-	A/D converter upper limit reference voltage pin
17	AVSS2	-	-	GND pin for comparator and slope compensation circuit
23	AVSS1	-	-	GND pin for A/D converter, with 4ch. simultaneous sampling/hold function
25	AVRL1	-	-	Lower limit reference voltage pin for A/D converter, with 4ch. simultaneous sampling/hold function
24	VR1	-	-	Intermediate reference voltage pin for A/D converter, with 4ch. simultaneous sampling/hold function
28	AVSS0	-	-	A/D converter GND pin
29	AVRL0	-	-	A/D converter lower limit reference voltage pin
60	C	-	-	External capacity connection output pin
8 32 64	VCC	-	-	+5.0 V power supply pin
1 9 33 55 59	VSS	-	-	GND

4. I/O Circuit Type

Type	Circuit	Remarks
A		■ General-purpose I/O port ■ Output 8mA ■ Pull-down resistor control 50kΩ ■ Automotive input
B		■ General-purpose I/O port ■ Output 4mA ■ Pull-up resistor control 50kΩ ■ Automotive input
C		■ Analog input
D		■ Analog input, General-purpose I/O port ■ Output 4mA ■ Pull-up resistor control 50kΩ ■ Automotive input

Type	Circuit	Remarks
E		■ General-purpose I/O port ■ Output 4mA ■ Pull-up resistor control 50kΩ ■ CMOS hysteresis input
F		■ Open-drain I/O ■ Output 25mA (Nch open drain) ■ TTL input
G		■ Mode I/O ■ CMOS hysteresis input
H		■ Main oscillation I/O

Type	Circuit	Remarks
L		■ CMOS hysteresis input ■ Pull-up resistor 50kΩ

5. Handling Precautions

Any semiconductor devices have inherently a certain rate of failure. The possibility of failure is greatly affected by the conditions in which they are used (circuit conditions, environmental conditions, etc.). This page describes precautions that must be observed to minimize the chance of failure and to obtain higher reliability from your Cypress semiconductor devices.

5.1 Precautions for Product Design

This section describes precautions when designing electronic equipment using semiconductor devices.

■ Absolute Maximum Ratings

Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of certain established limits, called absolute maximum ratings. Do not exceed these ratings.

■ Recommended Operating Conditions

Recommended operating conditions are normal operating ranges for the semiconductor device. All the device's electrical characteristics are warranted when operated within these ranges.

Always use semiconductor devices within the recommended operating conditions. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their sales representative beforehand.

■ Processing and Protection of Pins

These precautions must be followed when handling the pins which connect semiconductor devices to power supply and input/output functions.

1. Preventing Over-Voltage and Over-Current Conditions

Exposure to voltage or current levels in excess of maximum ratings at any pin is likely to cause deterioration within the device, and in extreme cases leads to permanent damage of the device. Try to prevent such overvoltage or over-current conditions at the design stage.

2. Protection of Output Pins

Shorting of output pins to supply pins or other output pins, or connection to large capacitance can cause large current flows. Such conditions if present for extended periods of time can damage the device.

Therefore, avoid this type of connection.

3. Handling of Unused Input Pins

Unconnected input pins with very high impedance levels can adversely affect stability of operation. Such pins should be connected through an appropriate resistance to a power supply pin or ground pin.

■ Latch-up

Semiconductor devices are constructed by the formation of P-type and N-type areas on a substrate. When subjected to abnormally high voltages, internal parasitic PNP junctions (called thyristor structures) may be formed, causing large current levels in excess of several hundred mA to flow continuously at the power supply pin. This condition is called latch-up.

CAUTION:

The occurrence of latch-up not only causes loss of reliability in the semiconductor device, but can cause injury or damage from high heat, smoke or flame. To prevent this from happening, do the following:

1. *Be sure that voltages applied to pins do not exceed the absolute maximum ratings. This should include attention to abnormal noise, surge levels, etc.*
2. *Be sure that abnormal current flows do not occur during the power-on sequence.*

■ **Observance of Safety Regulations and Standards**

Most countries in the world have established standards and regulations regarding safety, protection from electromagnetic interference, etc. Customers are requested to observe applicable regulations and standards in the design of products.

■ **Fail-Safe Design**

Any semiconductor devices have inherently a certain rate of failure. You must protect against injury, damage or loss from such failures by incorporating safety design measures into your facility and equipment such as redundancy, fire protection, and prevention of over-current levels and other abnormal operating conditions.

■ **Precautions Related to Usage of Devices**

Cypress semiconductor devices are intended for use in standard applications (computers, office automation and other office equipment, industrial, communications, and measurement equipment, personal or household devices, etc.).

CAUTION:

Customers considering the use of our products in special applications where failure or abnormal operation may directly affect human lives or cause physical injury or property damage, or where extremely high levels of reliability are demanded (such as aerospace systems, atomic energy controls, sea floor repeaters, vehicle operating controls, medical devices for life support, etc.) are requested to consult with sales representatives before such use. The company will not be responsible for damages arising from such use without prior approval.

5.2 Precautions for Package Mounting

Package mounting may be either lead insertion type or surface mount type. In either case, for heat resistance during soldering, you should only mount under Cypress recommended conditions. For detailed information about mount conditions, contact your sales representative.

■ **Lead Insertion Type**

Mounting of lead insertion type packages onto printed circuit boards may be done by two methods: direct soldering on the board, or mounting by using a socket.

Direct mounting onto boards normally involves processes for inserting leads into through-holes on the board and using the flow soldering (wave soldering) method of applying liquid solder. In this case, the soldering process usually causes leads to be subjected to thermal stress in excess of the absolute ratings for storage temperature. Mounting processes should conform to Cypress recommended mounting conditions.

If socket mounting is used, differences in surface treatment of the socket contacts and IC lead surfaces can lead to contact deterioration after long periods. For this reason it is recommended that the surface treatment of socket contacts and IC leads be verified before mounting.

■ **Surface Mount Type**

Surface mount packaging has longer and thinner leads than lead-insertion packaging, and therefore leads are more easily deformed or bent. The use of packages with higher pin counts and narrower pin pitch results in increased susceptibility to open connections caused by deformed pins, or shorting due to solder bridges.

You must use appropriate mounting techniques. Cypress recommends the solder reflow method, and has established a ranking of mounting conditions for each product. Users are advised to mount packages in accordance with Cypress ranking of recommended conditions.

■ **Lead-Free Packaging**

CAUTION:

When ball grid array (BGA) packages with Sn-Ag-Cu balls are mounted using Sn-Pb eutectic soldering, junction strength may be reduced under some conditions of use.

■ **Storage of Semiconductor Devices**

Because plastic chip packages are formed from plastic resins, exposure to natural environmental conditions will cause absorption of moisture. During mounting, the application of heat to a package that has absorbed moisture can cause surfaces to peel, reducing moisture resistance and causing packages to crack. To prevent, do the following:

1. Avoid exposure to rapid temperature changes, which cause moisture to condense inside the product. Store products in locations where temperature changes are slight.
2. Use dry boxes for product storage. Products should be stored below 70% relative humidity, and at temperatures between 5°C and 30°C.
When you open Dry Package that recommends humidity 40% to 70% relative humidity.
3. When necessary, Cypress packages semiconductor devices in highly moisture-resistant aluminum laminate bags, with a silica gel desiccant. Devices should be sealed in their aluminum laminate bags for storage.
4. Avoid storing packages where they are exposed to corrosive gases or high levels of dust.

■ **Baking**

Packages that have absorbed moisture may be de-moisturized by baking (heat drying). Follow the Cypress recommended conditions for baking.

Condition: 125°C/24 h

■ **Static Electricity**

Because semiconductor devices are particularly susceptible to damage by static electricity, you must take the following precautions:

1. Maintain relative humidity in the working environment between 40% and 70%. Use of an apparatus for ion generation may be needed to remove electricity.
2. Electrically ground all conveyors, solder vessels, soldering irons and peripheral equipment.
3. Eliminate static body electricity by the use of rings or bracelets connected to ground through high resistance (on the level of 1 MΩ). Wearing of conductive clothing and shoes, use of conductive floor mats and other measures to minimize shock loads is recommended.
4. Ground all fixtures and instruments, or protect with anti-static measures.
5. Avoid the use of styrofoam or other highly static-prone materials for storage of completed board assemblies.

5.3 Precautions for Use Environment

Reliability of semiconductor devices depends on ambient temperature and other conditions as described above.

For reliable performance, do the following:

1. **Humidity**

Prolonged use in high humidity can lead to leakage in devices as well as printed circuit boards. If high humidity levels are anticipated, consider anti-humidity processing.

2. **Discharge of Static Electricity**

When high-voltage charges exist close to semiconductor devices, discharges can cause abnormal operation. In such cases, use anti-static measures or processing to prevent discharges.

3. **Corrosive Gases, Dust, or Oil**

Exposure to corrosive gases or contact with dust or oil may lead to chemical reactions that will adversely affect the device. If you use devices in such conditions, consider ways to prevent such exposure or to protect the devices.

4. **Radiation, Including Cosmic Radiation**

Most devices are not designed for environments involving exposure to radiation or cosmic radiation. Users should provide shielding as appropriate.

5. **Smoke, Flame**

CAUTION:

Plastic molded devices are flammable, and therefore should not be used near combustible substances. If devices begin to smoke or burn, there is danger of the release of toxic gases.

Customers considering the use of Cypress products in other special environmental conditions should consult with sales representatives.

6. Handling Devices

This section explains the latch-up prevention and pin processing.

6.1 For Latch-up Prevention

If a voltage higher than VCC or a voltage lower than VSS is applied to an I/O pin, or if a voltage exceeding the ratings is applied between VCC and VSS pins, a latch-up may occur in CMOS IC. If the latch-up occurs, the power supply current increases excessively and device elements may be damaged by heat. Take care to prevent any voltage from exceeding the maximum ratings in device application.

Also, the analog power supply (AVCC, AVRH) and analog input must not exceed the digital power supply (VCC) when the power supply to the analog system is turned on or off.

In the correct power-on sequence of the microcontroller, turn on the digital power supply (VCC) and analog power supplies (AVCC, AVRH) simultaneously. Or, turn on the digital power supply (VCC), and then turn on analog power supplies (AVCC, AVRH).

6.2 Treatment of Unused Pins

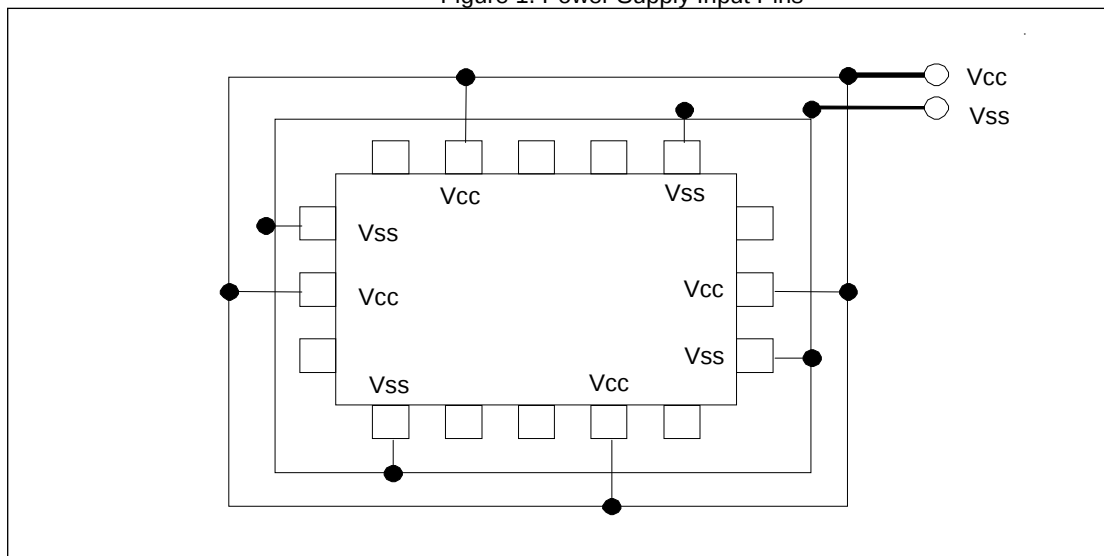
If unused input pins are left open, they may cause a permanent damage to the device due to malfunction or latch-up. Connect at least a 2kΩ resistor to each of the unused pins for pull-up or pull-down processing.

Also, if I/O pins are not used, they must be set to the output state for releasing or they must be set to the input state and treated in the same way as for the input pins.

6.3 Power Supply Pins

The device is designed to ensure that if the device contains multiple VCC or VSS pins, the pins that should be at the same potential are interconnected to prevent latch-up or other malfunctions. Further, connect these pins to an external power supply or ground to reduce unwanted radiation, prevent strobe signals from malfunctioning due to a raised ground level, and fulfill the total output current standard, etc. As shown in figure 1, all Vss power supply pins must be treated in the similar way. If multiple Vcc or Vss systems are connected, the device cannot operate correctly even within the guaranteed operating range.

Figure 1. Power Supply Input Pins



The power supply pins should be connected to VCC and VSS pins of this device at the low impedance from the power supply source.

In the area close to this device, a ceramic capacitor having the capacitance larger than the capacitor of C pin is recommended to use as a bypass capacitor between VCC and VSS pins.

6.4 Crystal Oscillation Circuit

An external noise to the X0 or X1 pin may cause a device malfunction. The printed circuit board must be designed to lay out X0 and X1 pins, crystal oscillator (or ceramic resonator), and the bypass capacitor to be grounded to the close position to the device.

The printed circuit board artwork is recommended to surround the X0 and X1 pins by ground circuits.

6.5 Mode Pins (MD1, MD0)

Connect the MD1 and MD0 mode pins to the VCC or VSS pin directly. To prevent an erroneous selection of test mode caused by the noise, reduce the pattern length between each mode pin and VCC or VSS pin on the printed circuit board. Also, use the low-impedance pin connection.

6.6 During Power-on

To prevent a malfunction of the voltage step-down circuit built in the device, set the voltage rising time to have 50 μ s or longer (between 0.2V and 2.7V) during power-on.

6.7 Notes during PLL clock Operation

When the PLL clock is selected and if the oscillator is disconnected or if the input is stopped, this clock may continue to operate at the free running frequency of the self-oscillator circuit built in the PLL clock. This operation is not guaranteed.

6.8 Treatment of A/D Converter Power Supply Pins

Connect the pins to have AVCC=AVRH=VCC and AVSS/AVRL=VSS even if the A/D converter is not used.

6.9 External clock is not Supported

None of the external direct clock input can be used.

6.10 Power-on Sequence of A/D Converter Power Supplies and Analog Inputs

Be sure to turn on the digital power supply (Vcc) first, and then turn on the A/D converter power supplies (AVcc, AVRH, AVRL) and analog inputs (AN0 to AN7, AN8 to AN11). Also, turn off the A/D converter power supplies and analog inputs first, and then turn off the digital power supply (Vcc). When the AVRH pin voltage is turned on or off, it must not exceed AVCC. Even if a common analog input pin is used as an input port, its input voltage must not exceed AVcc. (However, the analog power supply and digital power supply can be turned on or off simultaneously.)

6.11 Power-on Sequence of Comparator and Slope Compensation Power Supply and Analog Inputs

Be sure to turn on the digital power supply (Vcc) first, and then turn on the comparator and slope compensation power supply (AVcc) and analog inputs (CMP0 to CMP2). Also, turn off the comparator and slope compensation power supply and analog inputs first, and then turn off the digital power supply (Vcc). (However, the analog power supply and digital power supply can be turned on or off simultaneously.)

6.12 Treatment of C Pin

This device contains a voltage step-down circuit. A capacitor must always be connected to the C pin to assure the internal stabilization of the device. For the standard values, see the "Recommended Operating Conditions" of the latest data sheet.

Note: Please see the latest data sheet for a detailed specification of the operation voltage.

6.13 Function Switching of a Multiplexed Port

To switch between the port function and the multiplexed pin function, use the PFR (port function register). However, if a pin is also used for an external bus, its function is switched by the external bus setting. For details, see "I/O PORTS" in the hardware manual.

6.14 Low-Power Consumption Mode

To transit to the sleep mode, watch mode, stop mode, watch mode(power-off) or stop mode(power-off), follow the procedure explained in "Activating the sleep mode, watch mode, or stop mode" or "Activating the watch mode (power-off) or stop mode(power-off)" of " POWER CONSUMPTION CONTROL" in the hardware manual.

Take the following notes when using a monitor debugger.

Do not set a break point for the low-power consumption transition program.

Do not execute an operation step for the low-power consumption transition program.

6.15 Notes when Writing Data in a Register having the Status Flag

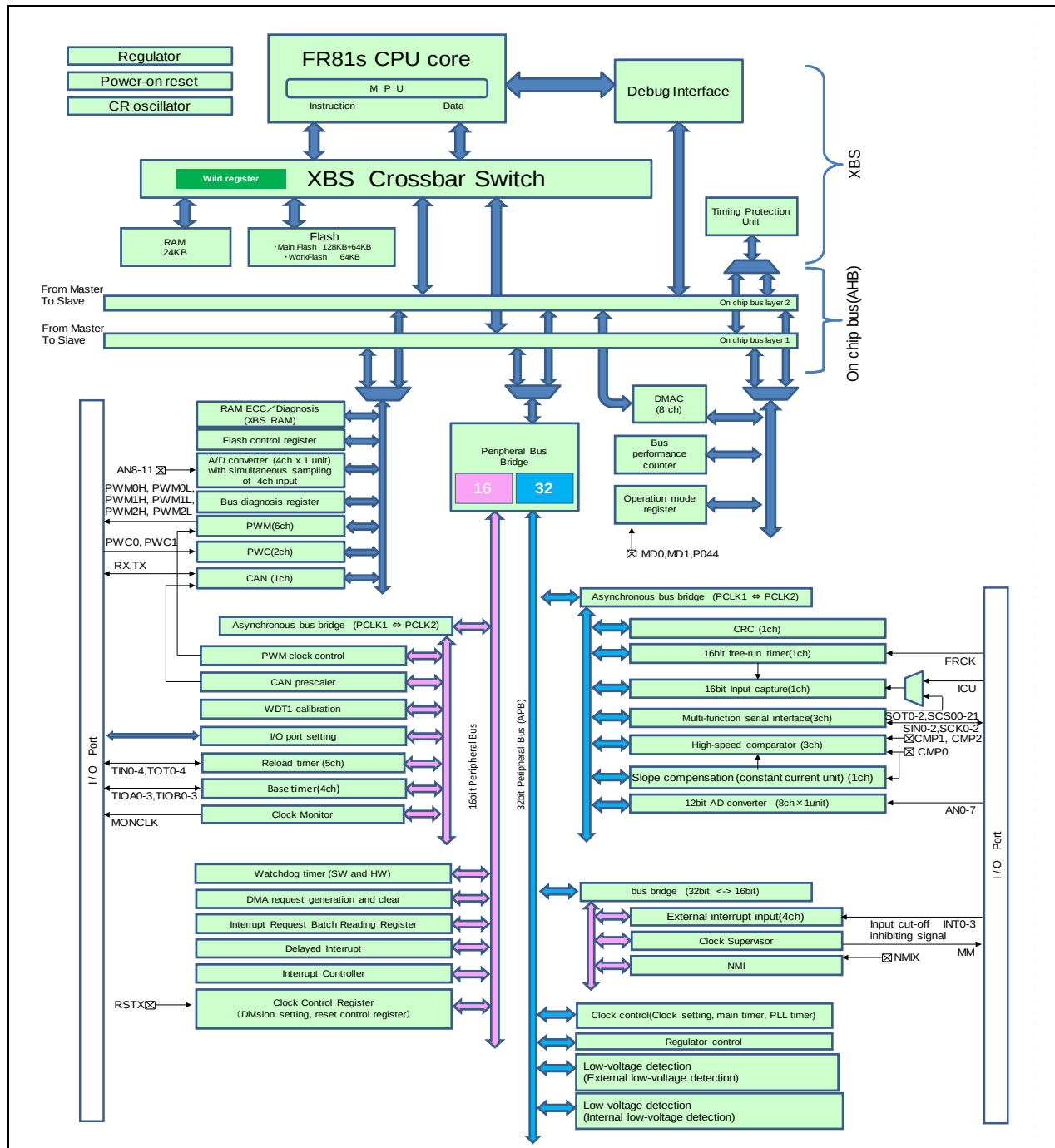
When writing data in the register that has a status flag (especially, an interrupt request flag) to control function, taking care not to clear its status flag erroneously must be followed.

The program must be written not to clear the flag to the status bit, and then to set the control bits to have the desired value.

Especially, if multiple control bits are used, the bit instruction cannot be used. (The bit instruction can access to a single bit only.) By the Byte, Half-word, or Word access, data is written to the control bits and status flag simultaneously. During this time, take care not to clear other bits (in this case, the bits of status flag) erroneously.

Note: These points can be ignored because the bit instructions are already taken the points into consideration.

7. Block Diagram



8. Memory Map

0000_0000 H	I/O area
0000_4000 H	Reserved
0000_6000 H	I/O area
0001_0000 H	RAM (24KB)
0001_6000 H	Reserved
0007_0000 H	Reserved
000D_0000 H	Flash memory (128+64)KB
000F_FC00 H	Interrupt vector table Reset vector table
0010_0000 H	Reserved
0033_0000 H	WorkFlash (64KB)
0034_0000 H	Reserved
FFFF_FFFF H	

9. I/O Map

The following I/O map shows the relationship between memory space and registers for peripheral resources.

Legend of I/O Map

Read/Write attribute (R: Read W: Write)

Address	Address offset value/register name				Block
	+0	+1	+2	+3	
000090 _H	BT1TMR[R] H 0000000000000000		BT1TMCR[R/W] B,H,W 00000000 00000000		Base timer 1
000094 _H	-	BT1STC[R/W] B 00000000	-	-	
000098 _H	BT1PCSR/BT1PRL[R/W] H 0000000000000000		BT1PDU T/BT1PRLH/BT1DTBF[R/W] H 0000000000000000		
00009C _H	BTSEL[R/W] B ----000 0	-	BTSSSR[W] B,H -----11		
0000A0 _H	ADERH [R/W] B,H,W 00000000 00000000		ADERL [R/W] B,H,W 00000000 00000000		A/D converter
0000A4 _H	ADCS1 [R/W] B,H,W 00000000	ADCS0 [R/W] B,H,W 00000000	ADCR1 [R] B,H,W -----XX	ADCR0 [R] B,H,W XXXXXX XXX	
0000A8 _H	ADCT1 [R/W] B,H,W 00010000	ADCT0 [R/W] B,H,W 00101100	ADSCH [R/W] B,H,W ---00000	ADECH [R/W] B,H,W ---00000	

Data access attribute
 B: Byte
 H: Half-word
 W: Word
 (Note) The access by the data access attribute not described is disabled.

Initial register value after reset

The initial register value after reset indicates as follows:

"1": Initial value "1"

"0": Initial value "0"

"X": Initial value undefined

"-": Reserved bit/Undefined bit

"*": Initial value "0" or "1" according to the setting

Note: The access to addresses not described is disabled.

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
000000 _H	PDR00 [R/W] B,H,W --XXXXXX	—	PDR02 [R/W] B,H,W XXXXXXXXXX	PDR03 [R/W] B,H,W XXXXXXXXXX	Port Data Register
000004 _H	PDR04 [R/W] B,H,W XXXXXXXXXX	—	—	—	
000008 _H to 000034 _H	—	—	—	—	Reserved
000038 _H	WDTECR0 [R/W] B,H,W ---00000	—	—	—	Watchdog Timer ^[S]
00003C _H	WDTECR0 [R/W] B,H,W -0--0000	WDTCPR0 [W] B,H,W 00000000	WDTCR1 [R] B,H,W ----0110	WDTCPR1 [W] B,H,W 00000000	
000040 _H	—	—	—	—	Reserved
000044 _H	DICR [R/W] B ---0	—	—	—	Delayed Interrupt
000048 _H to 00005C _H	—	—	—	—	Reserved
000060 _H	TMRLRA0 [R/W] H XXXXXXXXXX XXXXXXXXX		TMR0 [R] H XXXXXXXXXX XXXXXXXXX		Reload Timer 0
000064 _H	TMRLRB0 [R/W] H XXXXXXXXXX XXXXXXXXX		TMCSR0 [R/W] B,H,W 00000000 0-000000		
000068 _H to 00007C _H	—	—	—	—	Reserved
000080 _H	BT0TMR [R] H 00000000 00000000		BT0TMCR [R/W] H -000--00 -000-000		Base Timer 0
000084 _H	BT0TMCR2 [R/W] B -----0	BT0STC [R/W] B -0-0-0-0	—	—	
000088 _H	BT0PCSR/BT0PRLL [R/W] H XXXXXXXXXX XXXXXXXXX		BT0PDUT/BT0PRLH/BT0DTBF [R/W] H XXXXXXXXXX XXXXXXXXX		
00008C _H	—	—	—	—	Reserved
000090 _H	BT1TMR [R] H 00000000 00000000		BT1TMCR [R/W] H -000--00 -000-000		Base Timer 1
000094 _H	BT1TMCR2 [R/W] B ----0	BT1STC [R/W] B -0-0-0-0	—	—	
000098 _H	BT1PCSR/BT1PRLL [R/W] H XXXXXXXXXX XXXXXXXXX		BT1PDUT/BT1PRLH/BT1DTBF [R/W] H XXXXXXXXXX XXXXXXXXX		
00009C _H	BTSEL01 [R/W] B ----0000	—	BTSSSR [W] B,H -----11		Base Timer 0,1

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
0000A0 _H to 0000FC _H	—	—	—	—	Reserved
000100 _H	TMRLRA1 [R/W] H XXXXXXXX XXXXXXXX		TMR1 [R] H XXXXXXXX XXXXXXXX		Reload Timer 1
000104 _H	TMRLRB1 [R/W] H XXXXXXXX XXXXXXXX		TMCSR1 [R/W] B, H,W 00000000 0-000000		
000108 _H	TMRLRA2 [R/W] H XXXXXXXX XXXXXXXX		TMR2 [R] H XXXXXXXX XXXXXXXX		Reload Timer 2
00010C _H	TMRLRB2 [R/W] H XXXXXXXX XXXXXXXX		TMCSR2 [R/W] B,H,W 00000000 0-000000		
000110 _H	TMRLRA3 [R/W] H XXXXXXXX XXXXXXXX		TMR3 [R] H XXXXXXXX XXXXXXXX		Reload Timer 3
000114 _H	TMRLRB3 [R/W] H XXXXXXXX XXXXXXXX		TMCSR3 [R/W] B,H,W 00000000 0-000000		
000118 _H	BT2TMR [R] H 00000000 00000000		BT2TMCR [R/W] H -000--00 -000-000		Base Timer 2
00011C _H	BT2TMCR2 [R/W] B -----0	BT2STC [R/W] B -0-0-0-0	—	—	
000120 _H	BT2PCSR/BT2PRL [R/W] H XXXXXXXX XXXXXXXX		BT2PDUT/BT2PRLH/BT2DTBF [R/W] H XXXXXXXX XXXXXXXX		
000124 _H	BT3TMR [R] H 00000000 00000000		BT3TMCR [R/W] H -000--00 -000-000		Base Timer 3
000128 _H	BT3TMCR2 [R/W] B -----0	BT3STC [R/W] B -0-0-0-0	—	—	
00012C _H	BT3PCSR/BT3PRL [R/W] H XXXXXXXX XXXXXXXX		BT3PDUT/BT3PRLH/BT3DTBF [R/W] H XXXXXXXX XXXXXXXX		
000130 _H	BTSEL23 [R/W] B ----0000	—	BTSSSRA [W] B,H -----11		Base Timer 2,3
000134 _H to 0001B4 _H	—	—	—	—	Reserved
0001B8 _H	—	EPFR65 [R/W] B,H,W --000000	—	—	Extended port function register
0001BC _H to 0001C8 _H	—	—	—	—	Reserved
0001CC _H	—	—	EPFR86 [R/W] B,H,W ----0--	—	Extended port function register
0001D0 _H	EPFR88 [R/W] B,H,W -----0	—	—	—	
0001D4 _H	—	—	—	—	Reserved
0001D8 _H	TMRLRA4 [R/W] H XXXXXXXX XXXXXXXX		TMR4 [R] H XXXXXXXX XXXXXXXX		Reload Timer 4
0001DC _H	TMRLRB4 [R/W] H XXXXXXXX XXXXXXXX		TMCSR4 [R/W] B,H,W 00000000 0-000000		
0001E0 _H to 00030C _H	—	—	—	—	Reserved

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
000310 _H	—	—	MPUCR [R/W] H 000000-0 ----0100		MPU ^[S] (Only CPU core can access this area)
000314 _H	—	—	—	—	
000318 _H	—				
00031C _H	—	—	—	—	
000320 _H	DPVAR [R] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000324 _H	—	—	DPVSR [R/W] H ----- 00000--0		
000328 _H	DEAR [R] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
00032C _H	—	—	DESR [R/W] H ----- 00000--0		
000330 _H	PABR0 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXX0000				
000334 _H	—	—	PACR0 [R/W] H 000000-0 00000--0		
000338 _H	PABR1 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXX0000				
00033C _H	—	—	PACR1 [R/W] H 000000-0 00000--0		
000340 _H	PABR2 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXX0000				
000344 _H	—	—	PACR2 [R/W] H 000000-0 00000--0		
000348 _H	PABR3 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXX0000				
00034C _H	—	—	PACR3 [R/W] H 000000-0 00000--0		
000350 _H	PABR4 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXX0000				
000354 _H	—	—	PACR4 [R/W] H 000000-0 00000--0		
000358 _H	PABR5 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXX0000				
00035C _H	—	—	PACR5 [R/W] H 000000-0 00000--0		
000360 _H	PABR6 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXX0000				
000364 _H	—	—	PACR6 [R/W] H 000000-0 00000--0		
000368 _H	PABR7 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXX0000				
00036C _H	—	—	PACR7 [R/W] H 000000-0 00000--0		
000370 _H to 0003FC _H	—	—	—	—	Reserved ^[S]

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
000400 _H	ICSEL0 [R/W] B,H,W -----000	—	ICSEL2 [R/W] B,H,W -----00	ICSEL3 [R/W] B,H,W -----0	DMA request generation and clear
000404 _H	—	ICSEL5 [R/W] B,H,W -----000	—	—	
000408 _H	—	—	—	ICSEL11 [R/W] B,H,W -----000	
00040C _H	—	ICSEL13 [R/W] B,H,W -----00	ICSEL14 [R/W] B,H,W -----00	ICSEL15 [R/W] B,H,W ----0000	
000410 _H	ICSEL16 [R/W] B,H,W -----00	ICSEL17 [R/W] B,H,W ----0000	ICSEL18 [R/W] B,H,W -----00	ICSEL19 [R/W] B,H,W -----0	
000414 _H	ICSEL20 [R/W] B,H,W -----0	ICSEL21 [R/W] B,H,W -----00	ICSEL22 [R/W] B,H,W -----00	ICSEL23 [R/W] B,H,W -----00	
000418 _H	IRPR0H [R] B,H,W 000----	IRPR0L [R] B,H,W 00-----	IRPR1H [R] B,H,W 00-----	IRPR1L [R] B,H,W 00-----	Interrupt Request Batch Reading Register
00041C _H	IRPR2H [R] B,H,W 00-----	IRPR2L [R] B,H,W 00-----	IRPR3H [R] B,H,W 00-----	IRPR3L [R] B,H,W 00-----	
000420 _H	IRPR4H [R] B,H,W 0000----	IRPR4L [R] B,H,W 0000----	IRPR5H [R] B,H,W 0000----	IRPR5L [R] B,H,W 00-----	
000424 _H	IRPR6H [R] B,H,W -0-----	IRPR6L [R] B,H,W 0-0-----	IRPR7H [R] B,H,W 0000----	IRPR7L [R] B,H,W 00000000	
000428 _H	IRPR8H [R] B,H,W 000----	IRPR8L [R] B,H,W 0000----	IRPR9H [R] B,H,W 00000000	IRPR9L [R] B,H,W 00000000	
00042C _H	IRPR10H [R] B,H,W 00000000	IRPR10L [R] B,H,W 00000000	IRPR11H [R] B,H,W 0000----	IRPR11L [R] B,H,W 0000----	
000430 _H	IRPR12H [R] B,H,W 00-----	IRPR12L [R] B,H,W 00-----	IRPR13H [R] B,H,W 00-----	IRPR13L [R] B,H,W 00-----	
000434 _H	IRPR14H [R] B,H,W 00000000	—	IRPR15H [R] B,H,W 0000----	IRPR15L [R] B,H,W -000----	
000438 _H	—	ICSEL25 [R/W] B,H,W ---00000	—	—	DMA request generation and clear
00043C _H	—	—	—	—	Reserved ^[S]

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
000440 _H	ICR00 [R/W] B,H,W ---11111	ICR01 [R/W] B,H,W ---11111	ICR02 [R/W] B,H,W ---11111	ICR03 [R/W] B,H,W ---11111	Interrupt Controller ^[S]
000444 _H	ICR04 [R/W] B,H,W ---11111	ICR05 [R/W] B,H,W ---11111	ICR06 [R/W] B,H,W ---11111	ICR07 [R/W] B,H,W ---11111	
000448 _H	ICR08 [R/W] B,H,W ---11111	ICR09 [R/W] B,H,W ---11111	ICR10 [R/W] B,H,W ---11111	ICR11 [R/W] B,H,W ---11111	
00044C _H	ICR12 [R/W] B,H,W ---11111	ICR13 [R/W] B,H,W ---11111	ICR14 [R/W] B,H,W ---11111	ICR15 [R/W] B,H,W ---11111	
000450 _H	ICR16 [R/W] B,H,W ---11111	ICR17 [R/W] B,H,W ---11111	ICR18 [R/W] B,H,W ---11111	ICR19 [R/W] B,H,W ---11111	
000454 _H	ICR20 [R/W] B,H,W ---11111	ICR21 [R/W] B,H,W ---11111	ICR22 [R/W] B,H,W ---11111	ICR23 [R/W] B,H,W ---11111	
000458 _H	ICR24 [R/W] B,H,W ---11111	ICR25 [R/W] B,H,W ---11111	ICR26 [R/W] B,H,W ---11111	ICR27 [R/W] B,H,W ---11111	
00045C _H	ICR28 [R/W] B,H,W ---11111	ICR29 [R/W] B,H,W ---11111	ICR30 [R/W] B,H,W ---11111	ICR31 [R/W] B,H,W ---11111	
000460 _H	ICR32 [R/W] B,H,W ---11111	ICR33 [R/W] B,H,W ---11111	ICR34 [R/W] B,H,W ---11111	ICR35 [R/W] B,H,W ---11111	
000464 _H	ICR36 [R/W] B,H,W ---11111	ICR37 [R/W] B,H,W ---11111	ICR38 [R/W] B,H,W ---11111	ICR39 [R/W] B,H,W ---11111	
000468 _H	ICR40 [R/W] B,H,W ---11111	ICR41 [R/W] B,H,W ---11111	ICR42 [R/W] B,H,W ---11111	ICR43 [R/W] B,H,W ---11111	
00046C _H	ICR44 [R/W] B,H,W ---11111	ICR45 [R/W] B,H,W ---11111	ICR46 [R/W] B,H,W ---11111	ICR47 [R/W] B,H,W ---11111	
000470 _H to 00047C _H	—	—	—	—	Reserved ^[S]
000480 _H	RSTRR [R] B,H,W XXXX--XX	RSTCR [R/W] B,H,W 111---0	STBCR [R/W] B,H,W * 000---11	—	Reset Control ^[S] Power Control ^[S] *: Writing STBCR by DMA is forbidden
000484 _H	—	—	—	—	Reserved ^[S]
000488 _H	DIVR0 [R/W] B,H,W 000----	—	DIVR2 [R/W] B,H,W 0011----	—	Clock Control ^[S]
00048C _H	—	—	—	—	Reserved ^[S]

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
000490 _H	IORR0 [R/W] B,H,W -0000000	IORR1 [R/W] B,H,W -0000000	IORR2 [R/W] B,H,W -0000000	IORR3 [R/W] B,H,W -0000000	DMA request by peripheral ^[S]
000494 _H	IORR4 [R/W] B,H,W -0000000	IORR5 [R/W] B,H,W -0000000	IORR6 [R/W] B,H,W -0000000	IORR7 [R/W] B,H,W -0000000	
000498 _H	—	—	—	—	
00049C _H	—	—	—	—	
0004A0 _H	—	—	—	—	Reserved
0004A4 _H	CANPRE [R/W] B,H,W ---00000	—	—	—	CAN prescaler
0004A8 _H	—	—	CSCFG[R/W]B,H,W ---0----	CMCFG[R/W]B,H,W 00000000	Clock monitor control register
0004AC _H	—	—	ADERL0[R/W] B,H ----- 11111111		Analog input control register
0004B0 _H to 0004C0 _H	—	—	—	—	Reserved
0004C4 _H	CUCR1 [R/W] B,H,W ----- --0--00		CUTD1 [R/W] B,H,W 11000011 01010000		WDT1 calibration
0004C8 _H	CUTR1 [R] B,H,W ----- 00000000 00000000 00000000				
0004CC _H to 0004E4 _H	—	—	—	—	Reserved
0004E8 _H	PLL2DIVM [R/W] B,H,W ----0000	PLL2DIVN [R/W] B,H,W -0000000	—	—	PWM Clock control
0004EC _H	—	PLL2DIVK [R/W] B,H,W -----0	CLKR2 [R/W] B,H,W 000--000	—	
0004F0 _H	—	PWMCGR0 [R/W] B,H,W 00----00	PWMCGR1 [R/W] B,H,W 00000000	PWMCGR2 [R/W] B,H,W 00000000	
0004F4 _H to 00050C _H	—	—	—	—	Reserved
000510 _H	CSELR [R/W] B,H,W -01---00	CMONR [R] B,H,W -01---00	MTMCR [R/W] B,H,W 00001111	—	Clock Control ^[S]
000514 _H	PLLCR [R/W] B,H,W ----- 11110000		CSTBR [R/W] B,H,W ----0000	PTMCR [R/W] B,H,W 00-----	
000518 _H	—	—	CPUAR [R/W] B,H,W 0---XXX	—	Reset clock ^[S]
00051C _H	—	—	—	—	Reserved ^[S]

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
000520 _H	CCPSSEL _R [R/W] B,H,W -----0	—	—	CCPSDIV _R [R/W] B,H,W -000-000	Clock Control 2 ^[S]
000524 _H	—	CCPLLFB _R [R/W] B,H,W -0000000	CCSSFBR0 [R/W] B,H,W --000000	CCSSFBR1 [R/W] B,H,W ---00000	
000528 _H	—	CCSSCCR0 [R/W] B,H,W ----0000	CCSSCCR1 [R/W] H,W 000-----		
00052C _H	—	CCCGRCR0 [R/W] B,H,W 00----00	CCCGRCR1 [R/W] B,H,W 00000000	CCCGRCR2 [R/W] B,H,W 00000000	
000530 _H to 00053C _H	—	—	—	—	
000540 _H to 00054C _H	—	—	—	—	Reserved
000550 _H	EIRR0 [R/W] B,H,W ----XXXX	ENIR0 [R/W] B,H,W ----0000	ELVR0 [R/W] B,H,W ----- 00000000		External Interrupt (INT0 to 3)
000554 _H to 000568 _H	—	—	—	—	Reserved
00056C _H	—	CSVCR [R/W] B -0-11--0	—	—	Clock Supervisor
000570 _H to 00057C _H	—	—	—	—	Reserved
000580 _H	REGSEL [R/W] B,H,W 01-----	—	—	—	Regulator Control / Low Voltage Detection
000584 _H	LVD5R [R/W] B,H,W -----1	LVD5F [R/W] B,H,W 00110001	LVD [R/W] B,H,W 01000--0	—	
000588 _H to 00059C _H	—	—	—	—	Reserved

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
0005A0 _H	SLPCNT [R/W] B,H,W -----00	—	—	—	Slope Compensation Control
0005A4 _H	SLPEDGESEL1 [R/W] B,H,W ---0-000 ---0-000		SLPEDGESEL2 [R/W] B,H,W ---0-000 ---0-000		
0005A8 _H	SLPSWA [R/W] B,H,W -----100	SLPSWB [R/W] B,H,W -----100	SLPSWC [R/W] B,H,W -----100	—	
0005AC _H	SLP1A [R/W] H,W 00000000 00000000		SLP1B [R/W] H,W 00000000 00000000		
0005B0 _H	SLP1C [R/W] H,W 00000000 00000000		SLP3 [R/W] H,W 00000000 00000000		
0005B4 _H	SLP2A [R/W] H,W 00000000 00000000		SLP2B [R/W] H,W 00000000 00000000		
0005B8 _H	SLP2C [R/W] H,W 00000000 00000000		SLP4 [R/W] H,W 00000000 00000000		
0005BC _H	—	—	SLPDADR [R/W] H,W -----00 00000000		
0005C0 _H	SLPSTMSEL1 [R/W] B,H,W -000-000 -----000		SLPSTMSEL2 [R/W] B,H,W -000-000 -----		
0005C4 _H	SLPCVE [R] H,W -----XX XXXXXXXX		—	—	
0005C8 _H to 0005DC _H	—	—	—	—	Reserved
0005E0 _H	CMPCTL0 [R/W] B,H,W --001000	CMPCTL1 [R/W] B,H,W --001000	CMPCTL2 [R/W] B,H,W --001000	CMPDIV [R/W] B,H,W -----00	Comparator Control
0005E4 _H	CMPDACR0 [R/W] B,H,W -----0	—	CMPDADR0 [R/W] H,W -----00 00000000		
0005E8 _H	CMPDACR1 [R/W] B,H,W -----0	—	CMPDADR1 [R/W] H,W -----00 00000000		
0005EC _H	CMPDACR2 [R/W] B,H,W -----0	—	CMPDADR2 [R/W] H,W -----00 00000000		
0005F0 _H	CMPINT [R/W] B,H,W -----000	—	—	—	
0005F4 _H	CMPST [R] B,H,W -----XXX	—	—	—	
0005F8 _H to 0005FC _H	—	—	—	—	Reserved

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
000600 _H to 0006FC _H	—	—	—	—	Reserved[S]
000700 _H to 00070C _H	—	—	—	—	Reserved
000710 _H	BPCCRA [R/W] B 00000000	BPCCRB [R/W] B 00000000	BPCCRC [R/W] B 00000000	—	Bus Performance Counter
000714 _H	BPCTRA [R/W] W 00000000 00000000 00000000 00000000				
000718 _H	BPCTRB [R/W] W 00000000 00000000 00000000 00000000				
00071C _H	BPCTRC [R/W] W 00000000 00000000 00000000 00000000				
000720 _H to 0007F8 _H	—	—	—	—	Reserved
0007FC _H	BMODR [R] B, H, W XXXXXXXX	—	—	—	Operation Mode
000800 _H to 00083C _H	—	—	—	—	Reserved[S]
000840 _H	FCTL R [R/W] H -0--1000 0-0----		—	FSTR [R/W] B ----001	Flash Memory Register [S]
000844 _H to 000854 _H	—	—	—	—	Reserved[S]
000858 _H	—	—	WREN [R/W] H 00000000 00000000		Wild Register [S]
00085C _H to 00087C _H	—	—	—	—	Reserved[S]
000880 _H	WRAR00 [R/W] W ----- --XXXXXX XXXXXXXX XXXXXX--				Wild Register [S]
000884 _H	WRDR00 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000888 _H	WRAR01 [R/W] W ----- --XXXXXX XXXXXXXX XXXXXX--				
00088C _H	WRDR01 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000890 _H	WRAR02 [R/W] W ----- --XXXXXX XXXXXXXX XXXXXX--				
000894 _H	WRDR02 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000898 _H	WRAR03 [R/W] W ----- --XXXXXX XXXXXXXX XXXXXX--				

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
00089C _H	WRDR03 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				Wild Register [S]
0008A0 _H	WRAR04 [R/W] W ----- --XXXXXX XXXXXXXX XXXXXX--				
0008A4 _H	WRDR04 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
0008A8 _H	WRAR05 [R/W] W ----- --XXXXXX XXXXXXXX XXXXXX--				
0008AC _H	WRDR05 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
0008B0 _H	WRAR06 [R/W] W ----- --XXXXXX XXXXXXXX XXXXXX--				
0008B4 _H	WRDR06 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
0008B8 _H	WRAR07 [R/W] W ----- --XXXXXX XXXXXXXX XXXXXX--				
0008BC _H	WRDR07 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
0008C0 _H	WRAR08 [R/W] W ----- --XXXXXX XXXXXXXX XXXXXX--				
0008C4 _H	WRDR08 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
0008C8 _H	WRAR09 [R/W] W ----- --XXXXXX XXXXXXXX XXXXXX--				
0008CC _H	WRDR09 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
0008D0 _H	WRAR10 [R/W] W ----- --XXXXXX XXXXXXXX XXXXXX--				
0008D4 _H	WRDR10 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
0008D8 _H	WRAR11 [R/W] W ----- --XXXXXX XXXXXXXX XXXXXX--				
0008DC _H	WRDR11 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
0008E0 _H	WRAR12 [R/W] W ----- --XXXXXX XXXXXXXX XXXXXX--				
0008E4 _H	WRDR12 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
0008E8 _H	WRAR13 [R/W] W ----- --XXXXXX XXXXXXXX XXXXXX--				Wild Register [S]
0008EC _H	WRDR13 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
0008F0 _H	WRAR14 [R/W] W ----- --XXXXXX XXXXXXXX XXXXXX--				
0008F4 _H	WRDR14 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
0008F8 _H	WRAR15 [R/W] W ----- --XXXXXX XXXXXXXX XXXXXX--				
0008FC _H	WRDR15 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000900 _H	TPUUNLOCK [R/W] W 00000000 00000000 00000000 00000000				Time Protection Unit[S]
000904 _H	TPULST [R] B,H,W -----0	—	TPUVST [R/W] B,H,W ----000	—	
000908 _H	TPUCFG [R/W] B,H,W -----0 0-000000 -----0				
00090C _H	TPUTIR [R] B,H,W 00000000	—	—	—	
000910 _H	TPUTST [R] B,H,W 00000000	—	—	—	
000914 _H	TPUTIE [R/W] B,H,W 00000000	—	—	—	
000918 _H	TPUTMID [R] B,H,W 00000000 00000000 00000000 00000000				
00091C _H to 00092C _H	—	—	—	—	
000930 _H	TPUTCN00 [R/W] B,H,W 000000-- 00000000 00000000 00000000				
000934 _H	TPUTCN01 [R/W] B,H,W 000000-- 00000000 00000000 00000000				
000938 _H	TPUTCN02 [R/W] B,H,W 000000-- 00000000 00000000 00000000				
00093C _H	TPUTCN03 [R/W] B,H,W 000000-- 00000000 00000000 00000000				
000940 _H	TPUTCN04 [R/W] B,H,W 000000-- 00000000 00000000 00000000				
000944 _H	TPUTCN05 [R/W] B,H,W 000000-- 00000000 00000000 00000000				

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
000948 _H	TPUTCN06 [R/W] B,H,W 000000-- 00000000 00000000 00000000				Time Protection Unit[S]
00094C _H	TPUTCN07 [R/W] B,H,W 000000-- 00000000 00000000 00000000				
000950 _H	TPUTCN10 [RW] B,H,W ---00000	—	—	—	
000954 _H	TPUTCN11 [RW] B,H,W ---00000	—	—	—	
000958 _H	TPUTCN12 [RW] B,H,W ---00000	—	—	—	
00095C _H	TPUTCN13 [RW] B,H,W ---00000	—	—	—	
000960 _H	TPUTCN14 [RW] B,H,W ---00000	—	—	—	
000964 _H	TPUTCN15 [RW] B,H,W ---00000	—	—	—	
000968 _H	TPUTCN16 [RW] B,H,W ---00000	—	—	—	
00096C _H	TPUTCN17 [RW] B,H,W ---00000	—	—	—	
000970 _H	TPUTCC0 [R] B,H,W ----- 00000000 00000000 00000000				
000974 _H	TPUTCC1 [R] B,H,W ----- 00000000 00000000 00000000				
000978 _H	TPUTCC2 [R] B,H,W ----- 00000000 00000000 00000000				
00097C _H	TPUTCC3 [R] B,H,W ----- 00000000 00000000 00000000				
000980 _H	TPUTCC4 [R] B,H,W ----- 00000000 00000000 00000000				
000984 _H	TPUTCC5 [R] B,H,W ----- 00000000 00000000 00000000				
000988 _H	TPUTCC6 [R] B,H,W ----- 00000000 00000000 00000000				
00098C _H	TPUTCC7 [R] B,H,W ----- 00000000 00000000 00000000				
000990 _H to 0009FC _H	—	—	—	—	
000A00 _H to 000BEC _H	—	—	—	—	Reserved

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
000BF0 _H	HSCFR [R/W] B,H,W -----00 00000000 00000000				OC DU
000BF4 _H	—	—	—	—	
000BF8 _H	—	—	MBR [R/W] B,H,W 00----- XXXXXXXX		
000BFC _H	—	—	UER [W] B,H,W -----X		
000C00 _H	DCCR0 [R/W] W 0----000 --00--00 00000000 0-000000				DMA Controller[S]
000C04 _H	DCSR0 [R/W] H 0-----000		DTCR0 [R/W] H 00000000 00000000		
000C08 _H	DSAR0 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000C0C _H	DDAR0 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000C10 _H	DCCR1 [R/W] W 0----000 --00--00 00000000 0-000000				
000C14 _H	DCSR1 [R/W] H 0-----000		DTCR1 [R/W] H 00000000 00000000		
000C18 _H	DSAR1 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000C1C _H	DDAR1 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000C20 _H	DCCR2 [R/W] W 0----000 --00--00 00000000 0-000000				
000C24 _H	DCSR2 [R/W] H 0-----000		DTCR2 [R/W] H 00000000 00000000		
000C28 _H	DSAR2 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000C2C _H	DDAR2 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000C30 _H	DCCR3 [R/W] W 0----000 --00--00 00000000 0-000000				
000C34 _H	DCSR3 [R/W] H 0-----000		DTCR3 [R/W] H 00000000 00000000		
000C38 _H	DSAR3 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000C3C _H	DDAR3 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
000C40 _H	DCCR4 [R/W] W 0----000 --00--00 00000000 0-000000				DMA Controller[S]
000C44 _H	DCSR4 [R/W] H 0-----000		DTCR4 [R/W] H 00000000 00000000		
000C48 _H	DSAR4 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000C4C _H	DDAR4 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000C50 _H	DCCR5 [R/W] W 0----000 --00--00 00000000 0-000000				
000C54 _H	DCSR5 [R/W] H 0-----000		DTCR5 [R/W] H 00000000 00000000		
000C58 _H	DSAR5 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000C5C _H	DDAR5 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000C60 _H	DCCR6 [R/W] W 0----000 --00--00 00000000 0-000000				
000C64 _H	DCSR6 [R/W] H 0-----000		DTCR6 [R/W] H 00000000 00000000		
000C68 _H	DSAR6 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000C6C _H	DDAR6 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000C70 _H	DCCR7 [R/W] W 0----000 --00--00 00000000 0-000000				
000C74 _H	DCSR7 [R/W] H 0-----000		DTCR7 [R/W] H 00000000 00000000		
000C78 _H	DSAR7 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000C7C _H	DDAR7 [R/W] W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000C80 _H to 000DF0 _H	—	—	—	—	Reserved[S]
000DF4 _H	—	—	DNMIR [R/W] B 0-----0	DILVR [R/W] B ---1111	DMA Controller[S]
000DF8 _H	DMACR[R/W] W 0-----0-----				
000DFC _H	—	—	—	—	Reserved[S]

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
000E00 _H	—	—	DDR02 [R/W] B,H,W 00000000	DDR03 [R/W] B,H,W 00000000	Data Direction Register
000E04 _H	DDR04 [R/W] B,H,W 00000000	—	—	—	
000E08 _H to 000E1C _H	—	—	—	—	Reserved
000E20 _H	PFR00 [R/W] B,H,W --000000	—	PFR02 [R/W] B,H,W 00000000	PFR03 [R/W] B,H,W 00000000	Port Function Register
000E24 _H	PFR04 [R/W] B,H,W 00000000	—	—	—	
000E28 _H to 000E3C _H	—	—	—	—	Reserved
000E40 _H	PDDR00 [R] B,H,W --XXXXXX	—	PDDR02 [R] B,H,W XXXXXXXX	PDDR03 [R] B,H,W XXXXXXXX	Port Direct Read Register
000E44 _H	PDDR04 [R] B,H,W XXXXXXXX	—	—	—	
000E48 _H to 000E5C _H	—	—	—	—	Reserved
000E60 _H	—	—	EPFR02 [R/W] B,H,W ---00000	—	Extended Port Function Register
000E64 _H to 000E68 _H	—	—	—	—	
000E70 _H	EPFR16 [R/W] B,H,W -----0	—	—	—	
000E74 _H	—	—	—	—	
000E78 _H	—	—	EPFR26 [R/W] B,H,W -0-0-0-0	—	
000E7C _H	—	—	—	—	
000E80 _H	—	—	—	EPFR35 [R/W] B,H,W --000000	
000E84 _H to 000EBC _H	—	—	—	—	Reserved
000EC0 _H	PPER00 [R/W] B,H,W --000000	—	PPER02 [R/W] B,H,W 00000000	PPER03 [R/W] B,H,W 00000000	Port Pull-up/down Enable Register
000EC4 _H	PPER04 [R/W] B,H,W 00000000	—	—	—	
000EC8 _H to 000F3C _H	—	—	—	—	Reserved

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
000F40 _H	PORTEN [R/W] B,H,W -----0	—	—	—	Port Enable Register
000F44 _H	KEYCDR [R/W] H 00000000 00000000		—	—	Key Code Register
000F48 _H to 000FFC _H	—	—	—	—	Reserved
001000 _H	SACR [R/W] B,H,W -----0	PICD [R/W] B,H,W ----0011	—	—	Clock Control
001004 _H to 00112C _H	—	—	—	—	Reserved
001130 _H	—	—	—	CRCCR [R/W] B,H,W -0000000	CRC calculation unit
001134 _H	CRCINIT [R/W] B,H,W 11111111 11111111 11111111 11111111				
001138 _H	CRCIN [R/W] B,H,W 00000000 00000000 00000000 00000000				
00113C _H	CRCR [R] B,H,W 11111111 11111111 11111111 11111111				
001140 _H to 001200 _H	—	—	—	—	Reserved
001204 _H	CPCLRB0/CPCLR0 [W] H,W 11111111 11111111		TCDT0 [R/W] H,W 00000000 00000000		Free-run Timer 0 (16bit)
001208 _H	TCCS0 [R/W] B,H,W 00000000 01000000 ----0000 -----				
00120C _H to 001278 _H	—	—	—	—	Reserved
00127C _H	IPCP0 [R] H,W 00000000 00000000		—	—	Input Capture 0 (16bit)
001280 _H	ICS01 [R/W] B,H,W -----0 -0-0--00		—	LSYNS [R/W] B,H,W -----000	
001284 _H to 001300 _H	—	—	—	—	Reserved

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
001304 _H	ADTSS0[R/W] B,H ,W-----0	—	—	—	12 bit A/D converter
001308 _H	ADTSE0[R/W] B,H,W ----- 00000000				
00130C _H	—		—		
001310 _H	—		—		
001314 _H	—		—		
001318 _H	—		—		
00131C _H to 001348 _H	—	—	—	—	
00134C _H	ADTCS0[R/W] B,H,W 00000000 -----		ADTCS1[R/W] B,H,W 00000000 -----		
001350 _H	ADTCS2[R/W] B,H,W 00000000 -----		ADTCS3[R/W] B,H,W 00000000 -----		
001354 _H	ADTCS4[R/W] B,H,W 00000000 -----		ADTCS5[R/W] B,H,W 00000000 -----		
001358 _H	ADTCS6[R/W] B,H,W 00000000 -----		ADTCS7[R/W] B,H,W 00000000 -----		
00135C _H to 001388 _H	—	—	—	—	
00138C _H	ADTCD0[R] B,H,W 10--0000 00000000		ADTCD1[R] B,H,W 10--0000 00000000		
001390 _H	ADTCD2[R] B,H,W 10--0000 00000000		ADTCD3[R] B,H,W 10--0000 00000000		
001394 _H	ADTCD4[R] B,H,W 10--0000 00000000		ADTCD5[R] B,H,W 10--0000 00000000		
001398 _H	ADTCD6[R] B,H,W 10--0000 00000000		ADTCD7[R] B,H,W 10--0000 00000000		
00139C _H to 0013C8 _H	—	—	—	—	
0013CC _H	ADTECS0[R/W] B,H,W -----0 ---00000		ADTECS1[R/W] B,H,W -----0 ---00000		
0013D0 _H	ADTECS2[R/W] B,H,W -----0 ---00000		ADTECS3[R/W] B,H,W -----0 ---00000		
0013D4 _H	ADTECS4[R/W] B,H,W -----0 ---00000		ADTECS5[R/W] B,H,W -----0 ---00000		
0013D8 _H	ADTECS6[R/W] B,H,W -----0 ---00000		ADTECS7[R/W] B,H,W -----0 ---00000		
0013DC _H to 001454 _H	—	—	—	—	
001458 _H	ADPRTF0[R] B,H,W ----- 00000000				
00145C _H	—				
001460 _H	ADCS0[R] B,H,W 0-----		ADCH0[R] B,H,W ---00000	ADMD0[R/W] B,H,W 0---0000	
001464 _H	ADSTPCS0[R/W] B,H,W 00000000	ADSTPCS1[R/W] B,H,W 00000000	—	—	
001468 _H	—	—	—	—	
00146C _H	EADTCS0 [R/W] B,H,W ----0000	EADTCS1 [R/W] B,H,W ----0000	EADTCS2 [R/W] B,H,W ----0000	EADTCS3 [R/W] B,H,W ----0000	
001470 _H	EADTCS4 [R/W] B,H,W ----0000	EADTCS5 [R/W] B,H,W ----0000	EADTCS6 [R/W] B,H,W ----0000	EADTCS7 [R/W] B,H,W ----0000	

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
001474 _H to 00174C _H	—	—	—	—	Reserved
001750 _H	SCR0[R/W] B,H,W 0--00000	SMR0[R/W] B,H,W 000-00-0	SSR0[R/W] B,H,W 0-000011	ESCR0[R/W] B,H,W 00000000	Multi-UART0 [1]: Byte access is possible only for access to lower 8 bits. [2]: Reserved because CSIO mode is not set immediately after reset. [3]: Reserved because LIN2.1 mode is not set immediately after reset. [4]: Byte access in CSIO mode is prohibited.
001754 _H	— /(RDR10/(TDR10))[R/W] H,W ----- ^[2]		RDR00/(TDR00)[R/W] B,H,W ^[4] -----0 00000000 ^[1]		
001758 _H	SACSR0[R/W] B,H,W 00-----0 0--00000		STMR0[R] B,H,W 00000000 00000000		
00175C _H	STMCR0[R/W] B,H,W 00000000 00000000		— /(SCSCR0/SFUR0)[R/W] B,H,W ----- ^[2] ^[3]		
001760 _H	— /(SCSTR30)/ (LAMSR0) [R/W] B,H,W----- ^[2]	— /(SCSTR20)/ (LAMCR0) [R/W] B,H,W----- ^[2]	— /(SCSTR10) /(SFLR10) [R/W] B,H,W----- ^[2]	— /(SCSTR00)/ (SFLR00) [R/W] B,H,W----- ^[2]	
001764 _H	—	—	—	— /(SCSFR00) [R/W] B,H,W----- ^[2]	
001768 _H	—/(LAMESR0) [R/W] B,H,W ----- ^[2]	—/(LAMERT0) [R/W] B,H,W ----- ^[2]	—/(TBYTE10)/ (LAMIER0) [R/W] B,H,W ----- ^[2]	TBYTE00/(LAMRID0)/(LAMTID0) [R/W] B,H,W 00000000	
00176C _H	BGR0[R/W] H, W 00000000 00000000		—	—	
001770 _H	FCR10[R/W] B,H,W ---00100	FCR00[R/W] B,H,W -0000000	FBYTE0[R/W] B,H,W 00000000 00000000		
001774 _H	FTICR0[R/W] B,H,W 00000000 00000000		—	—	

Address	Address offset Value/Register name				Blocks
	+0	+1	+2	+3	
001778 _H	SCR1[R/W] B,H,W 0--00000	SMR1[R/W] B,H,W 000-00-0	SSR1[R/W] B,H,W 0-000011	ESCR1[R/W] B,H,W 00000000	Multi-UART1 *1: Byte access is possible only for access to lower 8 bits. *2: Reserved because CSIO mode is not set immediately after reset. [3]: Reserved because LIN2.1 mode is not set immediately after reset. [4]: Byte access in CSIO mode is prohibited.
00177C _H	— /(RDR11/(TDR11))[R/W] H,W ----- ^[2]		RDR01/(TDR01)[R/W] B,H,W ^[4] -----0 00000000 ^[1]		
001780 _H	SACSR1[R/W] B,H,W 00-----0 0--00000		STMR1[R] B,H,W 00000000 00000000		
001784 _H	STMCR1[R/W] B,H,W 00000000 00000000		— /(SCSCR1/SFUR1)[R/W] B,H,W ----- ^[2] ^[3]		
001788 _H	— /(SCSTR31)/ (LAMSR1) [R/W] B,H,W ----- ^[2]	— /(SCSTR21)/ (LAMCR1) [R/W] B,H,W ----- ^[2]	— /(SCSTR11)/ (SFLR11) [R/W] B,H,W ----- ^[2]	— /(SCSTR01)/ (SFLR01) [R/W] B,H,W ----- ^[2]	
00178C _H	—	—	—	— /(SCSFR01) [R/W] B,H,W ----- ^[2]	
001790 _H	—/(LAMESR1) [R/W] B,H,W ----- ^[2]	—/(LAMERT1) [R/W] B,H,W ----- ^[2]	—/(TBYTE11)/ (LAMIER1) [R/W] B,H,W ----- ^[2]	TBYTE01/(LAMRID1)/ (LAMTID1) [R/W] B,H,W 00000000	
001794 _H	BGR1[R/W] H,W 00000000 00000000		—	—	
001798 _H	FCR11[R/W] B,H,W ---00100	FCR01[R/W] B,H,W -0000000	FBYTE1[R/W] B,H,W 00000000 00000000		
00179C _H	FTICR1[R/W] B,H,W 00000000 00000000		—	—	

Address	Address offset Value/Register name				Blocks
	+0	+1	+2	+3	
0017A0 _H	SCR2[R/W] B,H,W 0--00000	SMR2[R/W] B,H,W 000-00-0	SSR2[R/W] B,H,W 0-000011	ESCR2[R/W] B,H,W 00000000	Multi-UART2 [1]: Byte access is possible only for access to lower 8 bits.
0017A0 _H	SCR2[R/W] B,H,W 0--00000	SMR2[R/W] B,H,W 000-00-0	SSR2[R/W] B,H,W 0-000011	ESCR2[R/W] B,H,W 00000000	
0017A4 _H	— /(RDR12/(TDR12))[R/W] H,W ----- [2]		RDR02/(TDR02)[R/W] B,H,W ^[4] -----0 00000000 ^[1]		[2]: Reserved because CSIO mode is not set immediately after reset.
0017A8 _H	SACSR2[R/W] B,H,W 00-----0 0--00000		STMR2[R] B,H,W 00000000 00000000		
0017AC _H	STMCR2[R/W] B,H,W 00000000 00000000		— /(SCSCR2/SFUR2)[R/W] B,H,W ----- [2] [3]		[3]: Reserved because LIN2.1 mode is not set immediately after reset.
0017B0 _H	— /(SCSTR32)/ (LAMSR2) [R/W] B,H,W ----- [2]	— /(SCSTR22)/ (LAMCR2) [R/W] B,H,W ----- [2]	— /(SCSTR12)/ (SFLR12) [R/W] B,H,W ----- [2]	— /(SCSTR02)/ (SFLR02) [R/W] B,H,W ----- [2]	
0017B4 _H	—	—	—	— /(SCSFR02) [R/W] B,H,W ----- [2]	[4]: Byte access in CSIO mode is prohibited.
0017B8 _H	—/(LAMESR2) [R/W] B,H,W ----- [2]	—/(LAMERT2) [R/W] B,H,W ----- [2]	—/(TBYTE12)/ (LAMIER2) [R/W] B,H,W ----- [2]	TBYTE02/(LAMRID2)/ (LAMTID2) [R/W] B,H,W 00000000	
0017BC _H	BGR2[R/W] H, W 00000000 00000000		—	—	
0017C0 _H	FCR12[R/W] B,H,W ---00100	FCR02[R/W] B,H,W -0000000	FBYTE2[R/W] B,H,W 00000000 00000000		
0017C4 _H	FTICR2[R/W] B,H,W 00000000 00000000		—	—	
0017C8 _H to 0020FC _H	—	—	—	—	Reserved

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
002100 _H	CTRLR1 [R/W] B,H,W ----- 000-0001		STATR1 [R/W] B,H,W ----- 00000000		CAN (64msb)
002104 _H	ERRCNT1 [R] B,H,W 00000000 00000000		BTR1 [R/W] B,H,W -0100011 00000001		
002108 _H	INTR1 [R] H,W 00000000 00000000		TESTR1 [R/W] B,H,W ----- X00000--		
00210C _H	BRPER1 [R/W] B,H,W ----- ----0000		—	—	
002110 _H	IF1CREQ1 [R/W] B,H,W 0----- 00000001		IF1CMSK1 [R/W] B,H,W ----- 00000000		
002114 _H	IF1MSK21 [R/W] B,H,W 11-11111 11111111		IF1MSK11 [R/W] B,H,W 11111111 11111111		
002118 _H	IF1ARB21 [R/W] B,H,W 00000000 00000000		IF1ARB11 [R/W] B,H,W 00000000 00000000		
00211C _H	IF1MCTR1 [R/W] B,H,W 00000000 0---0000		—	—	
002120 _H	IF1DTA11 [R/W] B,H,W 00000000 00000000		IF1DTA21 [R/W] B,H,W 00000000 00000000		
002124 _H	IF1DTB11 [R/W] B,H,W 00000000 00000000		IF1DTB21 [R/W] B,H,W 00000000 00000000		
002128 _H	—	—	—	—	
00212C _H	—	—	—	—	
002130 _H , 002134 _H	Reserved (IF1 data mirror)				
002138 _H	—	—	—	—	
00213C _H	—	—	—	—	
002140 _H	IF2CREQ1 [R/W] B,H,W 0----- 00000001		IF2CMSK1 [R/W] B,H,W ----- 00000000		
002144 _H	IF2MSK21 [R/W] B,H,W 11-11111 11111111		IF2MSK11 [R/W] B,H,W 11111111 11111111		
002148 _H	IF2ARB21 [R/W] B,H,W 00000000 00000000		IF2ARB11 [R/W] B,H,W 00000000 00000000		
00214C _H	IF2MCTR1 [R/W] B,H,W 00000000 0---0000		—	—	
002150 _H	IF2DTA11 [R/W] B,H,W 00000000 00000000		IF2DTA21 [R/W] B,H,W 00000000 00000000		

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
002154 _H	IF2DTB11 [R/W] B,H,W 00000000 00000000		IF2DTB21 [R/W] B,H,W 00000000 00000000		CAN (64msb)
002158 _H	—	—	—	—	
00215C _H	—	—	—	—	
002160 _H , 002164 _H	Reserved (IF2 data mirror)				
002168 _H To 00217C _H	—				
002180 _H	TREQR21 [R] B,H,W 00000000 00000000		TREQR11 [R] B,H,W 00000000 00000000		
002184 _H	TREQR41 [R] B,H,W 00000000 00000000		TREQR31 [R] B,H,W 00000000 00000000		
002188 _H	—	—	—	—	
00218C _H	—	—	—	—	
002190 _H	NEWDT21 [R] B,H,W 00000000 00000000		NEWDT11 [R] B,H,W 00000000 00000000		
002194 _H	NEWDT41 [R] B,H,W 00000000 00000000		NEWDT31 [R] B,H,W 00000000 00000000		
002198 _H	—	—	—	—	
00219C _H	—	—	—	—	
0021A0 _H	INTPND21 [R] B,H,W 00000000 00000000		INTPND11 [R] B,H,W 00000000 00000000		
0021A4 _H	INTPND41 [R] B,H,W 00000000 00000000		INTPND31 [R] B,H,W 00000000 00000000		
0021A8 _H	—	—	—	—	
0021AC _H	—	—	—	—	
0021B0 _H	MSGVAL21 [R] B,H,W 00000000 00000000		MSGVAL11 [R] B,H,W 00000000 00000000		
0021B4 _H	MSGVAL41 [R] B,H,W 00000000 00000000		MSGVAL31 [R] B,H,W 00000000 00000000		
0021B8 _H	—	—	—	—	
0021BC _H	—	—	—	—	
0021C0 _H to 0022FC _H	—				Reserved

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
002300 _H	DFCTLR [R/W] B,H,W -0-----		—	DFSTR [R/W] B,H,W -----001	WorkFlash
002304 _H	—	—	—	—	
002308 _H	FLIFCTLR [R/W] B,H,W ---0--00	—	FLIFFER1 [R/W] B,H,W -----	FLIFFER2 [R/W] B,H,W -----	Flash / WorkFlash
00230C _H to 0023FC _H	—				Reserved
002400 _H	SEEARX [R] B,H,W -0000000 00000000		DEEARX [R] B,H,W -0000000 00000000		XBS RAM ECC control
002404 _H	EECSRX [R/W] B,H,W ----00-0	—	EFEARX [R/W] B,H,W -0000000 00000000		
002408 _H	—	EFECRX [R/W] B,H,W -----0 00000000 00000000			
00240C _H to 003008 _H	—				Reserved
00300C _H	TEAR0X[R] B,H,W 000----- -0000000 00000000				RAM diagnosis XBS RAM
003010 _H	TEAR1X[R] B,H,W 000----- -0000000 00000000				
003014 _H	TEAR2X[R] B,H,W 000----- -0000000 00000000				
003018 _H	TAEARX [R/W] B,H,W -1111111 11111111		TASARX [R/W] B,H,W -0000000 00000000		
00301C _H	TFECRX [R/W] B,H,W ----0000	TICRX [R/W] B,H,W ----0000	TTCRX [R/W] B,H,W -----00 00001100		
003020 _H	TSRCRX [W] B,H,W 0-----	—	—	TKCCR [R/W] B,H,W 00----00	
003024 _H to 0030FC _H	—				Reserved

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
003100 _H	BUSDIGSR0[R/W] H,W 00000000 0-----00		BUSDIGSR1[R/W] H,W 00000000 0-----00		Bus diagnosis
003104 _H	BUSDIGSR2[R/W] H,W 00000000 0-----00		BUSTSTR0[R/W] H,W 00--0000 00000000		
003108 _H	BUSADR0 [R] W 00000000 00000000 00000000 00000000				
00310C _H	BUSADR1 [R] W 00000000 00000000 00000000 00000000				
003110 _H	BUSADR2 [R] W 00000000 00000000 00000000 00000000				
003114 _H	—	—	BUSDIGSR3[R/W] H,W 00000000 0-----00		
003118 _H	BUSDIGSR4[R/W] H,W 00000000 0-----00		BUSTSTR1[R/W] H,W 00--000- 00000000		
00311C _H	—	—	—	—	
003120 _H	BUSADR3 [R] W 00000000 00000000 00000000 00000000				
003124 _H	BUSADR4 [R] W 00000000 00000000 00000000 00000000				
003128 _H to 00313C _H	—				Reserved
003140 _H	PWCINIT0 [R/W] B,H,W -----0	PWCC0 [R/W] B,H,W ---00000	—	—	PWC 0ch
003144 _H	PWCCPCLRB00/PWCCPCLR00 [W] H,W 11111111 11111111		PWCTCDT00 [R/W] H,W 00000000 00000000		
003148 _H	PWCTCCS00 [R/W] B,H,W -0000000 0--0-000		—	—	
00314C _H	PWCCPCLRB10/PWCCPCLR10 [W] H,W 11111111 11111111		PWCTCDT10 [R/W] H,W 00000000 00000000		
003150 _H	PWCTCCS10 [R/W] B,H,W -0000000 0--0----		—	—	
003154 _H	PWCDBR00 [R] H,W 00000000 00000000		PWCDBR10 [R] H,W 00000000 00000000		
003158 _H	PWCDBR20 [R] H,W 00000000 00000000		PWCDBR30 [R] H,W 00000000 00000000		
00315C _H	PWCDBS0 [R] B,H,W -000-000 -000-000		—	—	
003160 _H	PWCBFIRQF0 [R/W] B,H,W 00000000 00000000		—	—	

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
003164 _H	PWCBFIRQC0 [R/W] B,H,W 00000000 00000000 00000000			—	PWC 0ch
003168 _H	PWCCUC00 [R/W] H,W 00000000 00000000		PWCCLC00 [R/W] H,W 00000000 00000000		
00316C _H	PWCCUC10 [R/W] H,W 00000000 00000000		PWCCLC10 [R/W] H,W 00000000 00000000		
003170 _H	PWCCUC20 [R/W] H,W 00000000 00000000		PWCCLC20 [R/W] H,W 00000000 00000000		
003174 _H	PWCCUC30 [R/W] H,W 00000000 00000000		PWCCLC30 [R/W] H,W 00000000 00000000		
003178 _H	PWCINIT1 [R/W] B,H,W -----0	PWCC1 [R/W] B,H,W ---00000	—	—	PWC 1ch
00317C _H	PWCCPCLRB01/PWCCPCLR01 [W] H,W 11111111 11111111		PWCTCDT01 [R/W] H,W 00000000 00000000		
003180 _H	PWCTCCS01 [R/W] B,H,W -0000000 0--0-000		—	—	
003184 _H	PWCCPCLRB11/PWCCPCLR11 [W] H,W 11111111 11111111		PWCTCDT11 [R/W] H,W 00000000 00000000		
003188 _H	PWCTCCS11 [R/W] B,H,W -0000000 0--0----		—	—	
00318C _H	PWCDDBR01 [R] H,W 00000000 00000000		PWCDDBR11 [R] H,W 00000000 00000000		
003190 _H	PWCDDBR21 [R] H,W 00000000 00000000		PWCDDBR31 [R] H,W 00000000 00000000		
003194 _H	PWCDBS1 [R] B,H,W -000-000 -000-000		—	—	
003198 _H	PWCBFIRQF1 [R/W] B,H,W 00000000 00000000		—	—	
00319C _H	PWCBFIRQC1 [R/W] B,H,W 00000000 00000000 00000000			—	
0031A0 _H	PWCCUC01 [R/W] H,W 00000000 00000000		PWCCLC01 [R/W] H,W 00000000 00000000		
0031A4 _H	PWCCUC11 [R/W] H,W 00000000 00000000		PWCCLC11 [R/W] H,W 00000000 00000000		
0031A8 _H	PWCCUC21 [R/W] H,W 00000000 00000000		PWCCLC21 [R/W] H,W 00000000 00000000		
0031AC _H	PWCCUC31 [R/W] H,W 00000000 00000000		PWCCLC31 [R/W] H,W 00000000 00000000		

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
0031B0 _H to 0031BC _H	—		—		Reserved
0031C0 _H	PWMTCGS [R/W] B,H,W -----00	—	—	PWMTCGSE [R/W] B,H,W -----00	PWM master clock generation
0031C4 _H	PWMCPCLRB0/PWMCPCLR0 [W] H,W 11111111 11111111		PWMTCDT0 [R/W] H,W 00000000 00000000		
0031C8 _H	PWMTCCS0 [R/W] B,H,W -0000000 0100-000 ----0000			—	
0031CC _H	PWMCPCLRB1/PWMCPCLR1 [W] H,W 11111111 11111111		PWMTCDT1 [R/W] H,W 00000000 00000000		
0031D0 _H	PWMTCCS1 [R/W] B,H,W -0000000 0100---- ----0000			—	
0031D4 _H	PWMTRC [R/W] B,H,W -0000000 -000-000 ----000			—	
0031D8 _H	PWMSYNCP0 [R/W] H,W 00000000 00000000		PWMSYNCP1 [R/W] H,W 00000000 00000000		
0031DC _H	PWMSEVCON [R/W] B,H,W ---00000 ---00000		—	—	
0031E0 _H	PWMSEVST [R/W] B,H,W -----00	—	—	—	
0031E4 _H	PWMSEVCP0 [R/W] H,W 00000000 00000000		PWMSEVCP1 [R/W] H,W 00000000 00000000		
0031E8 _H	PWWMMCD0B [R/W] H,W 00000000 00000000		PWWMMCD1B [R/W] H,W 00000000 00000000		
0031EC _H	PWMST0 [R/W] B,H,W ----0000	PWMST1 [R/W] B,H,W ----0000	PWMST2 [R/W] B,H,W ----0000	PWMFLTST [R] B,H,W --XXXXXX	
0031F0 _H	PWMCMD [R/W] H,W 00000000 00000000		PWMPCGS [R/W] B,H,W -----000	—	PWM PWM generation
0031F4 _H	PWMPCN01 [R/W] B,H,W 00000000 -----00		—	—	
0031F8 _H	PWMCC0B [R/W] H,W 00000000 00000000		PWMCP0B [R/W] H,W 00000000 00000000		
0031FC _H	PWMCD0B [R/W] H,W 00000000 00000000		PWMP TMR0 [R] H,W 00000000 00000000		
003200 _H	PWMCC1B [R/W] H,W 00000000 00000000		PWMCP1B [R/W] H,W 00000000 00000000		

Address	Address offset Value/Register name				Block	
	+0	+1	+2	+3		
003204 _H	PWMCD1B [R/W] H,W 00000000 00000000		PWMPTMR1 [R] H,W 00000000 00000000		PWM PWM generation	
003208 _H	PWMPCN23 [R/W] B,H,W 00000000 -----00		—	—		
00320C _H	PWMCC2B [R/W] H,W 00000000 00000000		PWMCP2B [R/W] H,W 00000000 00000000			
003210 _H	PWMCD2B [R/W] H,W 00000000 00000000		PWMPTMR2 [R] H,W 00000000 00000000			
003214 _H	PWMCC3B [R/W] H,W 00000000 00000000		PWMCP3B [R/W] H,W 00000000 00000000			
003218 _H	PWMCD3B [R/W] H,W 00000000 00000000		PWMPTMR3 [R] H,W 00000000 00000000			
00321C _H	PWMPCN45 [R/W] B,H,W 00000000 -----00		—	—		
003220 _H	PWMCC4B [R/W] H,W 00000000 00000000		PWMCP4B [R/W] H,W 00000000 00000000			
003224 _H	PWMCD4B [R/W] H,W 00000000 00000000		PWMPTMR4 [R] H,W 00000000 00000000			
003228 _H	PWMCC5B [R/W] H,W 00000000 00000000		PWMCP5B [R/W] H,W 00000000 00000000			
00322C _H	PWMCD5B [R/W] H,W 00000000 00000000		PWMPTMR5 [R] H,W 00000000 00000000			
003230 _H	PWMFLTRCON0 [R/W] B,H,W 00000000 -0000-00		PWMFLTRCON1 [R/W] B,H,W 00000000 -0000-00		PWM fault	
003234 _H	PWMFLTRCON0 [R/W] B,H,W -000-000 -000-000		PWMFLTRCAPCON0 [R/W] B,H,W --00--00 -00000000			
003238 _H	PWMFLTSR0 [R/W] B,H,W -----0 -----0		—	—		
00323C _H	PWMCAPITH0 [R/W] H,W 00000000 00000000		—	—		
003240 _H	PWMFLTRDCON0 [R/W] H,W 00000000 00000000 00000000 00000000					
003244 _H	PWMFLTRDCON1 [R/W] H,W 00000000 00000000 00000000 00000000					
003248 _H	PWMFLTRCAPRDCON0 [R/W] H,W 00000000 00000000 00000000 00000000					
00324C _H	PWMFLTRCAPD0 [R] H,W 00000000 00000000 00000000 00000000					

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
003250 _H	PWMFLTCON10 [R/W] B,H,W 00000000 -0000-00		PWMFLTCON11 [R/W] B,H,W 00000000 -0000-00		PWM fault
003254 _H	PWMFLTRCON1 [R/W] B,H,W -000-000 -000-000		PWMFLTCAPCON1 [R/W] B,H,W --00--00 -00000000		
003258 _H	PWMFLTSR1 [R/W] B,H,W -----0 -----0		—	—	
00325C _H	PWMCAPITH1 [R/W] H,W 00000000 00000000		—	—	
003260 _H	PWMFLTRDCON10 [R/W] H,W 00000000 00000000 00000000 00000000				
003264 _H	PWMFLTRDCON11 [R/W] H,W 00000000 00000000 00000000 00000000				
003268 _H	PWMFLTCAPRDCON1 [R/W] H,W 00000000 00000000 00000000 00000000				
00326C _H	PWMFLTCAPD1 [R] H,W 00000000 00000000 00000000 00000000				
003270 _H	PWMFLTCON20 [R/W] B,H,W 00000000 -0000-00		PWMFLTCON21 [R/W] B,H,W 00000000 -0000-00		
003274 _H	PWMFLTRCON2 [R/W] B,H,W -000-000 -000-000		PWMFLTCAPCON2 [R/W] B,H,W --00--00 -00000000		
003278 _H	PWMFLTSR2 [R/W] B,H,W -----0 -----0		—	—	
00327C _H	PWMCAPITH2 [R/W] H,W 00000000 00000000		—	—	
003280 _H	PWMFLTRDCON20 [R/W] H,W 00000000 00000000 00000000 00000000				
003284 _H	PWMFLTRDCON21 [R/W] H,W 00000000 00000000 00000000 00000000				
003288 _H	PWMFLTCAPRDCON2 [R/W] H,W 00000000 00000000 00000000 00000000				
00328C _H	PWMFLTCAPD2 [R] H,W 00000000 00000000 00000000 00000000				

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
003290 _H	PWMSOWCON0 [R/W] B,H,W 00000000 -----0 00000000 00000000				PWM soft overwrite control
003294 _H	PWMSOWCON1 [R/W] B,H,W 00000000 -----0 00000000 00000000				
003298 _H	PWMSOWCON2 [R/W] B,H,W 00000000 -----0 00000000 00000000				
00329C _H	PWMDMOD [R/W] B,H,W--000000	—	—	—	PWM dead time
0032A0 _H	PWMHRTMRR0 [R/W] H,W 00000000 00000000		PWMHFTMRR0 [R/W] H,W 00000000 00000000		
0032A4 _H	PWMLRTMRR0 [R/W] H,W 00000000 00000000		PWMLFTMRR0 [R/W] H,W 00000000 00000000		
0032A8 _H	PWMHRTMRR1 [R/W] H,W 00000000 00000000		PWMHFTMRR1 [R/W] H,W 00000000 00000000		
0032AC _H	PWMLRTMRR1 [R/W] H,W 00000000 00000000		PWMLFTMRR1 [R/W] H,W 00000000 00000000		
0032B0 _H	PWMHRTMRR2 [R/W] H,W 00000000 00000000		PWMHFTMRR2 [R/W] H,W 00000000 00000000		
0032B4 _H	PWMLRTMRR2 [R/W] H,W 00000000 00000000		PWMLFTMRR2 [R/W] H,W 00000000 00000000		
0032B8 _H	PWMLEBCON0 [R/W] B,H,W -000-000 -000-000 ----0000			—	
0032BC _H	PWMLEBSDCON00 [R/W] H,W 00000000 00000000		PWMLEBSDCON01 [R/W] H,W 00000000 00000000		PWM Blanking
0032C0 _H	PWMLEBSDCON02 [R/W] H,W 00000000 00000000		PWMLEBSDCON03 [R/W] H,W 00000000 00000000		
0032C4 _H	PWMLEBTCON00 [R/W] H,W 00000000 00000000 00000000 00000000				
0032C8 _H	PWMLEBTCON01 [R/W] H,W 00000000 00000000 00000000 00000000				
0032CC _H	PWMLEBCON1 [R/W] B,H,W -000-000 -000-000 ----0000			—	
0032D0 _H	PWMLEBSDCON10 [R/W] H,W 00000000 00000000		PWMLEBSDCON11 [R/W] H,W 00000000 00000000		
0032D4 _H	PWMLEBSDCON12 [R/W] H,W 00000000 00000000		PWMLEBSDCON13 [R/W] H,W 00000000 00000000		
0032D8 _H	PWMLEBTCON10 [R/W] H,W 00000000 00000000 00000000 00000000				

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
0032DC _H	PWMLBETCON11 [R/W] H,W 00000000 00000000 00000000 00000000				PWM Blanking
0032E0 _H	PWMLBETCON2 [R/W] B,H,W -000-000 -000-000 ----0000			—	
0032E4 _H	PWMLBETSDCON20 [R/W] H,W 00000000 00000000		PWMLBETSDCON21 [R/W] H,W 00000000 00000000		
0032E8 _H	PWMLBETSDCON22 [R/W] H,W 00000000 00000000		PWMLBETSDCON23 [R/W] H,W 00000000 00000000		
0032EC _H	PWMLBETCON20 [R/W] H,W 00000000 00000000 00000000 00000000				
0032F0 _H	PWMLBETCON21 [R/W] H,W 00000000 00000000 00000000 00000000				
0032F4 _H	PWMADTCON [R/W] B,H,W 00000000 00000000 --000000 ----0000				PWM trigger
0032F8 _H	PWMADTST [R/W] B,H,W ----0000	—	—	—	
0032FC _H	PWMADTDCON0 [R/W] H,W 00000000 00000000		PWMADTDCON1 [R/W] H,W 00000000 00000000		
003300 _H	PWMADTDCON2 [R/W] H,W 00000000 00000000		PWMADTDCON3 [R/W] H,W 00000000 00000000		
003304 _H to 00331C _H	—				Reserved
003320 _H	AD4EN [R/W] B,H,W -----0	—	—	—	12 bit 4ch A/D converter
003324 _H	AD4TSS [R/W] B,H,W -----0	—	—	—	
003328 _H	AD4TSE [R/W] B,H,W -----00000000				
00332C _H	AD4TCS0 [R/W] B,H,W ---00--- -----		AD4TCS1 [R/W] B,H,W ---00--- -----		
003330 _H	AD4TCS2 [R/W] B,H,W ---00--- -----		AD4TCS3 [R/W] B,H,W ---00--- -----		
003334 _H	AD4TCS4 [R/W] B,H,W ---00--- -----		AD4TCS5 [R/W] B,H,W ---00--- -----		
003338 _H	AD4TCS6 [R/W] B,H,W ---00--- -----		AD4TCS7 [R/W] B,H,W ---00--- -----		

Address	Address offset Value/Register name				Block
	+0	+1	+2	+3	
00333C _H	AD4TBUSY [R/W] B,H,W ----- 00000000				12 bit 4ch A/D converter
003340 _H	AD4TECS0 [R/W] B,H,W 00--0000 0000----		AD4TECS1 [R/W] B,H,W 00--0000 0000----		
003344 _H	AD4TECS2 [R/W] B,H,W 00--0000 0000----		AD4TECS3 [R/W] B,H,W 00--0000 0000----		
003348 _H	AD4TECS4 [R/W] B,H,W 00--0000 0000----		AD4TECS5 [R/W] B,H,W 00--0000 0000----		
00334C _H	AD4TECS6 [R/W] B,H,W 00--0000 0000----		AD4TECS7 [R/W] B,H,W 00--0000 0000----		
003350 _H	AD4PTC8 [R/W] B,H,W 0000----	AD4PTC9 [R/W] B,H,W 0000----	AD4PTC10 [R/W] B,H,W 0000----	AD4PTC11 [R/W] B,H,W 0000----	
003354 _H	AD4TCD8 [R] B,H,W 10--0000 00000000		AD4TCD9 [R] B,H,W 10--0000 00000000		
003358 _H	AD4TCD10 [R] B,H,W 10--0000 00000000		AD4TCD11 [R] B,H,W 10--0000 00000000		
00335C _H	AD4CS [R/W] B,H,W 00----- 00-----		—	AD4MD [R/W] B,H,W ----0000	
003360 _H	AD4PRTF [R] B,H,W ----- ----0000				
003364 _H to 00EFC _H	—				Reserved
00F00 _H to 00FEFC _H	—	—	—	—	Reserved ^[S]

Address	Address offset Value/Register name				Blocks
	+0	+1	+2	+3	
00FF00 _H	DSUCR [R/W] B,H,W -----0		—	—	OCDU ^[S]
00FF04 _H to 00FF0C _H	—				
00FF10 _H	PCSR [R/W] B,H,W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
00FF14 _H	PSSR [R/W] B,H,W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
00FF18 _H to 00FF4 _H	—				
00FFF8 _H	EDIR1 [R] B,H,W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
00FFFC _H	EDIR0 [R] B,H,W XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				

[S]: It is a system register. The illegal instruction exception (data access error) is generated in these registers in the user mode when reading and writing to it.

10. Interrupt Vector Table

This list shows the assignments of interrupt factors and interrupt vectors/interrupt control registers.

10.1 Interrupt vector

Interrupt factor	Interrupt number		Interrupt level	Offset	Default address for TBR	RN*
	Decimal	Hexadecimal				
Reset	0	0	-	3FC _H	000FFFC _H	-
System reserved	1	1	-	3F8 _H	000FFFF8 _H	-
System reserved	2	2	-	3F4 _H	000FFFF4 _H	-
System reserved	3	3	-	3F0 _H	000FFFF0 _H	-
System reserved	4	4	-	3EC _H	000FFFE4 _H	-
FPU exception	5	5	-	3E8 _H	000FFFE8 _H	-
Exception of instruction access protection violation	6	6	-	3E4 _H	000FFFE4 _H	-
Exception of data access protection violation	7	7	-	3E0 _H	000FFFE0 _H	-
Data access error interrupt	8	8	-	3DC _H	000FFFD4 _H	-
INTE instruction	9	9	-	3D8 _H	000FFFD8 _H	-
Instruction break	10	0A	-	3D4 _H	000FFFD4 _H	-
System reserved	11	0B	-	3D0 _H	000FFFD0 _H	-
System reserved	12	0C	-	3CC _H	000FFFC4 _H	-
System reserved	13	0D	-	3C8 _H	000FFFC8 _H	-
Exception of invalid instruction	14	0E	-	3C4 _H	000FFFC4 _H	-
NMI request	15	0F	15(F _H) Fixed	3C0 _H	000FFFC0 _H	-
Error generation during internal bus diagnosis						
XBS RAM double-bit error generation						
TPU violation						
External interrupt 0-3	16	10	ICR00	3BC _H	000FFFB4 _H	0
External low-voltage detection interrupt	17	11	ICR01	3B8 _H	000FFFB8 _H	-
Reload timer 0/1/4	18	12	ICR02	3B4 _H	000FFFB4 _H	2
Reload timer 2/3	19	13	ICR03	3B0 _H	000FFFB0 _H	3
Multi-function serial interface ch.0 (reception completed)	20	14	ICR04	3AC _H	000FFFA4 _H	4 ^[1]
Multi-function serial interface ch.0 (status)						
Multi-function serial interface ch.0 (transmission completed)	21	15	ICR05	3A8 _H	000FFFA8 _H	5 ^[1]
Multi-function serial interface ch.1 (reception completed)	22	16	ICR06	3A4 _H	000FFFA4 _H	6 ^[1]
Multi-function serial interface ch.1(status)						
Multi-function serial interface ch.1 (transmission completed)	23	17	ICR07	3A0 _H	000FFFA0 _H	7 ^[1]
Multi-function serial interface ch.2 (reception completed)	24	18	ICR08	39C _H	000FFF9C _H	8 ^[1]
Multi-function serial interface ch.2(status)						
Multi-function serial interface ch.2 (transmission completed)	25	19	ICR09	398 _H	000FFF98 _H	9 ^[1]
-	26	1A	ICR10	394 _H	000FFF94 _H	-

Interrupt factor	Interrupt number		Interrupt level	Offset	Default address for TBR	RN*
	Decimal	Hexadecimal				
-	27	1B	ICR11	390 _H	000FFF90 _H	-
-	28	1C	ICR12	38C _H	000FFF8C _H	-
-	29	1D	ICR13	388 _H	000FFF88 _H	-
-	30	1E	ICR14	384 _H	000FFF84 _H	-
-	31	1F	ICR15	380 _H	000FFF80 _H	-
-	32	20	ICR16	37C _H	000FFF7C _H	-
-	33	21	ICR17	378 _H	000FFF78 _H	-
CAN	34	22	ICR18	374 _H	000FFF74 _H	-
RAM diagnosis end	35	23	ICR19	370 _H	000FFF70 _H	-
RAM initialization completion						
Error generation during RAM diagnosis						
4ch A/D converter irregular activation interrupt/insufficient sampling time interrupt	36	24	ICR20	36C _H	000FFF6C _H	-
-	37	25	ICR21	368 _H	000FFF68 _H	-
PWM special event interrupt 0/1	38	26	ICR22	364 _H	000FFF64 _H	-
16-bit Free-run timer 0 (0 detection) / (compare clear)	39	27	ICR23	360 _H	000FFF60 _H	23
PWM 0 detection interrupt 0, compare clear interrupt 0	40	28	ICR24	35C _H	000FFF5C _H	-
PWM 0 detection interrupt 1, compare clear interrupt 1	41	29	ICR25	358 _H	000FFF58 _H	-
PWM SOW interrupt 0, fault interrupt 0/1, capture interrupt 0	42	2A	ICR26	354 _H	000FFF54 _H	-
PWM SOW interrupt 1, fault interrupt 2/3, capture interrupt 1	43	2B	ICR27	350 _H	000FFF50 _H	-
PWM SOW interrupt 2, fault interrupt 4/5, capture interrupt 2	44	2C	ICR28	34C _H	000FFF4C _H	-
16bit ICU 0 (fetching)	45	2D	ICR29	348 _H	000FFF48 _H	29
Main timer	46	2E	ICR30	344 _H	000FFF44 _H	30
PLL timer						
PWM trigger interrupt 0/1/2/3	47	2F	ICR31	340 _H	000FFF40 _H	-
A/D converter 0/1/2/3/4/5/6/7	48	30	ICR32	33C _H	000FFF3C _H	32
Clock calibration unit (CR oscillation)	49	31	ICR33	338 _H	000FFF38 _H	-
PLL alarm interrupt for PWM	50	32	ICR34	334 _H	000FFF34 _H	-
reserved	51	33	ICR35	330 _H	000FFF30 _H	-
Comparator output detection interrupt 0/1/2	52	34	ICR36	32C _H	000FFF2C _H	36
PWC0 0 detection interrupt 00/10, compare clear interrupt 00/10	53	35	ICR37	328 _H	000FFF28 _H	- ^[2]
PWC0 capture data upper limit interrupt 00/10/20/30, PWC0 capture data lower limit interrupt 00/10/20/30, PWC0 data buffer interrupt 00/10/20/30, PWC0 buffer overrun interrupt 00/10/20/30	54	36	ICR38	324 _H	000FFF24 _H	- ^[2]
PWC1 0 detection interrupt 01/11, compare clear interrupt 01/11	55	37	ICR39	320 _H	000FFF20 _H	- ^[2]

Interrupt factor	Interrupt number		Interrupt level	Offset	Default address for TBR	RN*
	Decimal	Hexadecimal				
PWC1 capture data upper limit interrupt 01/11/21/31, PWC1 capture data lower limit interrupt 01/11/21/31, PWC1 data buffer interrupt 01/11/21/31, PWC1 buffer overrun interrupt 01/11/21/31	56	38	ICR40	31C _H	000FFF1C _H	- [2]
A/D converter 8/9/10/11	57	39	ICR41	318 _H	000FFF18 _H	- [2]
Base Timer 2 IRQ0 Base Timer 2 IRQ1	58	3A	ICR42	314 _H	000FFF14 _H	42
Base Timer 3 IRQ0 Base Timer 3 IRQ1	59	3B	ICR43	310 _H	000FFF10 _H	43
Base Timer 0 IRQ0 Base Timer 0 IRQ1	60	3C	ICR44	30C _H	000FFF0C _H	44
Base Timer 1 IRQ0 Base Timer 1 IRQ1	61	3D	ICR45	308 _H	000FFF08 _H	45
DMAC0/1/2/3/4/5/6/7	62	3E	ICR46	304 _H	000FFF04 _H	-
Delay interrupt	63	3F	ICR47	300 _H	000FFF00 _H	-
System reserved (Used for REALOS™ ^[3])	64	40	-	2FC _H	000FFEFC _H	-
System reserved (Used for REALOS)	65	41	-	2F8 _H	000FFE8 _H	-
Used with the INT instruction	66 255	42 FF	-	2F4 _H 000 _H	000FFE4 _H 000FFC00 _H	-

*: DMA transfer request by interrupt from peripherals without an assigned RN number is not supported.

[1]: DMA transfer by the multi-function serial interface status is not supported.

[2]: DMA transfer request by on-chip bus IP interrupt is supported.

[3]: REALOS is a trademark of Cypress.

11. Electrical Characteristics

11.1 Absolute Maximum Ratings

Parameter	Symbol	Rating		Unit	Remarks
		Min	Max		
Power supply voltage ^{[1] [2]}	V_{CC}	$V_{SS}-0.3$	$V_{SS}+6.0$	V	
Analog power supply voltage ^{[1] [2]}	AV_{CC}	$V_{SS}-0.3$	$V_{SS}+6.0$	V	$AVRH \leq AV_{CC} \leq V_{CC}$
Analog reference voltage ^[1]	$AVRH$	$V_{SS}-0.3$	$V_{SS}+6.0$	V	$AVRH \leq AV_{CC}$
Input voltage ^[1]	V_I	$V_{SS}-0.3$	$V_{CC}+0.3$	V	
Analog pin input voltage ^[1]	V_{IA5}	$V_{SS}-0.3$	$V_{CC}+0.3$	V	
Output voltage ^[1]	V_O	$V_{SS}-0.3$	$V_{CC}+0.3$	V	
Maximum clamp current	I_{CLAMP}	-	4.0	mA	[6]
Total maximum clamp current	$\Sigma I_{CLAMP} $	-	20	mA	[6]
"L" level maximum output current ^[3]	I_{OL1}	-	15	mA	
	I_{OL2}	-	30	mA	[8]
"L" level average output current ^[4]	I_{OLAV1}	-	4	mA	
	I_{OLAV2}	-	8	mA	[8]
"L" level total output current ^[5]	ΣI_{OL1}	-	50	mA	
	ΣI_{OL2}	-	60	mA	[8]
"H" level maximum output current ^[3]	I_{OH1}	-	-15	mA	
	I_{OH2}	-	-30	mA	[8]
"H" level average output current ^[4]	I_{OHAV1}	-	-4	mA	
	I_{OHAV2}	-	-8	mA	[8]
"H" level total output current ^[5]	ΣI_{OH1}	-	-50	mA	
	ΣI_{OH2}	-	-60	mA	[8]
Power consumption	P_D	-	690	mW	
Operating temperature	T_A	-40	+125	°C	[7]
Storage temperature	T_{stg}	-55	+150	°C	

[1]: These parameters are based on the condition that $V_{SS}=AV_{SS}=0.0V$

[2]: Caution must be taken that AV_{CC} , $AVRH$ do not exceed V_{CC} upon power-on and under other circumstances.

[3]: The maximum output current is defined as the value of the peak current flowing through any one of the corresponding pins.

[4]: The average output current is defined as the value of the average current flowing through any one of the corresponding pins for a 10 ms period. The average value is the operation current $\times$ the operation ratio.

[5]: The total output current is defined as the maximum current value flowing through all of corresponding pins.

[6]:

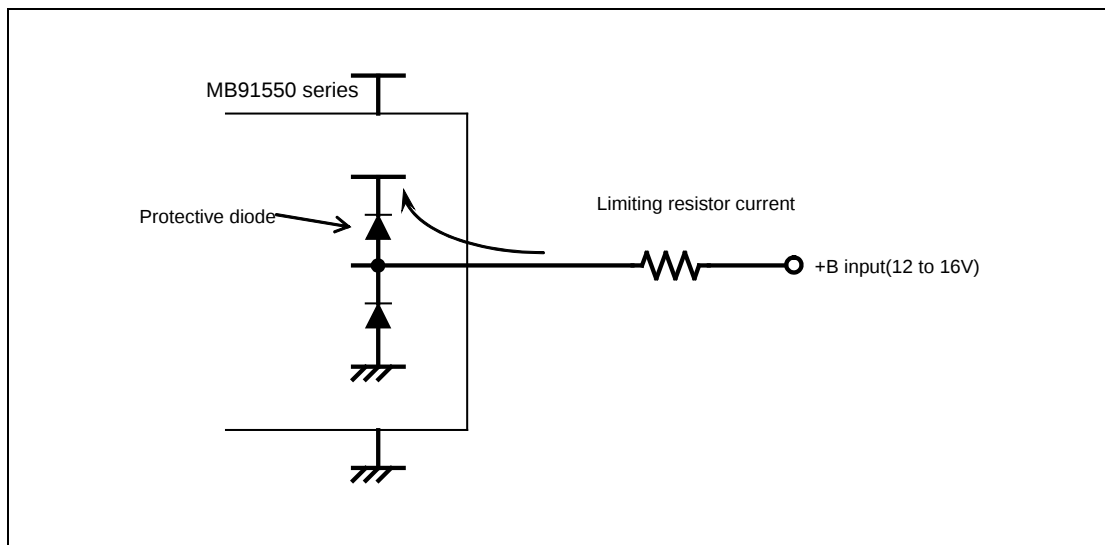
- Corresponding pins: all general-purpose ports.
- Use within recommended operating conditions.
- Use at DC voltage (current).
- The + B signal should always be applied by connecting a limiting resistor between the + B signal and the microcontroller.
- The value of the limiting resistor should be set so that the current input to the microcontroller pin does not exceed rated values at any time regardless of instantaneously or constantly when the + B signal is input.

- Note that when the microcontroller drive current is low, such as in the low power consumption modes, the + B input potential can increase the potential at the V_{CC} pin via a protective diode, possibly affecting other devices.
- Note that if the + B signal is input when the microcontroller is off (not fixed at 0 V), since the power is supplied through the pin, the microcontroller may operate incompletely.
- Note that if the +B signal is input at power-on, since the power is supplied through the pin, the power-on reset may not function in the power supply voltage.
- Do not leave + B input pins open.

[7]: When you use this product at $T_A = 125^{\circ}\text{C}$, it is necessary to built-in multi-layer substrate at least four -layer or more. If you use a 2-layer substrate, change the operating conditions (such as operating frequency, power supply voltage) , you will need to either you use the power consumption $P_D = 400\text{mW}$ or less, or use the operating temperature $T_A = 105^{\circ}\text{C}$ or less.

[8]: Corresponding pins: PWM0H, PWM0L, PWM1H, PWM1L, PWM2H, PWM2L

Sample recommended circuit



WARNING

Semiconductor devices may be permanently damaged by application of stress (including, without limitation, voltage, current or temperature) in excess of absolute maximum ratings. Do not exceed any of these ratings.

11.2 Recommended operating conditions

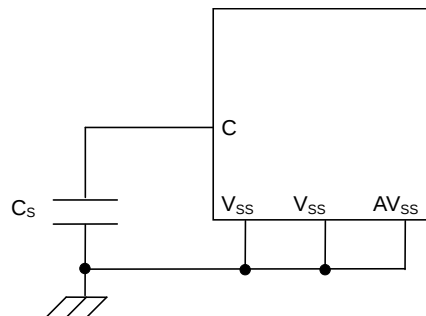
($V_{SS}=AV_{SS}=0.0V$)

Parameter	Symbol	Value		Unit	Remarks
		Min	Max		
Power supply voltage	V_{CC}	4.5	5.5	V	Recommended operation guarantee range
		3.4	5.5	V	Operation guarantee range ^[1]
	AV_{CC0}	4.5	5.5	V	Operation guarantee range ^[1]
	AV_{CC1}	4.925	5.075	V	Operation guarantee range ^[1]
Smoothing capacitor ^[2]	C_S	4.7 (tolerance within $\pm 50\%$)		μF	Use a ceramic capacitor or a capacitor that has the similar frequency characteristics. Use a capacitor with a capacitance greater than C_S as the smoothing capacitor on the VCC pin.
Operating temperature	T_A	-40	+125	$^{\circ}C$	

[1]: When it is used outside recommended operation guarantee range (range of the operation guarantee), contact your sales representative. Moreover, minimum value with an effective external low-voltage detection reset becomes a voltage until generating low-voltage detection reset.

[2]: See the following diagram for details on the connection of smoothing capacitor C_S .

■ C Pin Connection Diagram



WARNING:

The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated under these conditions. Any use of semiconductor devices will be under their recommended operating condition. Operation under any conditions other than these conditions may adversely affect reliability of device and could result in device failure. No warranty is made with respect to any use, operating conditions or combinations not represented on this data sheet. If you are considering application under any conditions other than listed herein, please contact sales representatives beforehand.

11.3 DC characteristics

(T_A : -40°C to +125°C, $V_{CC}=AV_{CC}=4.5V$ to 5.5V, $V_{SS}=AV_{SS}=0.0V$)

Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Power supply current	I_{CC5}	VCC	Operating frequency $F_{CP}=80MHz$, $F_{CpP}=40MHz$ $F_{CpWm}=200MHz$, at normal operation	-	60	98	mA	
			Operating frequency $F_{CP}=80MHz$, $F_{CpP}=40MHz$ $F_{CpWm}=200MHz$, at Flash write	-	72	112	mA	
			Operating frequency $F_{CP}=80MHz$, $F_{CpP}=40MHz$ $F_{CpWm}=200MHz$, at Flash erase	-	72	112	mA	
	I_{CCS5}		Operating frequency $F_{CP}=80MHz$, $F_{CpP}=40MHz$, $F_{CpWm}=200MHz$ at CPU sleep mode	-	33	66	mA	
	I_{CCBS5}		Operating frequency $F_{CP}=80MHz$, $F_{CpP}=40MHz$, $F_{CpWm}=200MHz$ at bus sleep mode	-	26	56	mA	
	I_{CCT5}		Watch mode When using crystal 4MHz $T_A=+25^\circ C$	-	1320	2600	μA	
	I_{CCH5}		Stop mode $T_A=+25^\circ C$	-	190	1370	μA	

(T_A: -40°C to +125°C, V_{CC}=AV_{CC}=5.0V±10%, V_{SS}=AV_{SS}=0.0V)

Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Input leak current	I _{IL}	All input pins	V _{CC} =AV _{CC} =5.5V V _{SS} <V _I <V _{CC}	-5	-	5	μA	
Input capacitance 1	C _{IN1}	Other than VCC, VSS, AVCC, AVSS, C	-	-	5	15	pF	
Pull-up resistance	R _{UP1}	RSTX, NMIX	-	25	-	100	kΩ	
	R _{UP2}	Port pin other than P000 to P005	-	25	-	100	kΩ	
Pull-down resistance	R _{DOWN}	P000 to P005	-	25	-	100	kΩ	
“H” level output voltage	V _{OH1}	Normal output pin	V _{CC} =4.5V I _{OH} =-4.0mA	V _{CC} -0.5	-	V _{CC}	V	
	V _{OH2}	P000 to P005	V _{CC} =4.5V I _{OH} =-8.0mA	V _{CC} -0.5	-	V _{CC}	V	PWM pin output
“L” level output voltage	V _{OL1}	Normal output pin	V _{CC} =4.5V I _{OL} =4.0mA	0	-	0.4	V	
	V _{OL2}	P000 to P005	V _{CC} =4.5V I _{OL} =8.0mA	0	-	0.4	V	PWM pin output
“H” level input voltage	V _{IH1}	P032, P033, P036, P037, P042, P044, P045	CMOS hysteresis input level	0.7× V _{CC}	-	V _{CC}	V	
	V _{IH3}	Port other than V _{IH1}	Automotive input level	0.8× V _{CC}	-	V _{CC}	V	
	V _{IH5}	RSTX, NMIX, MD0, MD1	CMOS hysteresis input level	0.8× V _{CC}	-	V _{CC}	V	
	V _{IHT}	DEBUGIF	TTL input level	2	-	V _{CC}	V	
“L” level input voltage	V _{IL1}	P032, P033, P036, P037, P042, P044, P045	CMOS hysteresis input level	V _{SS}	-	0.3× V _{CC}	V	
	V _{IL3}	Port other than V _{IH1}	Automotive input level	V _{SS}	-	0.5× V _{CC}	V	
	V _{IL5}	RSTX, NMIX, MD0, MD1	CMOS hysteresis input level	V _{SS}	-	0.2× V _{CC}	V	
	V _{ILT}	DEBUGIF	TTL input level	V _{SS}	-	0.8	V	

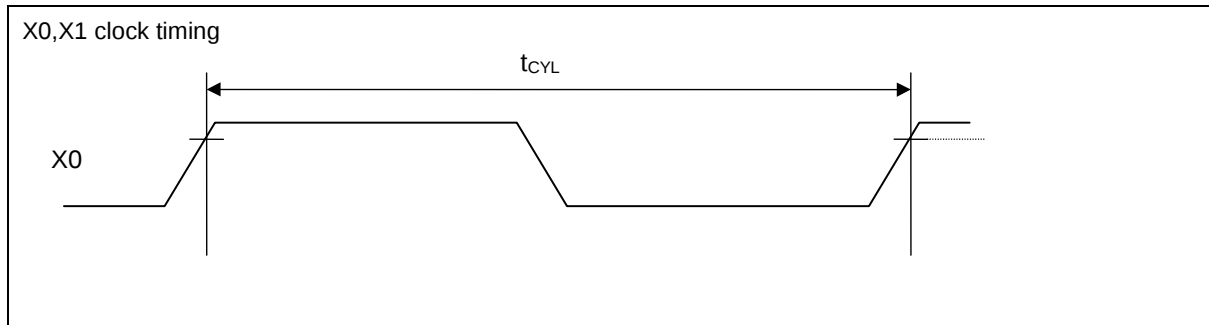
11.4 AC Characteristics

11.4.1 Main Clock Timing

(T_A: -40°C to +125°C, V_{CC}=AV_{CC}=5.0V±10%, V_{SS}=AV_{SS}=0.0V)

Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Source oscillation clock frequency	F _C	X0, X1	-	4	-	16	MHz	
Source oscillation clock cycle time	t _{CYL}	X0, X1		62.5	-	250	ns	
Internal operating clock frequency ^[1]	F _{CP}	-		2	-	80	MHz	CPU clock
	F _{CPP}			1		40		Peripheral bus clock
	F _{CPWM}			2		200		PWM clock
	F _{CPWMD}			2		200		PWM division clock
	F _{CCMP}			2		50		Comparator clock
Internal operating clock cycle time ^[1]	t _{CP}	-		12.5	-	500	ns	CPU clock
	t _{CPP}			25		1000		Peripheral bus clock
	t _{CPWM}			5		500		PWM clock
	t _{CPWMD}			5		500		PWM division clock
	t _{CCMP}			20		500		Comparator clock
	CAN PLL jitter (during lock)			t _{PJ}		-		-10
Built-in CR oscillation frequency	F _{CCR}	-		50	100	150	kHz	

[1]: The maximum / minimum value is defined when using the main clock and PLL clock.



CAN PLL jitter

Deviation time from the ideal clock is assured per cycle out of 20,000 cycles.

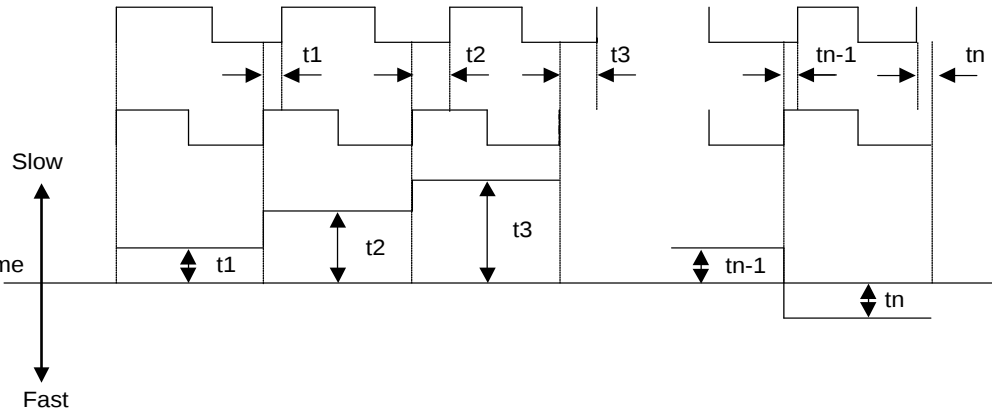
PLL output

Ideal clock

Slow

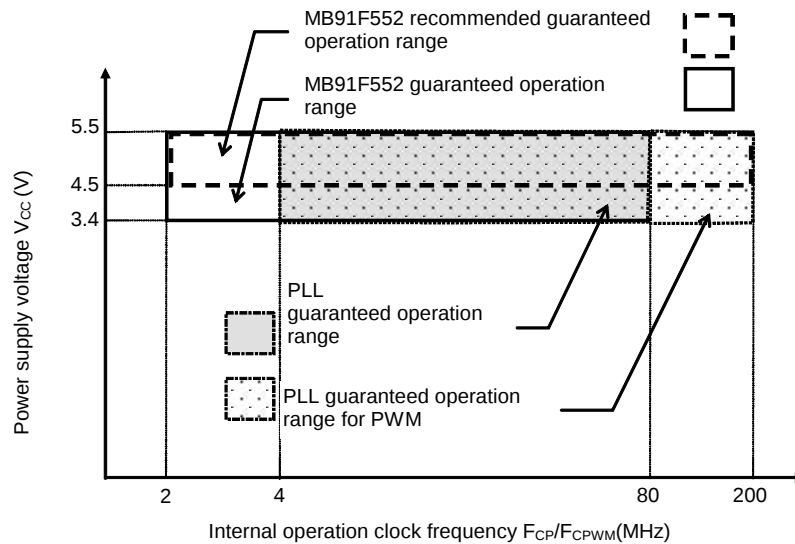
Deviation time

Fast



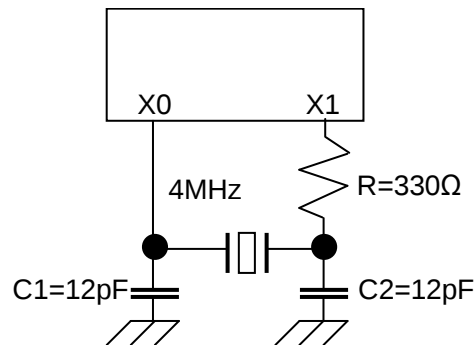
Guaranteed operation range

Internal operation clock frequency vs. Power supply voltage



Note: The power supply voltage, which is the low-voltage detection setting voltage or lower, is in the reset state.

Example of oscillation circuit



Note:

As to the product with its clock supervisor's initial value is "ON", when the oscillator is unable to start within 20ms from the stop state the clock supervisor will detect the oscillation stop. As a result, the CPU moves to the fail safe operation.

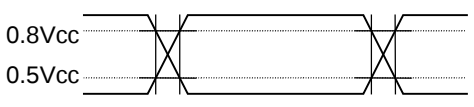
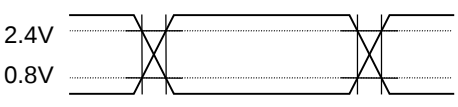
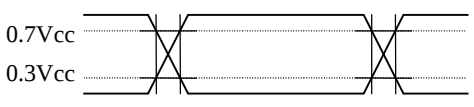
Design your print circuit board so that the oscillator can start oscillation within 20ms. Moreover, it is recommended to be designed after the match evaluation of the circuit is requested to the departure pendulum maker when the oscillation circuit is composed.

11.4.2 The using condition of PLL

(T_A : -40°C to +125°C, $V_{CC}=AV_{CC}=5.0V \pm 10\%$, $V_{SS}=AV_{SS}=0.0V$)

Parameter	Symbol	Condition s	Value			Unit	Remarks
			Min	Typ	Max		
PLL Oscillation stabilization waiting time (LOCK UP time)	t_{LOCK}	-	-	-	100	μs	Time until the oscillation of PLL is stabilized
PLL input clock frequency	f_{PLLI}	-	4	-	16	MHz	
PLL multiplication rate	-	-	13	-	100	multiplication	
PLL Macro oscillation clock frequency	f_{PLLO}		200	-	400	MHz	

AC characteristics are specified by the following measurement reference voltage values.

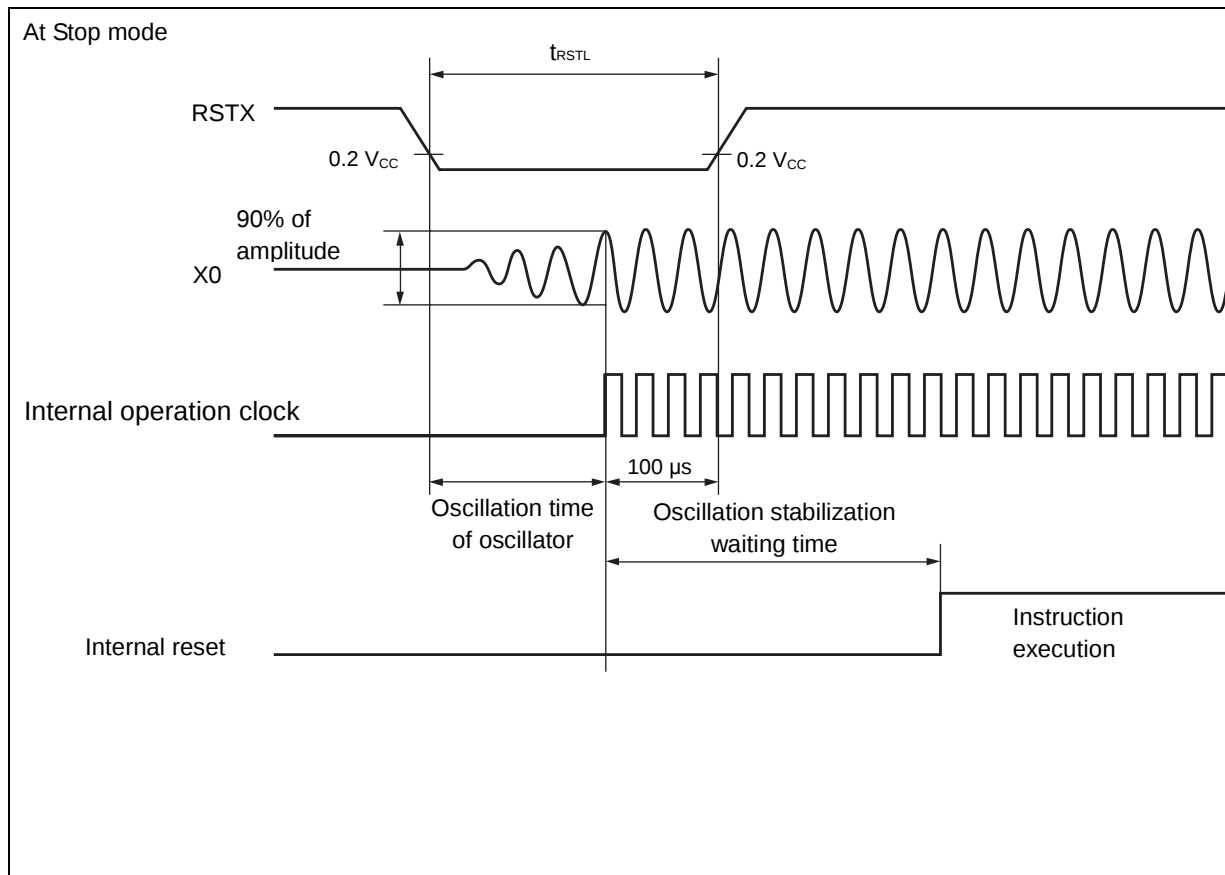
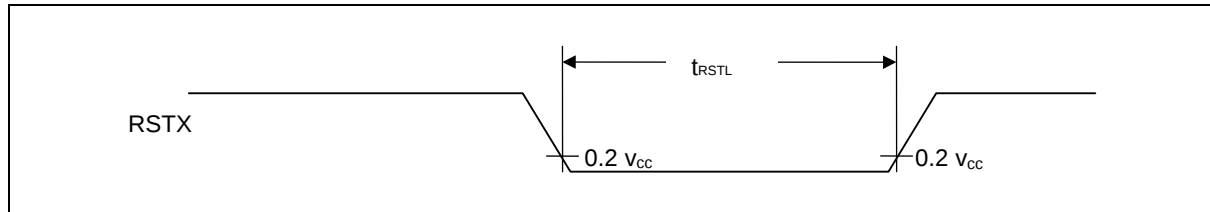
Input Signal Waveform	Output Signal Waveform
Hysteresis Input Pin (Automotive) 	Output Pin 
Hysteresis Input Pin (CMOS schmitt) 	

11.4.3 Reset Input

(T_A : -40°C to +125°C, $V_{CC}=AV_{CC}=5.0V \pm 10\%$, $V_{SS}=AV_{SS}=0.0V$)

Parameter	Symbol	Pin name	Conditions	Value		Unit	Remarks
				Min	Max		
Reset input time	t_{RSTL}	RSTX	-	10	-	μs	When normal operation
				Oscillation time of oscillator ^[1] +100	-	μs	At Stop mode
				100	-	μs	At Watch mode
Width for reset input removal				1	-	μs	

[1]: The oscillation time of the oscillator is the time it takes for the amplitude of the oscillations to reach 90%. For crystal oscillators, this time is between several ms and several tens of ms, for ceramic oscillators the time is between several hundred μs and several ms.



11.4.4 Power-on Conditions

 (T_A: -40°C to +125°C, V_{SS}=0.0V)

Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Level detection voltage	-	VCC	-	2.1	2.3	2.5	V	
Level detection hysteresis width	-	VCC	-	-	100	-	mV	
Level detection time	-	-	-	-	-	30	μs	[1]
Slope detection undetected standard	-	VCC	V _{CC} = at level detection release level time	-	-	4	mV/μs	[2]
Power off time	t _{OFF}	VCC	-	50	-	-	ms	[3]

[1]: If the fluctuation of the power supply is faster than the low-voltage detection time, there is the possibility to generate or release after the power supply voltage has exceeded the detection voltage range.

[2]: When setting the power supply fluctuation to this standard or less, it is possible to suppress the slope detection. This is the standard when the power supply fluctuation is stable.

[3]: This time is to start the slope detection at next power on after power down and internal charge loss.

11.4.5 Multi-function Serial

11.4.5.1 CSIO timing

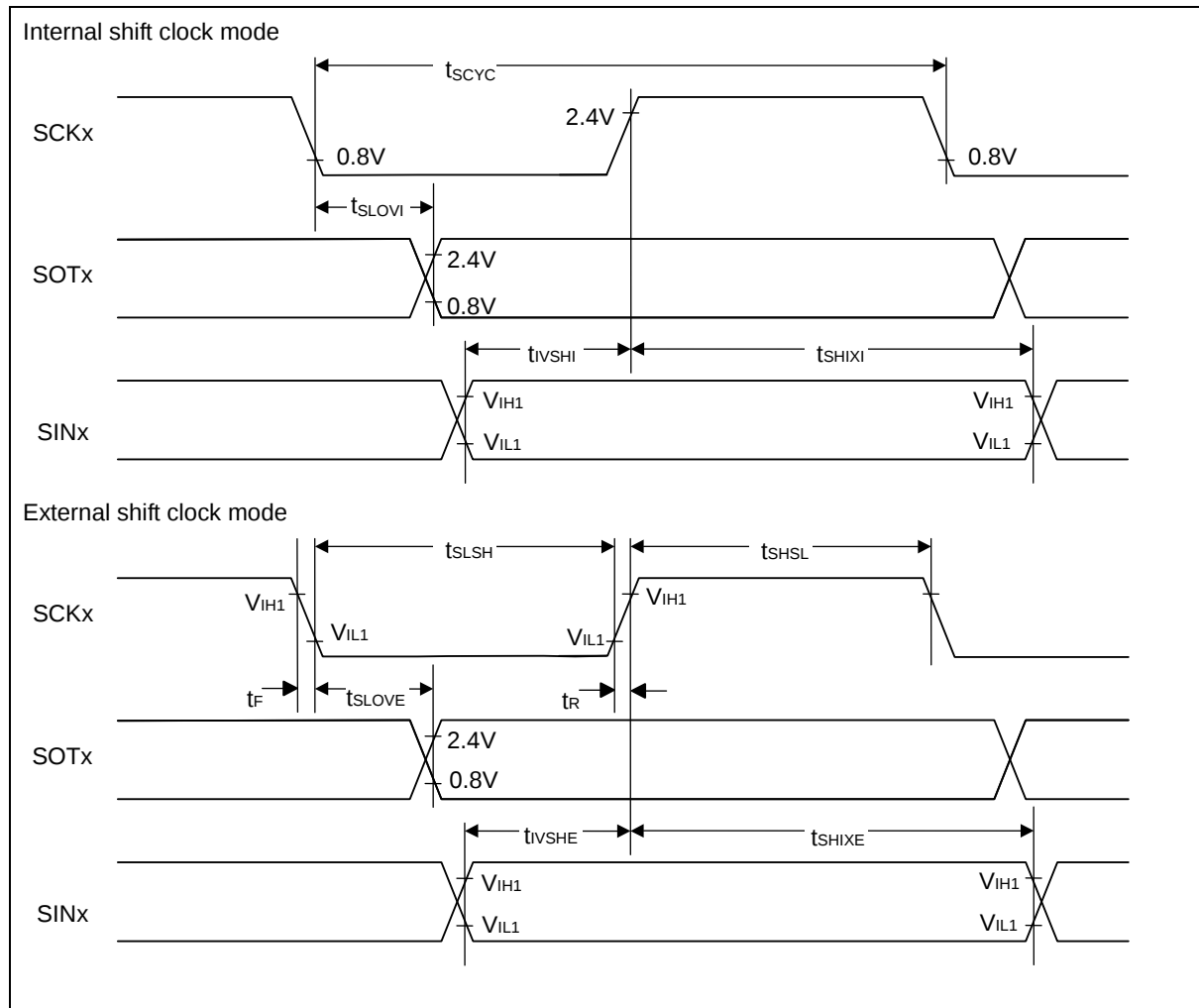
11.4.5.1.1 Bit setting: SMR: MD2=0, SMR: MD1=1, SMR: MD0=0, SMR: SCINV=0, SCR: SPI=0

(T_A: -40°C to +125°C, V_{CC}=AV_{CC}=5.0V±10%, V_{SS}=AV_{SS}=0.0V)

Parameter	Symbol	Pin name	Conditions	Value		Unit	Remarks
				Min	Max		
Serial clock cycle time	t _{SCYC}	SCK0 to SCK2	-	4t _{CPP}	-	ns	Internal shift clock mode output pin : CL=50pF
SCK ↓ → SOT delay time	t _{SLOVI}	SCK0 to SCK2 SOT0 to SOT2		-30	30	ns	
Valid SIN → SCK ↑ setup time	t _{IVSHI}	SCK0 to SCK2 SIN0 to SIN2		34	-	ns	
SCK ↑ → Valid SIN hold time	t _{SHIXI}			0	-	ns	
Serial clock "H"pulse width	t _{SHSL}	SCK0 to SCK2	-	t _{CPP} +10	-	ns	External shift clock mode output pin: CL=50pF
Serial clock "L" pulse width	t _{SLSH}			2t _{CPP} -10	-	ns	
SCK ↓ → SOT delay time	t _{SLOVE}	SCK0 to SCK2 SOT0 to SOT2		-	33	ns	
Valid SIN → SCK ↑ setup time	t _{IVSHE}	SCK0 to SCK2 SIN0 to SIN2		10	-	ns	
SCK ↑ → Valid SIN hold time	t _{SHIXE}			20	-	ns	
SCK fall time	t _F	SCK0 to SCK2		-	5	ns	
SCK rise time	t _R	SCK0 to SCK2		-	5	ns	

Notes:

- AC characteristic in CLK synchronized mode.
- C_L is the load capacitance applied to pins during testing.
- The maximum baud rate is limited by internal operation clock used and other parameters. See Hardware Manual for details.



11.4.5.1.2 Bit setting: SMR: MD2=0, SMR: MD1=1, SMR: MD0=0, SMR: SCINV=1, SCR: SPI=0

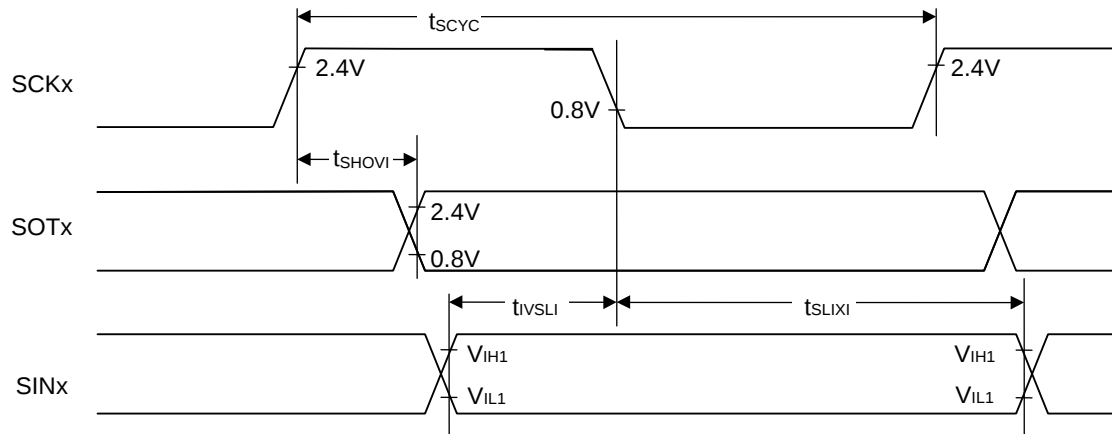
 (T_A: -40°C to 125°C, V_{CC}=AV_{CC}=5.0V±10%, V_{SS}=AV_{SS}=0.0V)

Parameter	Symbol	Pin name	Conditions	Value		Unit	Remarks
				Min	Max		
Serial clock cycle time	t _{SCYC}	SCK0 to SCK2	-	4t _{CPP}	-	ns	Internal shift clock mode output pin : CL=50pF
SCK ↑ → SOT delay time	t _{SHOVI}	SCK0 to SCK2 SOT0 to SOT2		-30	30	ns	
Valid SIN → SCK ↓ setup time	t _{IVSLI}	SCK0 to SCK2 SIN0 to SIN2		34	-	ns	
SCK ↓ → Valid SIN hold time	t _{SLIXI}			0	-	ns	
Serial clock "H"pulse width	t _{SHSL}	SCK0 to SCK2	-	t _{CPP} +10	-	ns	External shift clock mode output pin: CL=50pF
Serial clock "L" pulse width	t _{SLSH}			2t _{CPP} -10	-	ns	
SCK ↑ → SOT delay time	t _{SHOVE}	SCK0 to SCK2 SOT0 to SOT2		-	33	ns	
Valid SIN → SCK ↓ setup time	t _{IVSLE}	SCK0 to SCK2 SIN0 to SIN2		10	-	ns	
SCK ↓ → Valid SIN hold time	t _{SLIXE}			20	-	ns	
SCK fall time	t _F	SCK0 to SCK2		-	5	ns	
SCK rise time	t _R	SCK0 to SCK2		-	5	ns	

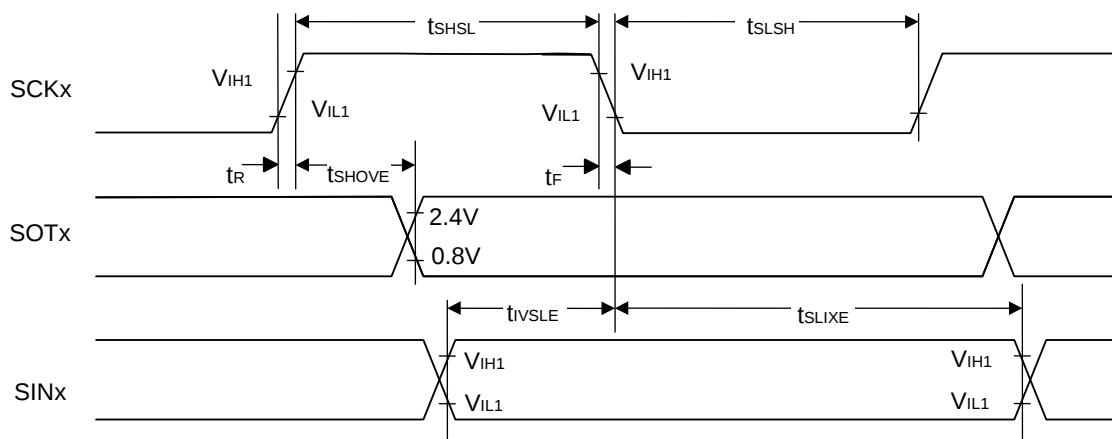
Notes:

- AC characteristic in CLK synchronized mode.
- C_L is the load capacitance applied to pins during testing.
- The maximum baud rate is limited by internal operation clock used and other parameters.
See Hardware Manual for details.

Internal shift clock mode



External shift clock mode



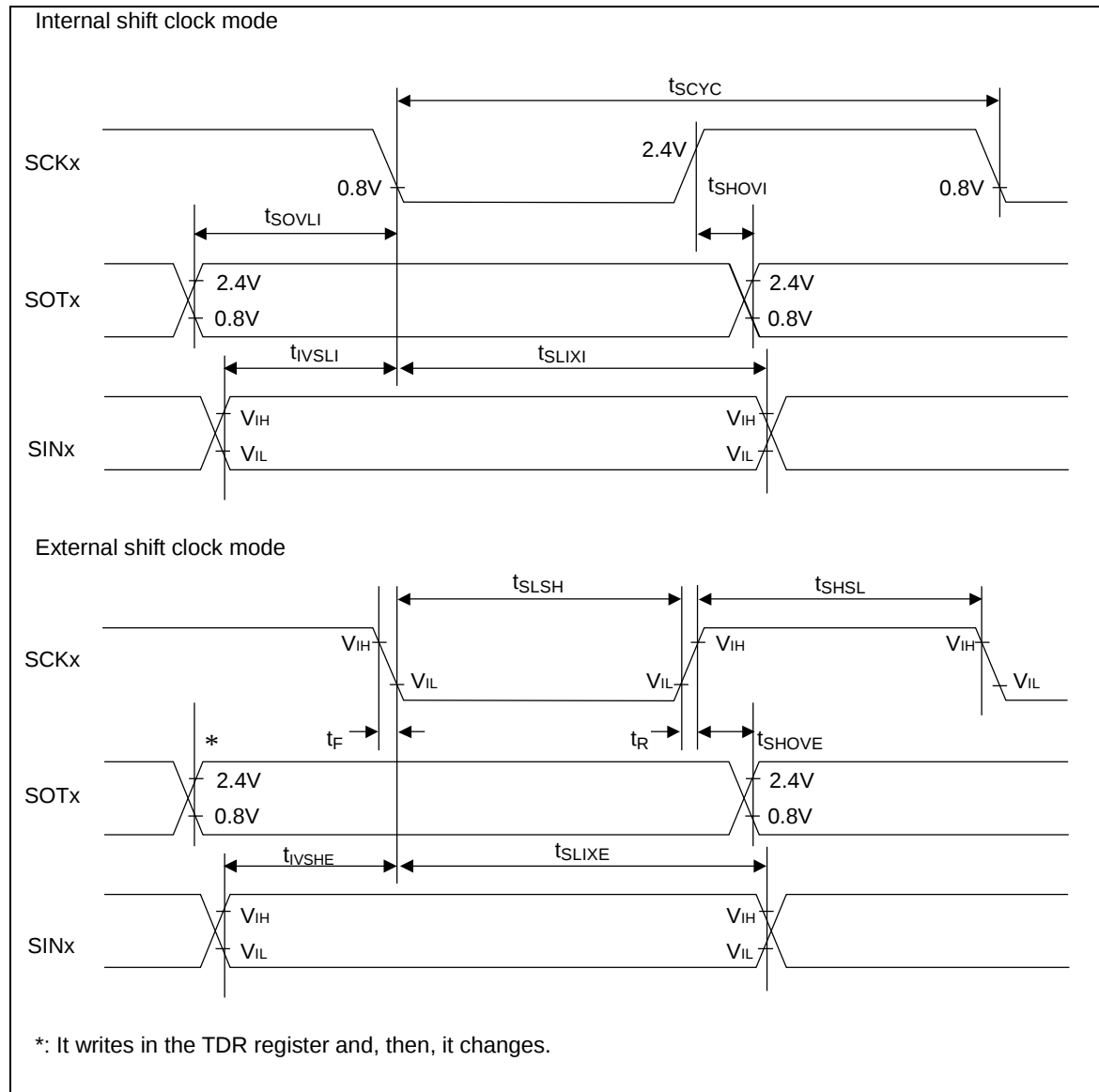
11.4.5.1.3 Bit setting: SMR: MD2=0, SMR: MD1=1, SMR: MD0=0, SMR: SCINV=0, SCR: SPI=1

 (T_A: -40°C +125°C, V_{CC}=AV_{CC}=5.0V±10%, V_{SS}=AV_{SS}=0.0V)

Parameter	Symbol	Pin name	Conditions	Value		Unit	Remarks
				Min	Max		
Serial clock cycle time	t _{SCYC}	SCK0 to SCK2	-	4t _{CPP}	-	ns	Internal shift clock mode output pin : CL=50pF
SCK ↑ → SOT delay time	t _{SHOVI}	SCK0 to SCK2 SOT0 to SOT2		-30	30	ns	
Valid SIN → SCK ↓ setup time	t _{IVSLI}	SCK0 to SCK2 SIN0 to SIN2		34	-	ns	
SCK ↓ → Valid SIN hold time	t _{SLIXI}			0	-	ns	
SOT→SCK↓ delay time	t _{SOVLI}	SCK0 to SCK2 SOT0 to SOT2		2t _{CPP} -30	-	ns	
Serial clock "H"pulse width	t _{SHSL}	SCK0 to SCK2	-	t _{CPP} +10	-	ns	External shift clock mode output pin: CL=50pF
Serial clock "L" pulse width	t _{SLSH}			2t _{CPP} -10	-	ns	
SCK ↑ → SOT delay time	t _{SHOVE}	SCK0 to SCK2 SOT0 to SOT2		-	33	ns	
Valid SIN → SCK ↓ setup time	t _{IVSHE}	SCK0 to SCK2 SIN0 to SIN2		10	-	ns	
SCK ↓ → Valid SIN hold time	t _{SLIXE}			20	-	ns	
SCK fall time	t _F	SCK0 to SCK2		-	5	ns	
SCK rise time	t _R	SCK0 to SCK2		-	5	ns	

Notes:

- AC characteristic in CLK synchronized mode.
- C_L is the load capacitance applied to pins during testing.
- The maximum baud rate is limited by internal operation clock used and other parameters.
See Hardware Manual for details.



11.4.5.1.4 Bit setting: SMR: MD2=0, SMR: MD1=1, SMR: MD0=0, SMR: SCINV=1, SCR: SPI=1

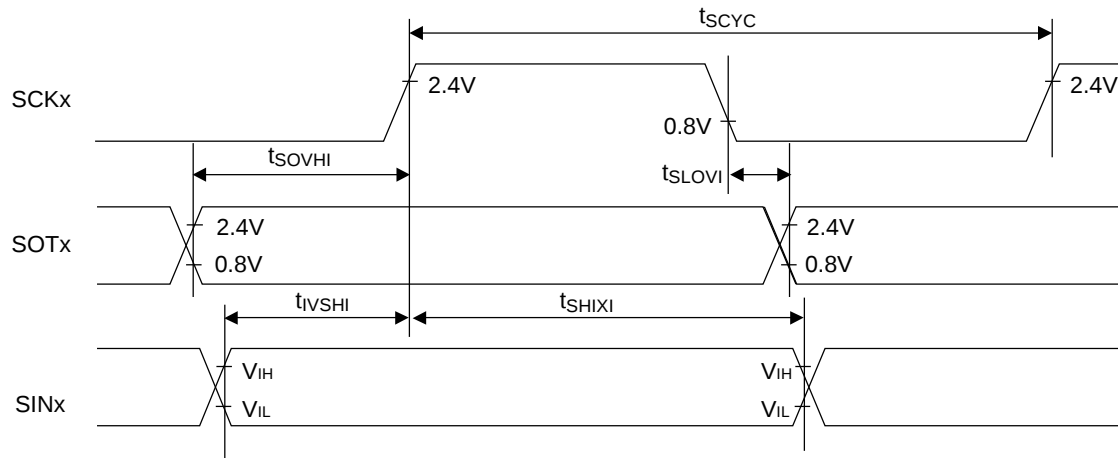
 (T_A: -40°C + 125°C, V_{CC}=AV_{CC}=5.0V±10%, V_{SS}=AV_{SS}=0.0V)

Parameter	Symbol	Pin name	Conditions	Value		Unit	Remarks
				Min	Max		
Serial clock cycle time	t _{SCYC}	SCK0 to SCK2	-	4t _{CPP}	-	ns	Internal shift clock mode output pin : CL=50pF
SCK↓→ SOT delay time	t _{SLOVI}	SCK0 to SCK2 SOT0 to SOT2		-30	30	ns	
Valid SIN → SCK↑setup time	t _{IVSHI}	SCK0 to SCK2 SIN0 to SIN2		34	-	ns	
SCK↑→ Valid SIN hold time	t _{SHIXI}			0	-	ns	
SOT→SCK↑ delay time	t _{SOVHI}	SCK0 to SCK2 SOT0 to SOT2		2t _{CPP} -30	-	ns	
Serial clock "H"pulse width	t _{SHSL}	SCK0 to SCK2	-	t _{CPP} +10	-	ns	External shift clock mode output pin: CL=50pF
Serial clock "L" pulse width	t _{SLSH}			2t _{CPP} -10	-	ns	
SCK↓→ SOT delay time	t _{SLOVE}	SCK0 to SCK2 SOT0 to SOT2		-	33	ns	
Valid SIN → SCK↑setup time	t _{IVSHE}	SCK0 to SCK2 SIN0 to SIN2		10	-	ns	
SCK↑→ Valid SIN hold time	t _{SHIXE}			20	-	ns	
SCK fall time	t _F	SCK0 to SCK2		-	5	ns	
SCK rise time	t _R	SCK0 to SCK2		-	5	ns	

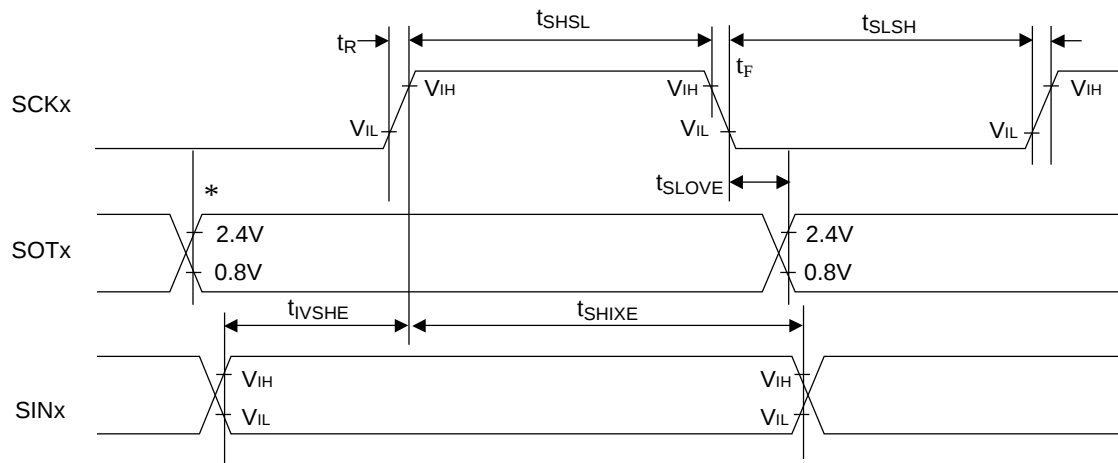
Notes:

- AC characteristic in CLK synchronized mode.
- C_L is the load capacitance applied to pins during testing.
- The maximum baud rate is limited by internal operation clock used and other parameters. See Hardware Manual for details.

Internal shift clock mode



External shift clock mode



11.4.5.1.5 Bit setting: SMR:MD2=0, SMR:MD1=1, SMR:MD0=0,

When Serial chip select is used : SCSCR:CSSEN=1,

Serial clock output mark level "H" : SMR, SCSFR:SCINV=0,

Serial chip select Inactive level "H" : SCSCR, SCSFR:CSLVL=1

 (T_A: -40°C to + 125°C, V_{CC}=AV_{CC}=5.0V±10%, V_{SS}=AV_{SS}=0.0V)

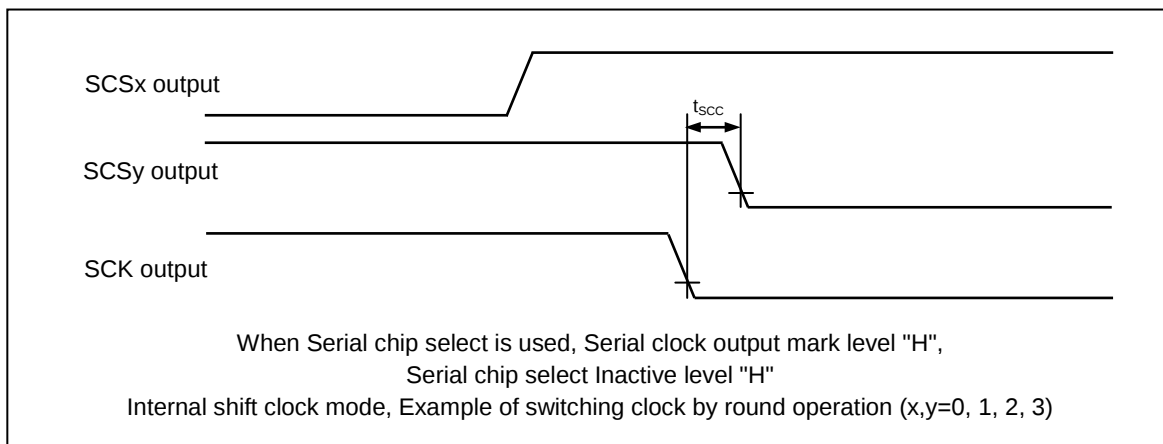
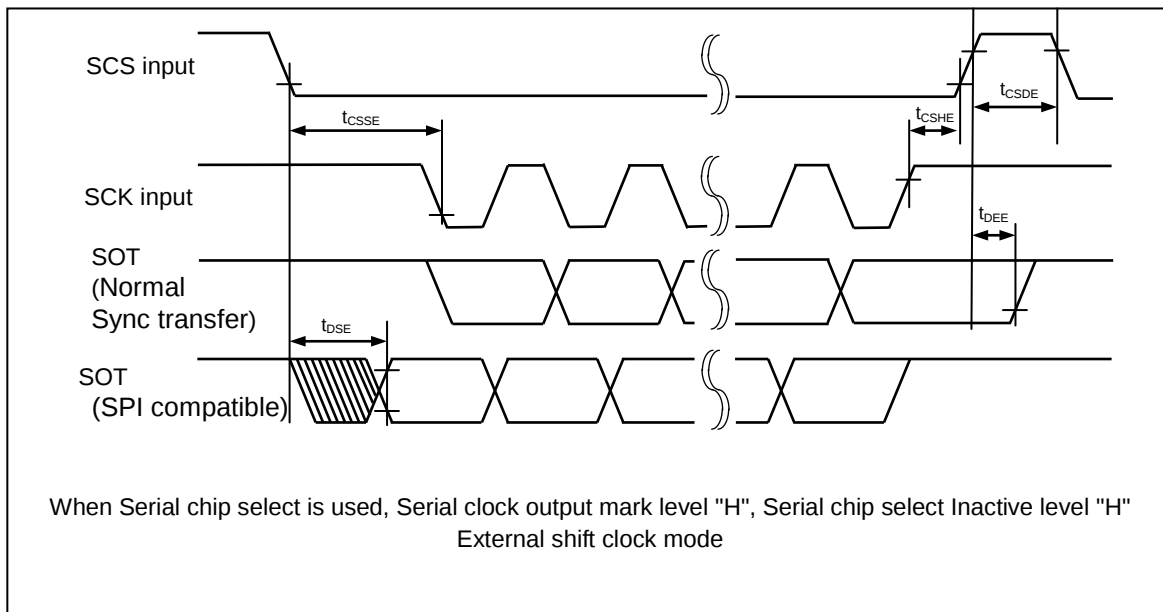
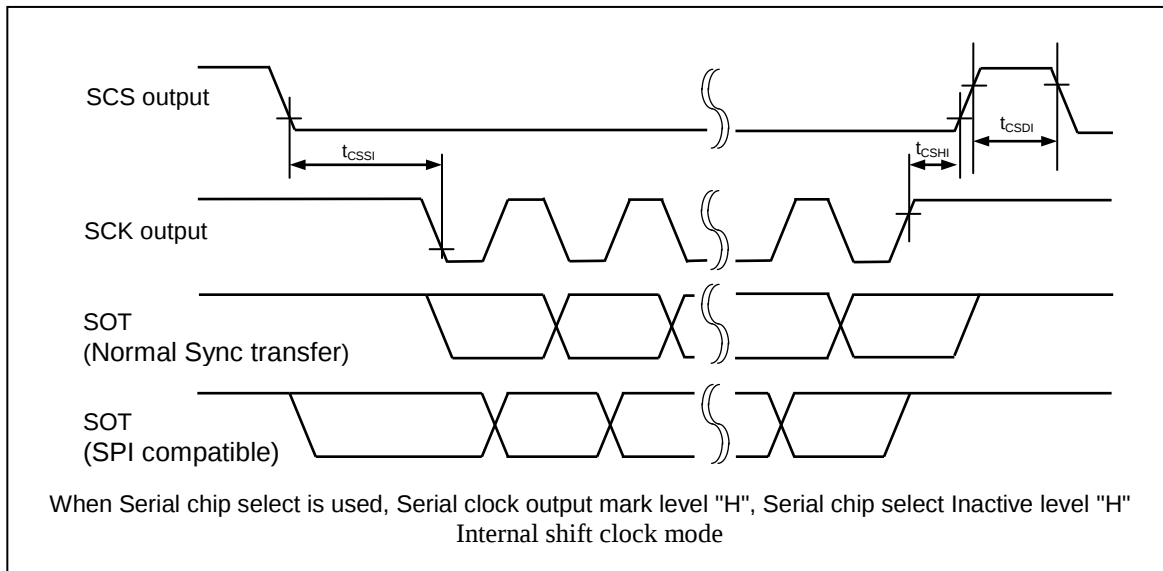
Parameter	Symbol	Pin name	Conditions	Value		Unit	Remarks
				Min	Max		
SCS _↓ →SCK _↓ setup time	t _{CSSI}	SCK0 to SCK2, SCS00, SCS01, SCS10, SCS11, SCS20, SCS21	-	t _{CSSU} +0 [1]	t _{CSSU} +50 [1]	ns	Internal shift clock mode output pin : C _L =50pF
SCK _↑ →SCS _↑ hold time	t _{CSHI}	SCS00, SCS01, SCS10, SCS11, SCS20, SCS21		t _{CSHD} -50 [2]	t _{CSHD} +0 [2]	ns	
SCS deselect time	t _{CSDI}	SCS00, SCS01, SCS10, SCS11, SCS20, SCS21		t _{CSDS} -50 [3]	t _{CSDS} +50 [3]	ns	
SCS _↓ →SCK _↓ setup time	t _{CSSE}	SCK0 to SCK2, SCS00, SCS01, SCS10, SCS11, SCS20, SCS21	-	3t _{CPP} +30	-	ns	External shift clock mode output pin: C _L =50pF
SCK _↑ →SCS _↑ hold time	t _{CSHE}	SCS00, SCS01, SCS10, SCS11, SCS20, SCS21		+0	-	ns	
SCS deselect time	t _{CSDE}	SCS00, SCS01, SCS10, SCS11, SCS20, SCS21		3t _{CPP} +30	-	ns	
SCS _↓ →SOT delay time	t _{DSE}	SCS00, SCS01, SCS10, SCS11,		-	40	ns	
SCS _↑ →SOT delay time	t _{DEE}	SCS20, SCS21, SOT0 to SOT2		+0	-	ns	
SCK _↓ →SCS _↓ clock switch time	t _{SCC}	SCK0 to SCK2, SCS00, SCS01, SCS10, SCS11, SCS20, SCS21	-	3t _{CPP} +0	3t _{CPP} +50	ns	Internal shift clock mode Round operation output pin: C _L =50pF

 [1]: t_{CSSU}=SCSTR:CSSU7-0×Serial chip select timing operating clock

 [2]: t_{CSHD}=SCSTR:CSHD7-0×Serial chip select timing operating clock

 [3]: t_{CSDS}=SCSTR:CSDS15-0×Serial chip select timing operating clock

Regardless of the deselect time setting, once after the serial chip select pin becomes inactive, it will take at least five peripheral bus clock cycles to be active again. Please see the hardware manual for details of above-mentioned [1], [2] and [3].



11.4.5.1.6 Bit setting: SMR:MD2=0, SMR:MD1=1, SMR:MD0=0,

When Serial chip select is used : SCSCR:CSSEN=1,

Serial clock output mark level "L" : SMR, SCSFR:SCINV=1,

Serial chip select Inactive level "H" : SCSCR, SCSFR:CSLVL=1

 (T_A: -40°C to +125°C, V_{CC}=AV_{CC}=5.0V±10%, V_{SS}=AV_{SS}=0.0V)

Parameter	Symbol	Pin name	Condi tions	Value		Unit	Remarks
				Min	Max		
SCS↓→SCK↑ setup time	t _{CSSU}	SCK0 to SCK2, SCS00, SCS01, SCS10, SCS11, SCS20, SCS21	-	t _{CSSU} +0 [1]	t _{CSSU} +50 [1]	ns	Internal shift clock mode output pin : C _L =50pF
SCK↓→SCS↑ hold time	t _{CSHI}			t _{CSHD} -50 [2]	t _{CSHD} +0 [2]	ns	
SCS deselect time	t _{CSDI}			t _{CSDS} -50 [3]	t _{CSDS} +50 [3]	ns	
SCS↓→SCK↑ setup time	t _{CSSE}	SCK0 to SCK2, SCS00, SCS01, SCS10, SCS11, SCS20, SCS21	-	3t _{CPP} +30	-	ns	External shift clock mode output pin: C _L =50pF
SCK↓→SCS↑ hold time	t _{CSHE}			+0	-	ns	
SCS deselect time	t _{CSDE}			3t _{CPP} +30	-	ns	
SCS↓→SOT delay time	t _{DSE}			-	40	ns	
SCS↑→SOT delay time	t _{DEE}			+0	-	ns	
SCK↑→SCS↓ clock switch time	t _{SCC}	SCK0 to SCK2, SCS00, SCS01, SCS10, SCS11, SCS20, SCS21	-	3t _{CPP} +0	3t _{CPP} +50	ns	Internal shift clock mode Round operation output pin: C _L =50pF

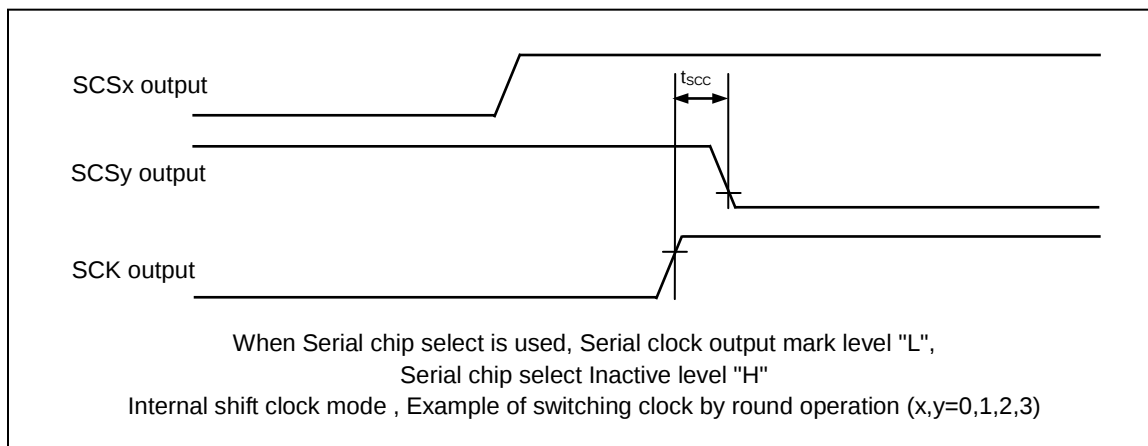
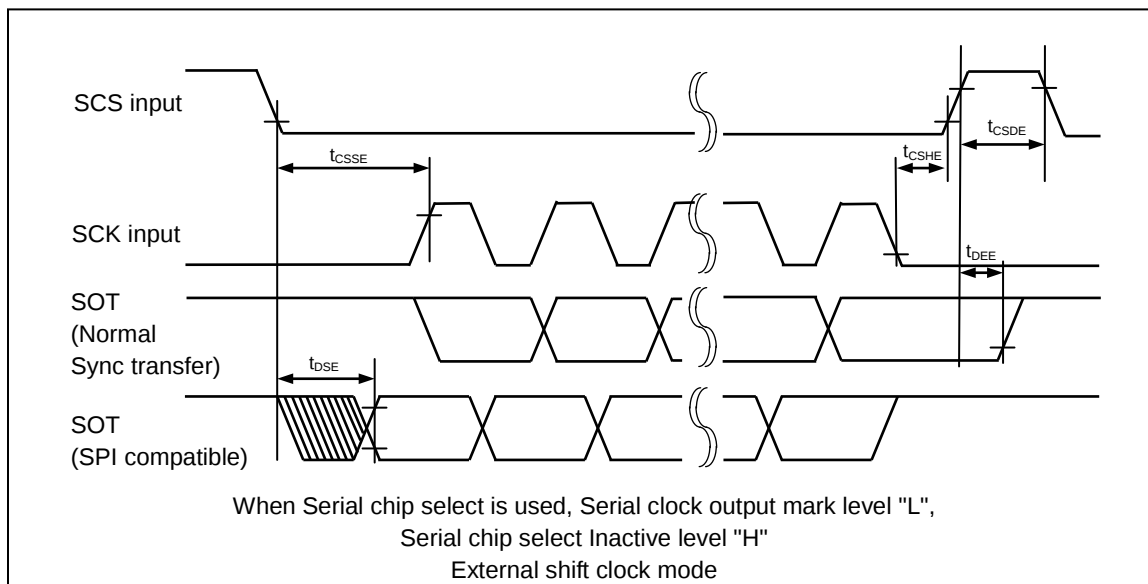
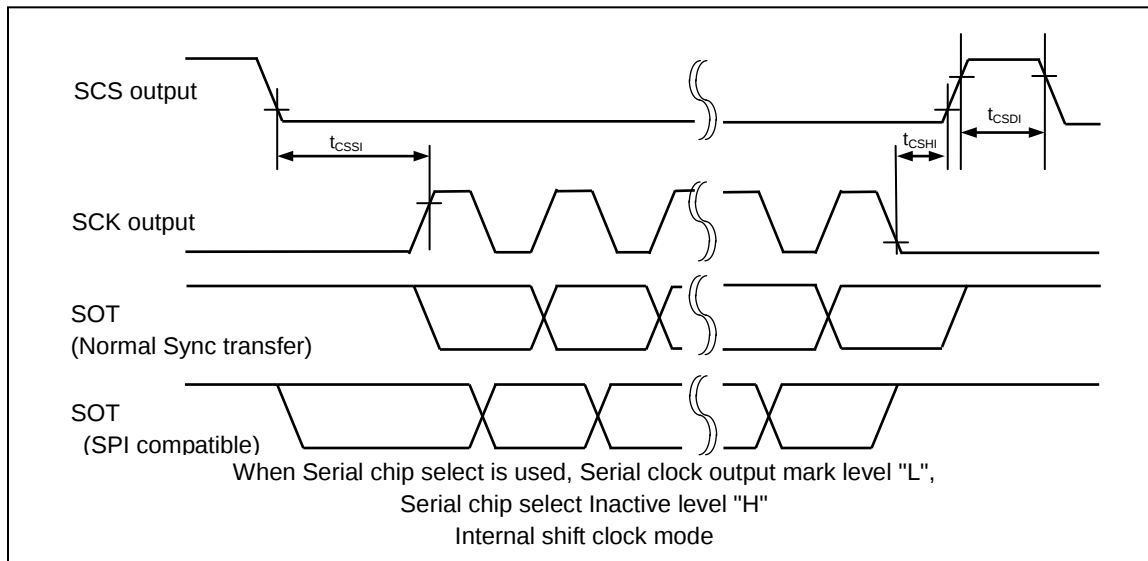
 [1]: t_{CSSU} = SCSTR:CSSU7-0×Serial chip select timing operating clock

 [2]: t_{CSHD} = SCSTR:CSHD7-0×Serial chip select timing operating clock

 [3]: t_{CSDS} = SCSTR:CSDS15-0×Serial chip select timing operating clock

Regardless of the deselect time setting, once after the serial chip select pin becomes inactive, it will take at least five peripheral bus clock cycles to be active again

Please see the hardware manual for details of above-mentioned [1], [2], [3]



11.4.5.1.7 Bit setting: SMR:MD2=0, SMR:MD1=1, SMR:MD0=0,

When Serial chip select is used : SCSCR:CSSEN=1,

Serial clock output mark level "H" : SMR, SCSFR:SCINV=0,

Serial chip select Inactive level "L" : SCSCR, SCSFR:CSLVL=0

 (T_A: -40°C to +125°C, V_{CC}=AV_{CC}=5.0V±10%, V_{SS}=AV_{SS}=0.0V)

Parameter	Symbol	Pin name	Conditions	Value		Unit	Remarks
				Min	Max		
SCS↑→SCK↓ setup time	t _{CSSU}	SCK0 to SCK2, SCS00, SCS01, SCS10, SCS11, SCS20, SCS21	-	t _{CSSU} +0 [1]	t _{CSSU} +50 [1]	ns	Internal shift clock mode output pin : C _L =50pF
SCK↑→SCS↓ hold time	t _{CSDH}			t _{CSDH} -50 [2]	t _{CSDH} +0 [2]	ns	
SCS deselect time	t _{CSDI}			t _{CSDS} -50 ^[3]	t _{CSDS} +50 ^[3]	ns	
SCS↑→SCK↓ setup time	t _{CSSE}	SCK0 to SCK2, SCS00, SCS01, SCS10, SCS11, SCS20, SCS21	-	3t _{CPP} +30	-	ns	External shift clock mode output pin: C _L =50pF
SCK↑→SCS↓ hold time	t _{CSHE}			+0	-	ns	
SCS deselect time	t _{CSDE}			3t _{CPP} +30	-	ns	
SCS↑→SOT delay time	t _{DSE}			-	40	ns	
SCS↓→SOT delay time	t _{DEE}			+0	-	ns	
SCK↓→SCS↑ clock switch time	t _{SCC}	SCK0 to SCK2, SCS00, SCS01, SCS10, SCS11, SCS20, SCS21	-	3t _{CPP} +0	3t _{CPP} +50	ns	Internal shift clock mode Round operation output pin: C _L =50pF

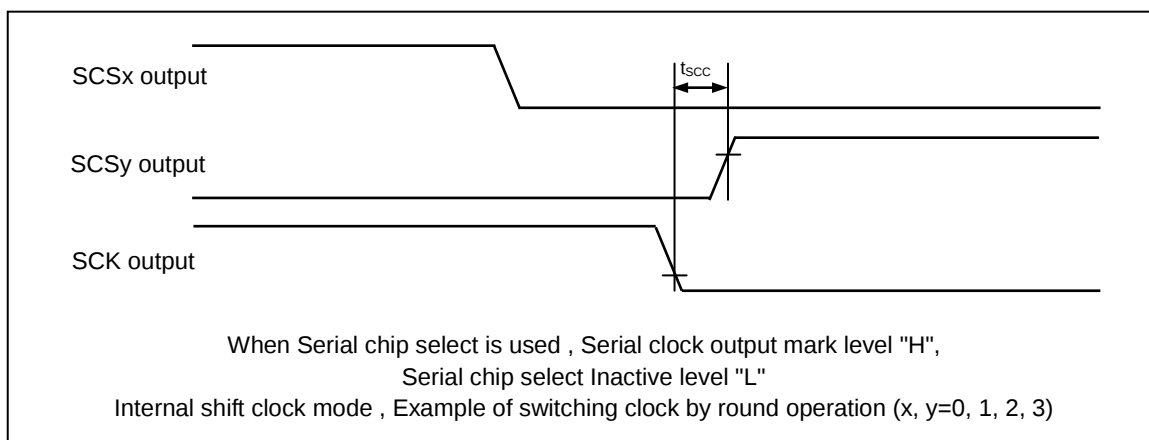
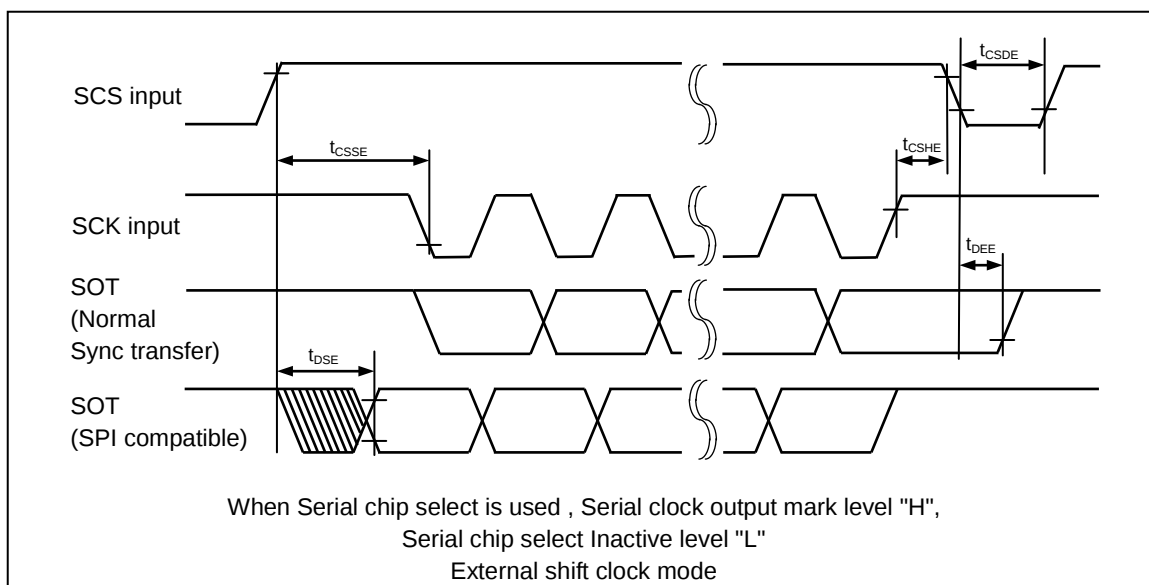
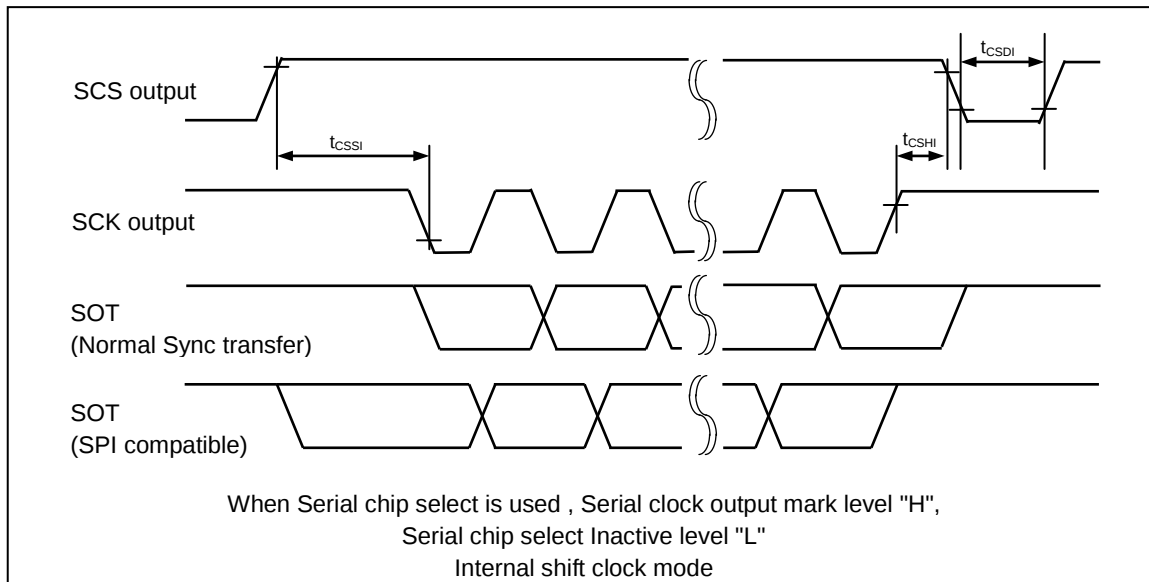
 [1]: t_{CSSU} = SCSTR:CSSU7-0×Serial chip select timing operating clock

 [2]: t_{CSDH} = SCSTR:CSDH7-0×Serial chip select timing operating clock

 [3]: t_{CSDS} = SCSTR:CSDS15-0×Serial chip select timing operating clock

Regardless of the deselect time setting, once after the serial chip select pin becomes inactive, it will take at least five peripheral bus clock cycles to be active again

Please see the hardware manual for details of above-mentioned [1], [2] and [3]



11.4.5.1.8 Bit setting: SMR:MD2=0, SMR:MD1=1, SMR:MD0=0,

When Serial chip select is used: SCSCR: CSEN=1,

Serial clock output mark level "L" : SMR, SCSFR:SCINV=1,

Serial chip select Inactive level "L" : SCSCR, SCSFR:CSLVL=0

 (T_A: -40°C to +125°C, V_{CC}=AV_{CC}=5.0V±10%, V_{SS}=AV_{SS}=0.0V)

Parameter	Symbo l	Pin name	Conditions	Value		Unit	Remarks
				Min	Max		
SCS↑→SCK↑ setup time	t _{CSSU}	SCK0 to SCK2, SCS00, SCS01, SCS10, SCS11, SCS20, SCS21	-	t _{CSSU} +0 ^[1]	t _{CSSU} +50 ^[1]	ns	Internal shift clock mode output pin : C _L =50pF
SCK↓→SCS↓ hold time	t _{CSHI}			t _{CSHD} -50 ^[2]	t _{CSHD} +0 ^[2]	ns	
SCS deselect time	t _{CSDI}			SCS00, SCS01, SCS10, SCS11, SCS20, SCS21	t _{CSDS} -50 ^[3]	t _{CSDS} +50 ^[3]	
SCS↑→SCK↑ setup time	t _{CSSE}	SCK0 to SCK2, SCS00, SCS01, SCS10, SCS11, SCS20, SCS21	-	3t _{CPP} +30	-	ns	External shift clock mode output pin: C _L =50pF
SCK↓→SCS↓ hold time	t _{CSHE}			+0	-	ns	
SCS deselect time	t _{CSDE}	SCS00, SCS01, SCS10, SCS11, SCS20, SCS21		3t _{CPP} +30	-	ns	
SCS↑→SOT delay time	t _{DSE}	SCS00, SCS01, SCS10, SCS11, SCS20, SCS21, SOT0 to SOT2		-	40	ns	
SCS↓→SOT delay time	t _{DEE}			+0	-	ns	
SCK↑→SCS↑ clock switch time	t _{SCC}	SCK0 to SCK2, SCS00, SCS01, SCS10, SCS11, SCS20, SCS21	-	3t _{CPP} +0	3t _{CPP} +50	ns	Internal shift clock mode Round operation output pin: C _L =50pF

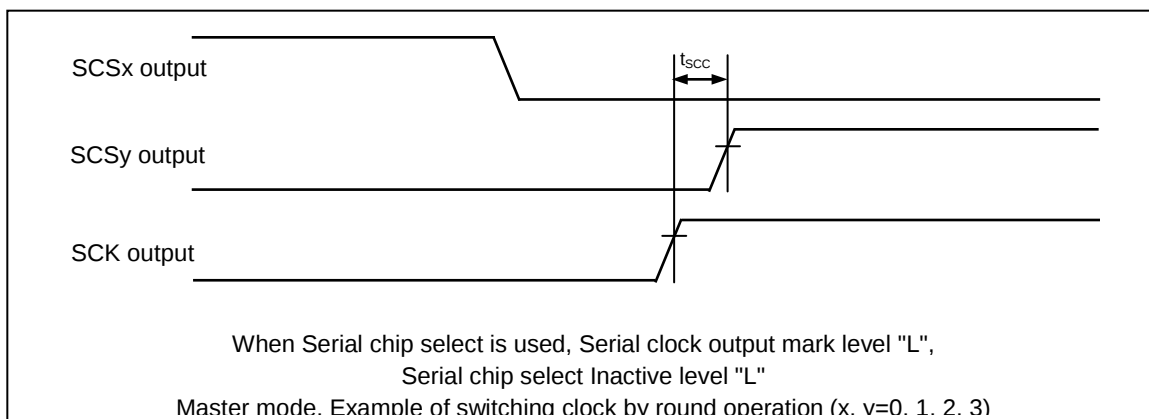
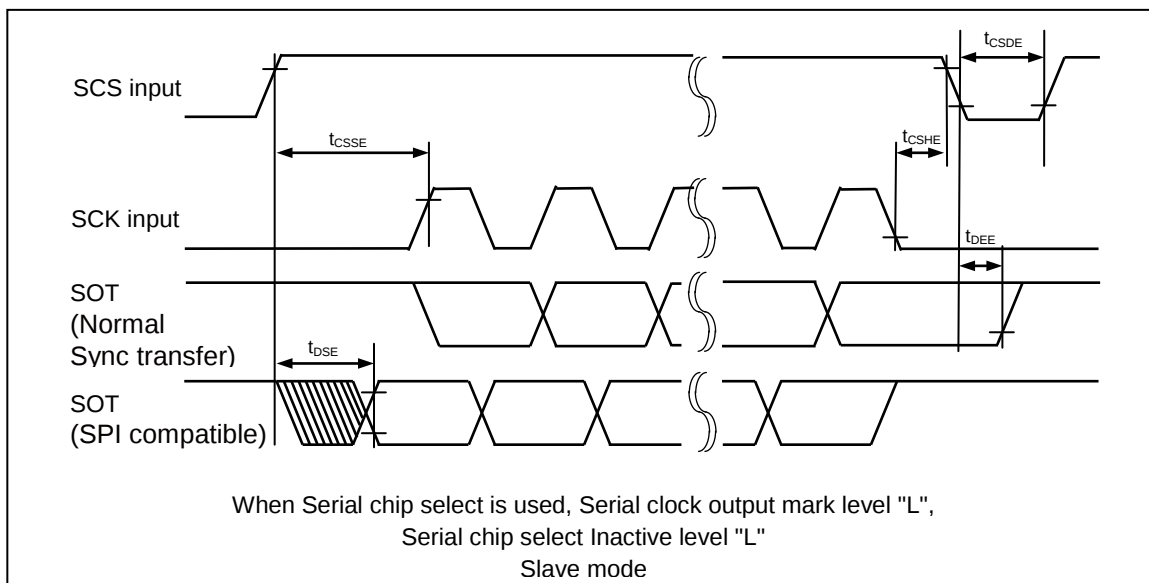
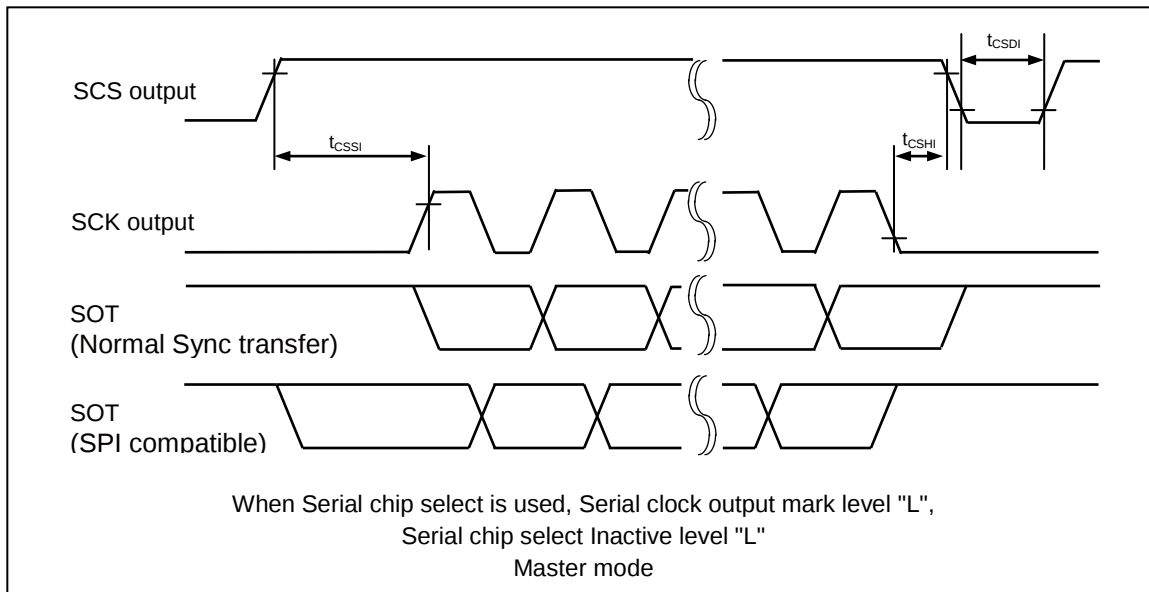
 [1]: t_{CSSU}=SCSTR:CSSU7-0×Serial chip select timing operating clock

 [2]: t_{CSHD}=SCSTR:CSHD7-0×Serial chip select timing operating clock

 [3]: t_{CSDS}=SCSTR:CSDS15-0×Serial chip select timing operating clock

Regardless of the deselect time setting, once after the serial chip select pin becomes inactive, it will take at least five peripheral bus clock cycles to be active again

Please see the hardware manual for details of above-mentioned [1], [2], and [3].



11.4.5.2 UART (Asynchronous serial interface) timing

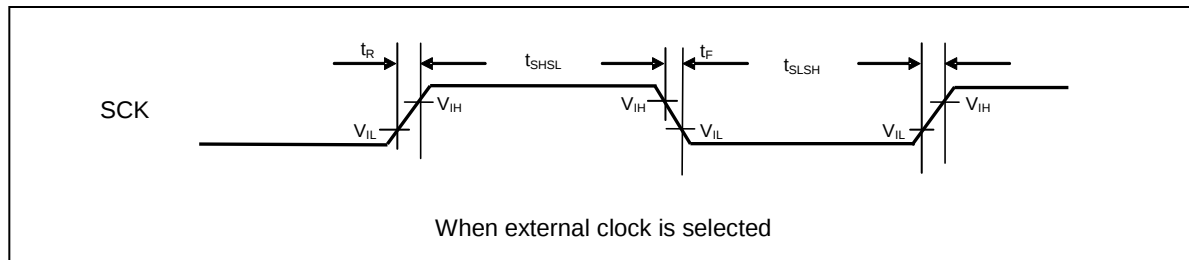
Bit setting: SMR : MD2=0, SMR:MD1=0, SMR : MD0=0

Bit setting: SMR : MD2=0, SMR:MD1=0, SMR : MD0=1

When external clock is selected (BGR: EXT=1)

(T_A: -40°C to +125°C, V_{CC}=AV_{CC}=5.0V±10%, V_{SS}=AV_{SS}=0.0V)

Parameter	Symbol	Pin name	Conditions	Value		Unit	Remarks
				Min	Max		
Serial clock "L" pulse width	t _{SLSH}	SCK0 to SCK2	-	t _{CPP} +10	-	ns	output pin: C _L =50pF
Serial clock "H" pulse width	t _{SHSL}			t _{CPP} +10	-	ns	
SCK fall time	t _F			-	5	ns	
SCK rise time	t _R			-	5	ns	

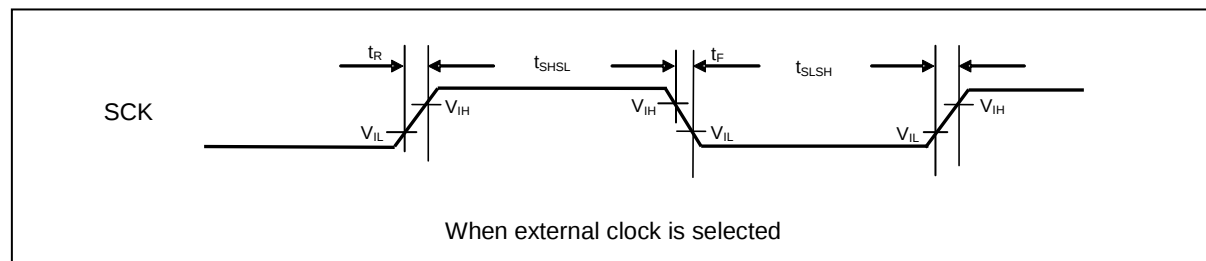


11.4.5.3 LIN Interface (v2.1) (Asynchronous Serial Interface for LIN (v2.1)) timing

Bit setting: SMR: MD2=0, SMR:MD1=1, SMR : MD0=1

(T_A: -40°C to +125°C, V_{CC}=AV_{CC}=5.0V±10%, V_{SS}=AV_{SS}=0.0V)

Parameter	Symbol	Pin name	Conditions	Value		Unit	Remarks
				Min	Max		
Serial clock "L" pulse width	t _{SLSH}	SCK0 to SCK2	-	t _{CPP} +10	-	ns	output pin: C _L =50pF
Serial clock "H" pulse width	t _{SHSL}			t _{CPP} +10	-	ns	
SCK fall time	t _F			-	5	ns	
SCK rise time	t _R			-	5	ns	

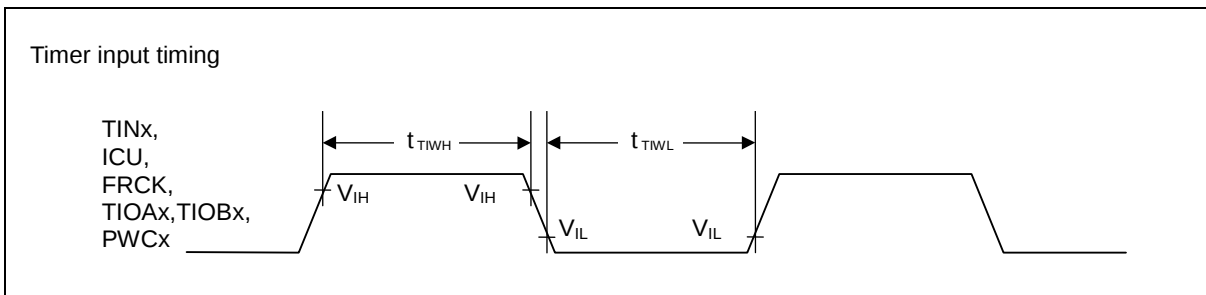


11.4.6 Timer input timing

(T_A: -40°C to +125°C, V_{CC}=AV_{CC}=5.0V±10%, V_{SS}=AV_{SS}=0.0V)

Parameter	Symbol	Pin name	Conditions	Value		Unit	Remarks
				Min	Max		
Input pulse width	t _{TIWH}	TIN0 to TIN4, ICU, FRCK, TIOA0 to TIOA3, TIOB0 to TIOB3,	-	4t _{CPP}	-	ns	
	t _{TIWL}	PWC0, PWC1	-	4t _{CP} ^[1]	-	ns	

[1]: In the case of digital LPF of PWC with buffers is setting as through.

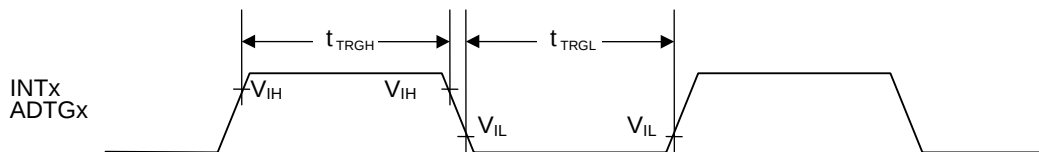


11.4.7 Trigger input timing

(T_A: -40°C + 125°C, V_{CC}=AV_{CC}=5.0V±10%, V_{SS}=AV_{SS}=0.0V)

Parameter	Symbol	Pin name	Conditions	Value		Unit	Remarks
				Min	Max		
Input pulse width	t _{TRGH} , t _{TRGL}	INT0 to INT3	-	5t _{CPP}	-	ns	
				1	-	μs	At stop mode
		ADTG0	-	5t _{CPP}	-	ns	
		ADTG1	-	5t _{CP}	-	ns	

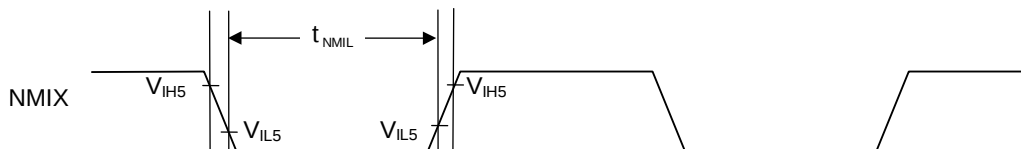
Trigger input timing


11.4.8 NMI input timing

(T_A: -40°C to +125°C, V_{CC}=AV_{CC}=5.0V±10%, V_{SS}=AV_{SS}=0.0V)

Parameter	Symbol	Pin name	Conditions	Value		Unit	Remarks
				Min	Max		
Input pulse width	t _{NMIL}	NMIX	-	4t _{CPP}	-	ns	

NMIX input timing



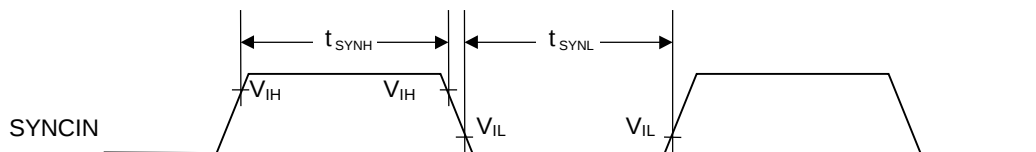
11.4.9 PWM

11.4.9.1 SYNCIN input timing

(T_A: -40°C to +125°C, V_{CC}=AV_{CC}=5.0V±10%, V_{SS}=AV_{SS}=0.0V)

Parameter	Symbol	Pin name	Conditions	Value		Unit	Remarks
				Min	Max		
Input pulse width	t _{SYNH} , t _{SYNL}	SYNCIN	-	16 t _{CPWMD}	-	ns	[1]

SYNCIN input timing



[1]: In the case of digital LPF of SYNCIN pin is setting as through.

11.4.9.2 PWM output

(T_A: -40°C to +125°C, V_{CC}=AV_{CC}=5.0V±10%, V_{SS}=AV_{SS}=0.0V)

Parameter	Symbol	Pin name	Conditions	Value		Unit	Remarks
				Min	Max		
CMPn⇒ PWMnH/PWMnL Delay time	t _{CPD}	CMP0 to CMP2 PWM0H to PWM2H PWM0L to PWM2L		-	100	ns	n=0, 1, 2 [1]
Min pulse width	tpw	PWM0H to PWM2H PWM0L to PWM2L		40	-	ns	[1]

[1]: In the case of PWM division clock is 200MHz

11.4.10 Low voltage detection (External low-voltage detection)

(T_A: -40°C to +125°C, V_{SS}=AV_{SS}=0.0V)

Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Power supply voltage range	V _{DP5}	VCC	-	3.7	-	5.5	V	
Detection voltage	V _{DL}		[1]	-8%	3.9	+8%	V	When power-supply voltage falls and detection level is set initially
Hysteresis width	V _{HYS}		-	-	0.1	-	V	When power-supply voltage rises
Low voltage detection time	T _d	-	-	-	-	30	μs	
Power supply voltage regulation	-	VCC	-	-2	-	2	V/ms	[2]

[1]: If the fluctuation of the power supply is faster than the low-voltage detection time, there is a possibility to generate or release after the power supply voltage has exceeded the detection voltage range.

[2]: Please suppress the change of the power supply within the range of the power-supply voltage regulation to do a low-voltage detection by detecting voltage (V_{DL}).

11.4.11 Low voltage detection (Internal low-voltage detection)

(T_A: -40°C to +125°C, V_{SS}=AV_{SS}=0.0V)

Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Power supply voltage range	V _{RDP5}	-	-	0.6	-	1.4	V	
Detection voltage	V _{RDL}		[1]	0.8	0.9	1.0	V	When power-supply voltage falls
Hysteresis width	V _{RHYS}		-	-	0.1	-	V	When power-supply voltage rises
Low voltage detection time	-	-	-	-	-	30	μs	

[1]: If the fluctuation of the power supply is faster than the low-voltage detection time, there is a possibility to generate or release after the power supply voltage has exceeded the detection voltage range.

11.5 A/D Converter

11.5.1 12-bit A/D Converter Electrical Characteristics

(T_A: -40°C to +125°C, V_{CC}=AV_{CC}=5.0V±10%, V_{SS}=AV_{SS}=0.0V)

Parameter	Symbol	Pin name	Value			Unit	Remarks
			Min	Typ	Max		
Resolution	-	-	-	-	12	bit	
Total error	-	-	-	-	±6.0	LSB	
Linearity error	-	-	-	-	±4.0	LSB	
Differential linearity error	-	-	-	-	±1.9	LSB	
Zero transition voltage	V _{OT}	AN0 to AN7	AVRL+0.5LSB -8mV	-	AVRL+0.5LSB +8mV	V	1LSB= (V _{FST} -V _{OT})/ 4094
Full-scale transition voltage	V _{FST}	AN0 to AN7	AVRH-1.5LSB -8mV	-	AVRH-1.5LSB +8mV	V	
Sampling time	t _{SMP}	-	0.3	-	-	μs	[1] [3]
Compare time	t _{CMP}	-	0.7	-	28	μs	[1]
A/D conversion time	t _{CNV}	-	1.0	-	-	μs	[1]
Analog port input current	I _{AIN}	AN0 to AN7	-2.0	-	+2.0	μA	V _{AVSS} ≤ V _{AIN} ≤ V _{AVCC}
Analog input voltage	V _{AIN}	AN0 to AN7	AVRL	-	AVRH	V	
Reference voltage	AVRH	AVRH0	4.5	-	5.5	V	
	AVRL	AVRL0	-	0.0	-	V	
Power supply current	I _A	AVCC0	-	0.5	0.69	mA	
	I _{AH}		-	-	6.1	μA	[2]
	I _R	AVRH0	-	1	1.96	mA	
	I _{RH}		-	-	4.0	μA	[2]
Variation between channels	-	AN0 to AN7	-	-	4	LSB	

[1]: Time for each channel.

[2]: Power supply current (V_{CC} = AV_{CC} = 5.0 V) is specified if A/D converter is not operating and CPU is stopped.

[3]: external impedance is 500Ω or less.

11.5.2 12-bit A/D Converter (4-channel simultaneous sampling) Electrical Characteristics

 (T_A: -40°C to +125°C, V_{CC}=AV_{CC}=5.0V±10%, V_{SS}=AV_{SS}=0.0V)

Parameter	Symbol	Pin name	Value			Unit	Remarks
			Min	Typ	Max		
Resolution	-	-	-	-	12	bit	
Total error	-	-	-	-	±6.0	LSB	
Linearity error	-	-	-	-	±4.0	LSB	
Differential linearity error	-	-	-	-	±1.9	LSB	
Zero transition voltage	V _{OT}	AN8 to AN11	AVRL+0.5LSB -8mV	-	AVRL+0.5LSB +8mV	V	1LSB= (V _{FST} -V _{OT})/ 4094
Full-scale transition voltage	V _{FST}	AN8 to AN11	AVRH-1.5LSB -8mV	-	AVRH-1.5LSB +8mV	V	
Sampling time	t _{SMP}	-	0.35	-	-	μs	[3]
Compare time	t _{CMP}	-	1.4	-	5.6	μs	[1]
A/D conversion time	t _{CNV}	-	1.75	-	-	μs	[1]
Analog port input current	I _{AIN}	AN8 to AN11	-1.0	-	+1.0	μA	V _{AVSS} ≤ V _{AIN} ≤ V _{AVCC}
Analog input voltage	V _{AIN}	AN8 to AN11	AVRL	-	AVRH	V	
Reference voltage	AVRH	AVRH1	4.5	-	5.5	V	
	AVRL	AVRL1	-	0.0	-	V	
Power supply current	I _A	AVCC1	-	1.0	1.5	mA	
	I _{AH}		-	0.1	20	μA	[2]
	I _R	AVRH1	-	2	4	mA	
	I _{RH}		-	0.1	10	μA	[2]
Decoupling capacitance	C _{REF}	connected to VR1	1	-	-	μF	
Resumption Time	t _{RS}	-	10.9	-	-	ms	[4] [5]

[1]: Conversion time of 4-channel.

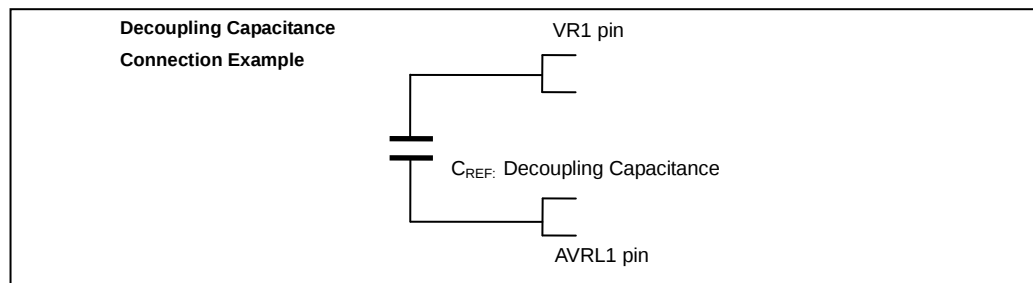
 [2]: Power supply current (V_{CC} = AV_{CC} = 5.0 V) is specified if A/D converter is not operating and CPU is stopped.

[3]: external impedance is 500Ω or less.

[4]: Calculate the minimum value by decoupling capacitance, the others parasitic capacitance value is defined as 0.

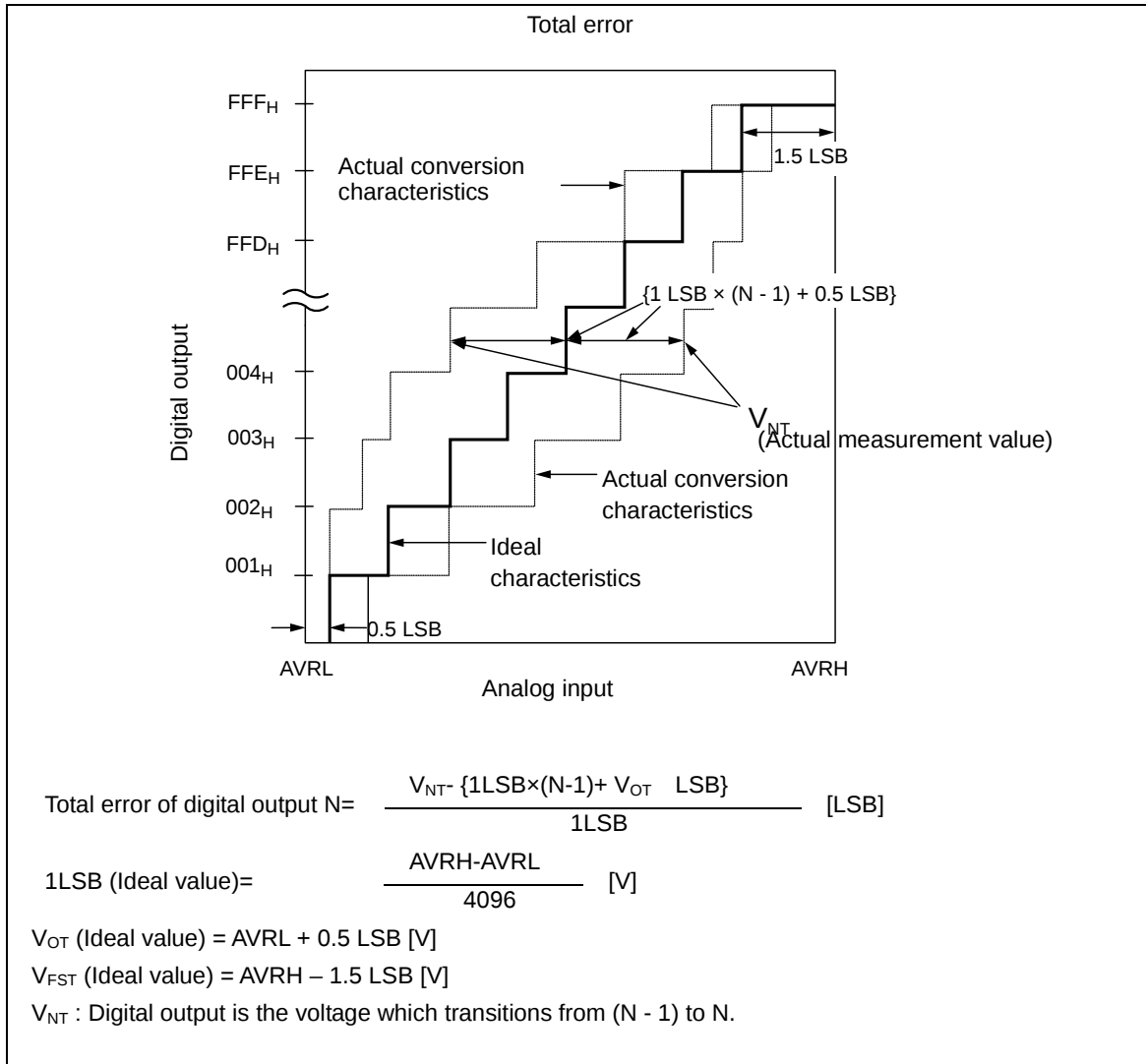
[5]: Resumption time is defined by the capacitance of the decoupling capacitance which connected to the pin VR1.

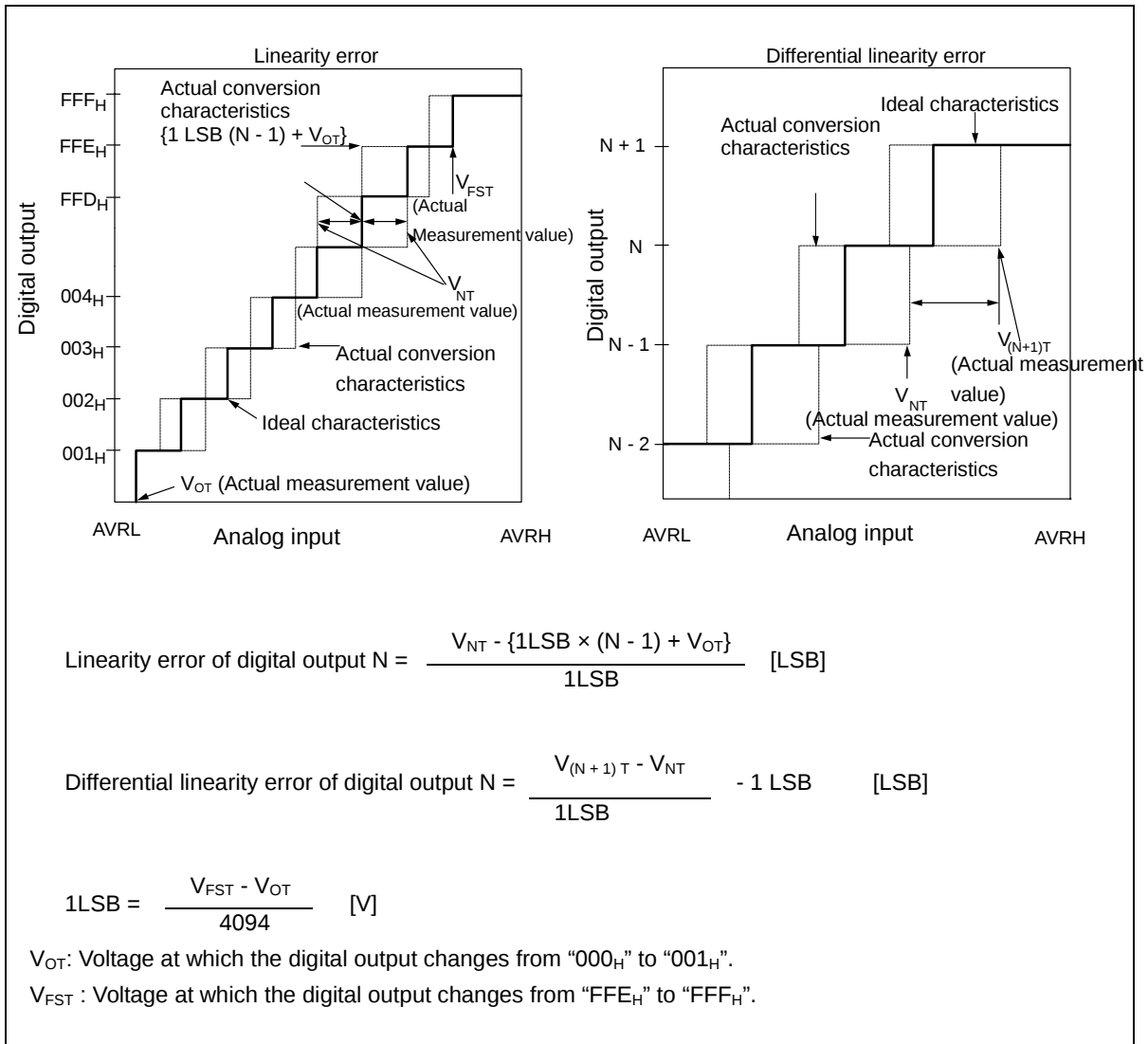
 Resumption Time=9*C_{REF}*1.2k + 1μ[s]

 C_{REF}:VR Decoupling capacitance [μF]


11.5.3 Definition of A/D Converter Terms

- Resolution : Analog variation that is recognized by an A/D converter.
- Linearity error : Deviation of the actual conversion characteristics from a straight line that connects the zero transition point ("0000 0000 0000" ← → "0000 0000 0001") to the full-scale transition point ("1111 1111 1110" ← → "1111 1111 1111").
- Differential linearity error : Deviation of the input voltage from the ideal value that is required to change the output code by LSB.
- Total error : Difference between the actual value and the theoretical value. The total error includes zero transition error, full-scale transition error, and linearity error.



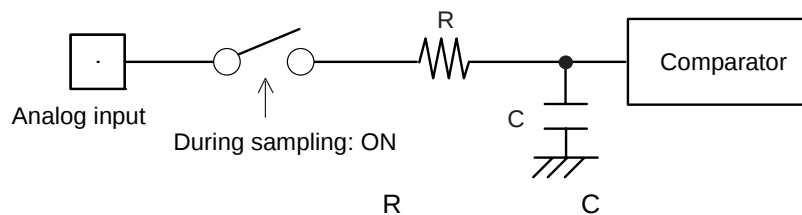


11.5.4 Notes on Using A/D Converter

About the output impedance of the analog input of external circuit

When the external impedance is too high, the sampling period for analog voltages may not be sufficient. In this case, it is recommended to connect the capacitor (approx. 0.1 μF) to the analog input pin.

Analog input circuit model



12bit A/D	2.0kΩ(Max)	11.65pF(Max)	(4.5V ≤ AV _{CC} ≤ 5.5V)
12bit A/D(4-channel simultaneous sampling)	5.0kΩ(Max)	11.0pF(Max)	(4.5V ≤ AV _{CC} ≤ 5.5V)

Note: Listed values must be considered as reference values.

11.6 Flash memory

11.6.1 Electrical Characteristics

Parameter	Value			Unit	Remarks
	Min	Typ	Max		
Sector erase time	-	200	800	ms	8 Kbytes sector ^[1] , excluding internal preprogramming time
	-	300	1100	ms	8 Kbytes sector ^[1] , including internal preprogramming time
	-	400	2000	ms	64 Kbytes sector ^[1] , excluding internal preprogramming time
	-	700	3700	ms	64 Kbytes sector ^[1] , including internal preprogramming time
8-bit writing time	-	9	288	μs	Exclusive of overhead time at system level ^[1]
16-bit writing time	-	12	384	μs	Exclusive of overhead time at system level ^[1]
ECC writing time	-	9	288	μs	Exclusive of overhead time at system level ^[1]
Erase cycle ^[2] /Data retain time	1,000 cycles/20 years, 10,000 cycles/10 years, 100,000 cycles/5 years	-	-	-	Temperature at writing/erasing T _j <+105°C, Average T _A =+85°C ^[3]

[1]: The guaranteed value for erasure up to 100,000 cycles.

[2]: Number of erase cycles for each sector.

[3]: This value comes from the technology qualification (using Arrhenius equation to translate high temperature measurements into normalized value at + 85°C).

11.6.2 Notes

While the Flash memory is written or erased, shutdown of the external power (V_{cc}) is prohibited.

In the application system where V_{cc} might be shut down while writing or erasing, be sure to turn the power off by using an external voltage detection function.

To put it concretely, after the external power supply voltage falls below the detection

voltage (V_{DL}^[1]), hold V_{cc} at 2.7V or more within the duration calculated by the following expression:

$$T_d [\mu s] + (\text{period of PCLK} [\mu s] \times 257) + 50 [\mu s]$$

[1]: See "11.4 AC Characteristics 11.4.9 Low voltage detection (External low-voltage detection)"

11.7 D/A converter

(T_A: -40°C to +125°C, V_{CC}=5.0V±10%, AV_{CC}2=5.0V±1.5%, V_{SS}=AV_{SS}=0.0V)

Parameter	Symbol	Pin name	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Resolution	-	-	-	-	-	10	Bit	
Linearity error	-	-	-	-4		4	LSB	
Differential non-linearity error	-	-	-	-0.9	-	0.9	LSB	
conversion time	-	-	-	-	-	200	ns	C _{OUT} =5pF ^[1]
Power supply current ^[2]	IA	AVCC2	-	-	475	600	μA	Each channel
	IAH	AVCC2	-	-	-	21	μA	When powerdown Each channel

[1]: capacitance of internal node

[2]: The power supply current described only current value on D/A converter.

The power supply current of AVCC2 = 3 unit × (the power supply current of D/A converter) + 3 unit × (the power supply current of comparator) + (the power supply current of slope compensation).

11.8 Comparator

(T_A: -40°C to +125°C, V_{CC}=5.0V±10%, AV_{CC2}=5.0V±1.5%V_{SS}=AV_{SS}=0.0V)

Parameter	Symbol	Pin name	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Input voltage	-	-	-	0	-	AV _{CC2} -1	V	
Compare time	-	-	-	-	-	t _{CCMP}	ns	[1]
Power down delay time	-	-	-	-	-	50	ns	
Power supply current [2]	IA	AVCC2	-	-	565	785	μA	Each channel
	IAH	AVCC2	-	-	0.2	2.5	μA	When powerdown Each channel
Input offset voltage	-	CMP0 CMP1 CMP2	-	-12	-	12	mV	

[1]: t_{CCMP} is comparator clock cycle time.

[2]: The power supply current described only current value on D/A converter.

The power supply current of AVCC2 = 3 unit × (the power supply current of D/A converter) + 3 unit × (the power supply current of comparator) + the power supply current of slope compensation).

11.9 Slope compensation

(T_A: -40°C to +125°C, V_{CC}=5.0V±10%, AV_{CC2}=5.0V±1.5%, V_{SS}=AV_{SS2}=0.0V)

Parameter	Symbol	Pin name	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Slope voltage	V _{slope}	(Vslope) ^[1]	-	0	-	AV _{CC2} -1	V	^[2]
				0.5	-	2.0	V	CTSI base
Operation cycle	T	(Vslope) ^[1]		2	-	10	μs	
Slope amount	dV _{slope} /dt	(Vslope) ^[1]	-	0.05	-	1.0	V/μs	
Slope output resolution	-	(Vslope) ^[1]	^[3]	-10	-	+10	%	^[5]
			^[4]	-14	-	+14	%	
OFF time	t _{off}	(Vslope) ^[1]	-	200	-	-	ns	
Switching stability time of slope amount	-	-	-	-	-	10	μs	^[6]
PD return time	-	-	-	-	-	20	μs	
Power supply current ^[8]	I _A	AVCC2	-	-	500	900	μA	When power down
	I _{AH}	AVCC2	-	-	0.01	33	μA	
Slope transmission error	-	CMP0	-	-3	-	+3	%	^[7]
ESD resistance	-	CMP0	-	700	800	900	Ω	
SWS on resistance	-	-	-	-	-	7	kΩ	
SWE on resistance	-	-	-	-	-	20	Ω	
SWI on resistance	-	-	-	-	-	600	Ω	

[1]: (Vslope) is Voltage of internal node.

[2]: Please do not let the total of external voltage input from slope voltage and CMP0 exceeds AV_{CC2}-1[V]. Besides, if reference voltage of the comparator is AV_{CC2}-1 [V] or less, we do not erroneously judged even if the slope voltage is more than AV_{CC2}-1 [V].

[3]: 1.0V/μs ≥ dV_{slope}/dt ≥ 0.1V/μs, 2.0V ≥ V_{slope} ≥ 0.5V, or voltage of internal node CTSI is defined as the reference.

[4]: 0.05V/μs ≤ dV_{slope}/dt < 0.1V/μs, 2.0V ≥ V_{slope} ≥ 0.5V, or voltage of internal node CTSI is defined as the reference.

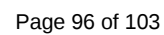
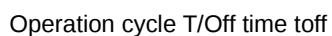
[5]: slope output resolution is the specification when calibration was performed. Calibration condition is dV_{slope}/dt=0.4V/μs.

[6]: When SLPDADR register is switching

[7]: Slope transmission error is the specification when calibration was performed. Calibration condition is correction voltage is 3.0V, voltage lower limits is 1.0V.

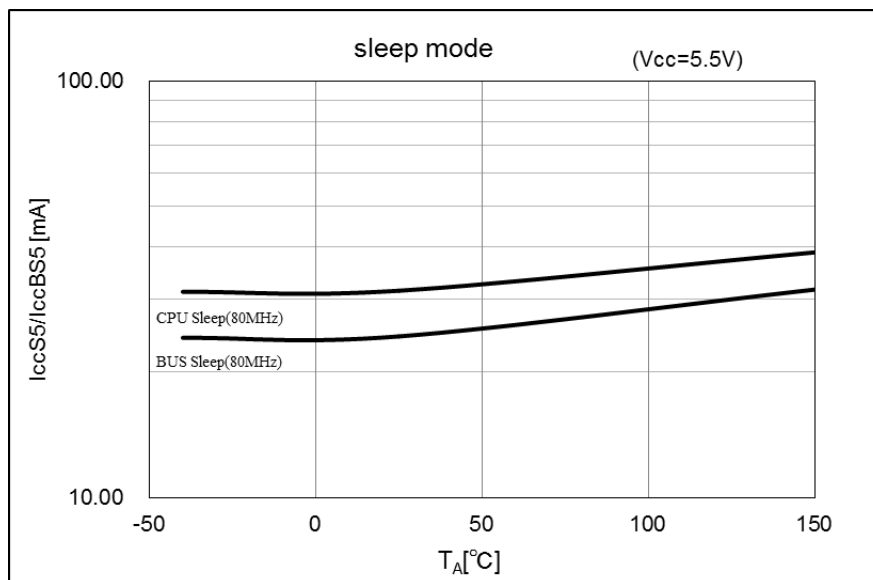
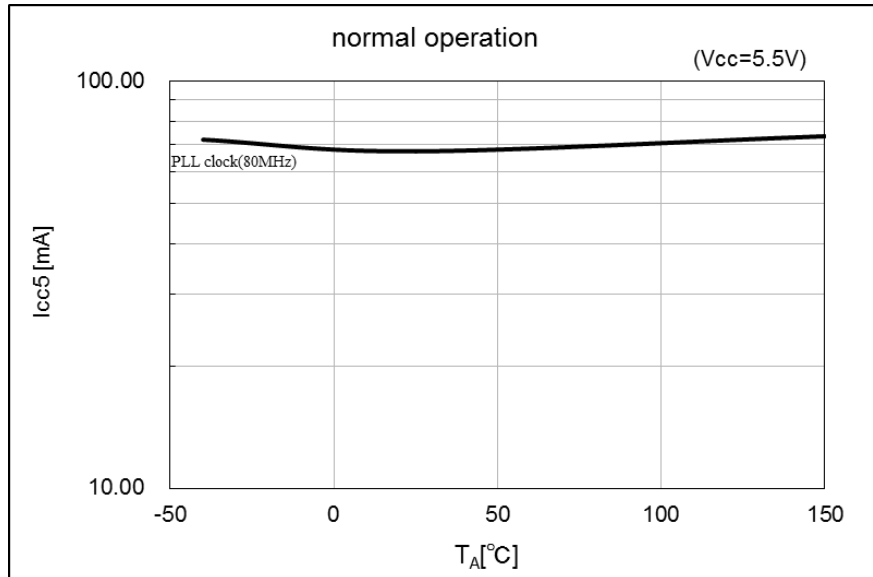
[8]: The power supply current described only current value on D/A converter.

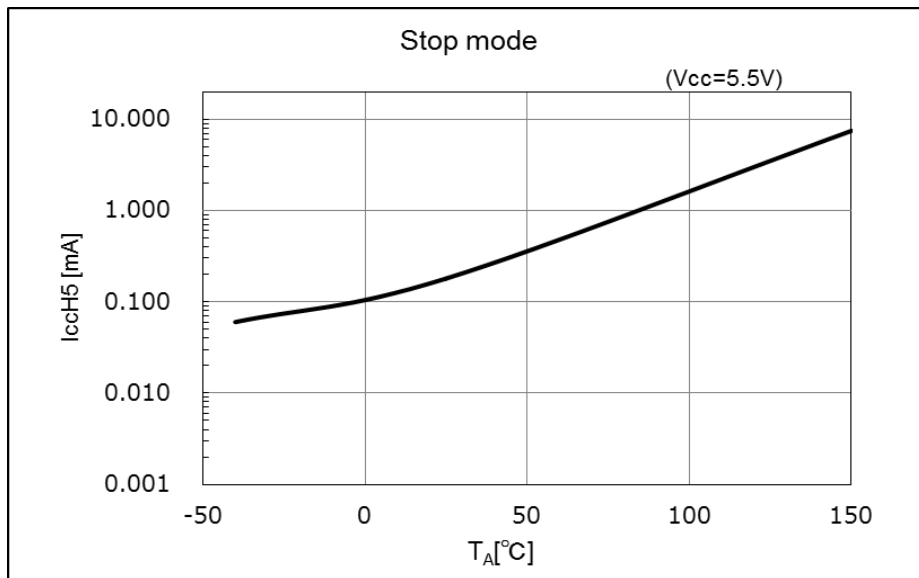
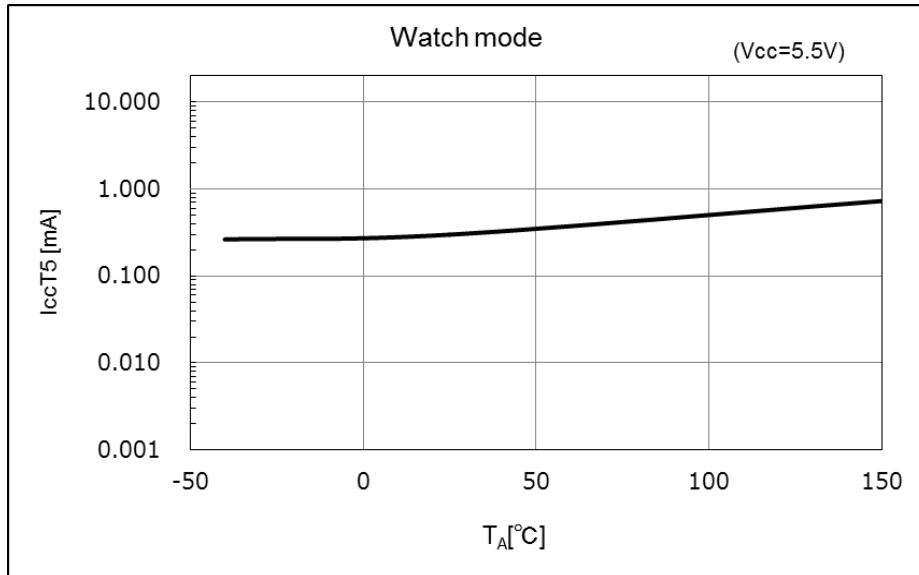
The power supply current of AVCC2 = 3 unit × (the power supply current of D/A converter) + 3 unit × (the power supply current of comparator) + (the power supply current of slope compensation).



12. Example Characteristics

This characteristic is an actual value of the arbitrary sample. It is not the guaranteed value.



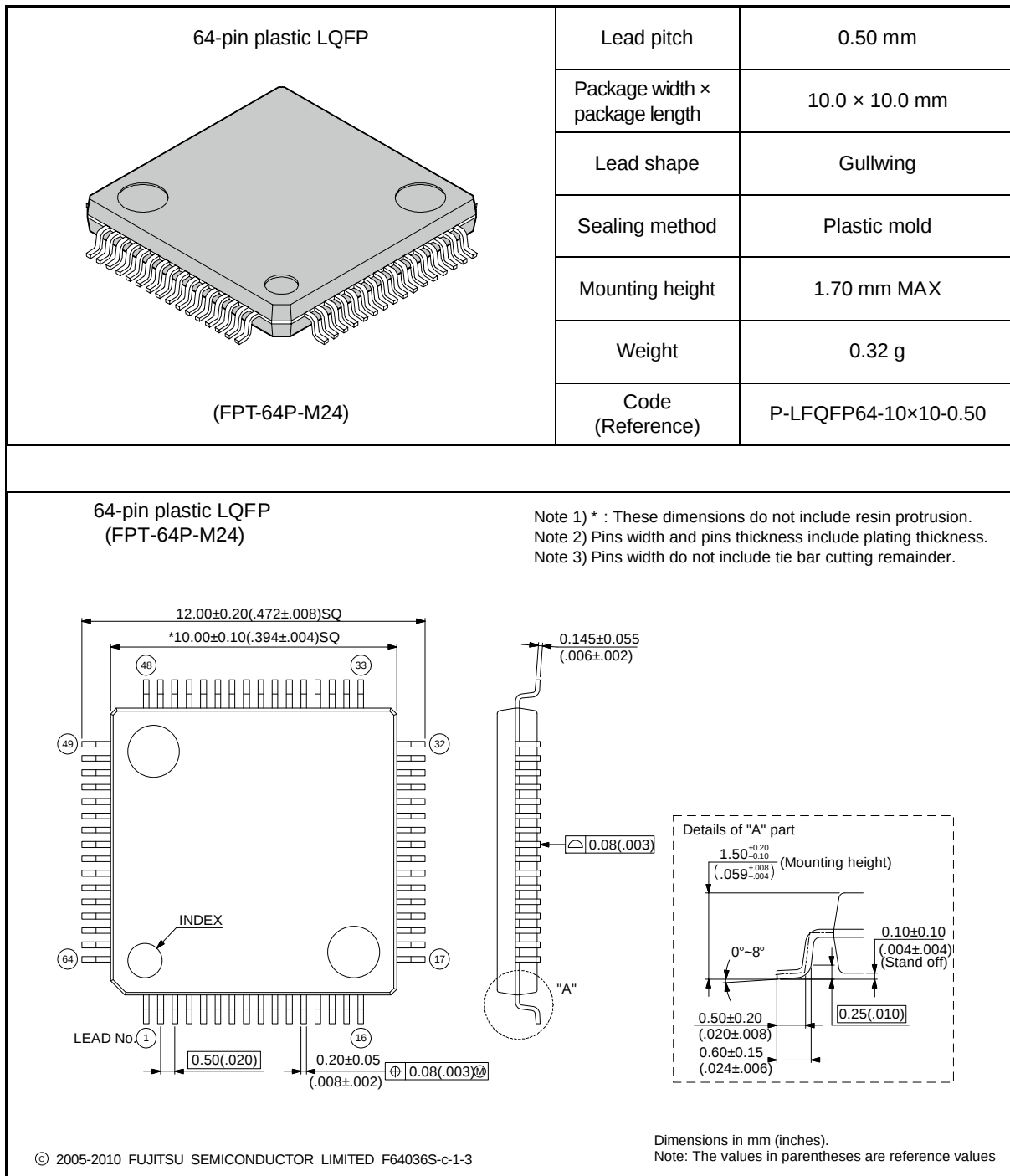


13. Ordering Information

Part number	Package*
MB91F552PMC1-GTE1	LQFP • 64 pin, Plastic (FPT-64P-M24)

*: For details of the package, see "[Package Dimensions](#)".

14. Package Dimensions



15. Major Changes

Spancion Publication Number: MB91F552_DS705-00015

Page	Section	Change Results
Revision 1.0		
-	-	Initial release

NOTE: Please see “Document History” for later revised information.

Document History

Document Title: MB91550 Series, MB91F552, FR Family FR81S, 32-bit Microcontroller

Document Number: 002-04667

Revision	ECN	Orig. of Change	Submission Date	Description of Change
**	—	HIHA	04/25/2014	Migrated to Cypress and assigned document number 002-04667. No change to document contents or format.
*A	5179093	HIHA	03/17/2016	Updated to Cypress template

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